

bq28z610

Technical Reference



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DRAFT ONLY

Preface

Read this First

This manual discusses the modules and peripherals of the bq28z610 device, and how each is used to build a complete battery pack gas gauge and protection solution.

Notational Conventions

The following notation is used if SBS commands and data flash values are mentioned within a text block:

- SBS commands: *italics* with parentheses and no breaking spaces, e.g., *RemainingCapacity()*.
- Data Flash: *italics*, **bold**, and breaking spaces, e.g. **Design Capacity**.
- Register Bits and Flags: *italics* and brackets, e.g. *[TDA]* Data
- Flash Bits: *italics* and **bold** e.g. **[LED1]**
- Modes and states: ALL CAPITALS, e.g. UNSEALED

The reference format for SBS commands is: SBS:Command Name(Command No.): Manufacturer Access(MA No.)[Flag], for example:

SBS:Voltage(0x09), or SBS:ManufacturerAccess(0x00): Seal Device(0x0020)

Introduction

The bq28z610 device provides a feature-rich gas gauging solution for 1-series cell to 2-series cell battery-pack applications. The device has extended capabilities, including:

- Fully Integrated 1-Series to 2-Series Cell Li-Ion or Li-Polymer Cell Battery Pack Manager and Protection
- Next-Generation Patented Impedance Track™ Technology Accurately Measures Available Charge in Li-Ion and Li-Polymer Batteries
- High Side N-CH Protection FET Drive
- Integrated Cell Balancing While Charging or At Rest
- Power Modes
 - NORMAL Mode
 - SLEEP Mode
 - SHUTDOWN Mode
- Full Array of Programmable Protection Features
 - Voltage
 - Current
 - Temperature
 - Charge Timeout
 - CHG/DSG FETs
 - Cell Imbalance
- Sophisticated Charge Algorithms
 - JEITA
 - Enhanced Charging
 - Adaptive Charging
 - Cell Balancing
- Diagnostic Lifetime Data Monitor
- Supports Two-Wire I²C Interface
- Battery Trip Point (BTP)
- SHA-1 Authentication
- Ultra-Compact Package: 12-Lead SON

Protections

Introduction

This chapter describes the recoverable protection the gauge provides. When the protection is triggered, charging and/or discharging will be disabled. This is indicated by the `OperationStatus()[XDSG] = 1` when discharging is disabled. Once the protection is recovered, charging and discharging will resume. All protection items can be enabled or disabled under **Settings:Enable Protections A** and **Settings:Enable Protections B**.

2.1 Cell Undervoltage Protection

The device can detect undervoltage in batteries and protect cells from damage by preventing further discharge.

Status	Condition	Action
Normal	Min cell voltages 1..2 > CUV:Threshold	<code>SafetyAlert()[CUV] = 0</code> <code>BatteryStatus()[TDA] = 0</code>
Alert	Min cell voltages 1..2 ≤ CUV:Threshold	<code>SafetyAlert()[CUV] = 1</code> <code>BatteryStatus()[TDA] = 1</code>
Trip	Min cell voltages 1..2 ≤ CUV:Threshold for CUV:Delay duration	<code>SafetyAlert()[CUV] = 0</code> <code>SafetyStatus()[CUV] = 1</code> <code>BatteryStatus()[FD] = 1, [TDA] = 0</code> <code>OperationStatus()[XDSG] = 1</code>
Recovery	Condition 1: <code>SafetyStatus()[CUV] = 1</code> AND Min cell voltages 1..2 ≥ CUV:Recovery AND Protection Configuration[CUV_RECOV_CHG] = 0 Condition 2: <code>SafetyStatus()[CUV] = 1</code> AND Min cell voltages 1..2 ≥ CUV:Recovery AND Protection Configuration[CUV_RECOV_CHG] = 1 AND <code>[CUV_RECOV_CHG] = 1</code> AND Charging detected (that is <code>BatteryStatus[DSG] = 0</code>)	<code>SafetyStatus()[CUV] = 0</code> <code>BatteryStatus()[FD] = 0, [TDA] = 0</code> <code>OperationStatus()[XDSG] = 1</code>

2.2 Cell Overvoltage Protection

The device can detect cell overvoltage in batteries and protect cells from damage by preventing further charging.

NOTE: The protection detection threshold may be influenced by the temperature settings of the advanced charging algorithm and the measured temperature.

Status	Condition	Action
Normal, <i>ChargingStatus()</i> [<i>UT</i>] or [<i>LT</i>] = 1	Max cell voltage 1..2 < COV:Threshold Low Temp	<i>SafetyAlert()</i> [<i>COV</i>] = 0
Normal, <i>ChargingStatus()</i> [<i>STL</i>] or [<i>STH</i>] = 1	Max cell voltage 1..2 < COV:Threshold Standard Temp	
Normal, <i>ChargingStatus()</i> [<i>RT</i>] = 1	Max cell voltage 1..2 < COV:Threshold Rec Temp	
Normal, <i>ChargingStatus()</i> [<i>HT</i>] or [<i>OT</i>] = 1	Max cell voltage 1..2 < COV:Threshold High Temp	
Alert, <i>ChargingStatus()</i> [<i>UT</i>] or [<i>LT</i>] = 1	Max cell voltage 1..2 ≥ COV:Threshold Low Temp	<i>SafetyAlert()</i> [<i>COV</i>] = 1, <i>BatteryStatus()</i> [<i>TCA</i>] = 1
Alert, <i>ChargingStatus()</i> [<i>STL</i>] or [<i>STH</i>] = 1	Max cell voltage 1..2 ≥ COV:Threshold Standard Temp	
Alert, <i>ChargingStatus()</i> [<i>RT</i>] = 1	Max cell voltage 1..2 ≥ COV:Threshold Rec Temp	
Alert, <i>ChargingStatus()</i> [<i>HT</i>] or [<i>OT</i>] = 1	Max cell voltage 1..2 ≥ COV:Threshold High Temp	
Trip, <i>ChargingStatus()</i> [<i>UT</i>] or [<i>LT</i>] = 1	Max cell voltage 1..2 ≥ COV:Threshold Low Temp for COV:Delay duration	<i>SafetyAlert()</i> [<i>COV</i>] = 0 <i>SafetyAlert()</i> [<i>COV</i>] = 1 <i>BatteryStatus()</i> [<i>TCA</i>] = 1 <i>OperationStatus()</i> [<i>XCHG</i>] = 1
Trip, <i>ChargingStatus()</i> [<i>STL</i>] or [<i>STH</i>] = 1	Max cell voltage 1..2 ≥ COV:Threshold Standard Temp for COV:Delay duration	
Trip, <i>ChargingStatus()</i> [<i>RT</i>] = 1	Max cell voltage 1..2 ≥ COV:Threshold Rec Temp for COV:Delay duration	
Trip, <i>ChargingStatus()</i> [<i>HT</i>] or [<i>OT</i>] = 1	Max cell voltage 1..2 ≥ COV:Threshold High Temp for COV:Delay duration	
Recovery, <i>ChargingStatus()</i> [<i>UT</i>] or [<i>LT</i>] = 1	<i>SafetyStatus()</i> [<i>COV</i>] = 1 AND Max cell voltage 1..2 ≤ COV:Recovery Low Temp	<i>SafetyStatus()</i> [<i>COV</i>] = 0 <i>BatteryStatus()</i> [<i>TCA</i>] = 0 <i>OperationStatus()</i> [<i>XCHG</i>] = 0
Recovery, <i>ChargingStatus()</i> [<i>STL</i>] or [<i>STH</i>] = 1	<i>SafetyStatus()</i> [<i>COV</i>] = 1 AND Max cell voltage 1..2 ≤ COV:Recovery Standard Temp	
Recovery, <i>ChargingStatus()</i> [<i>RT</i>] = 1	<i>SafetyStatus()</i> [<i>COV</i>] = 1 AND Max cell voltage 1..2 ≤ COV:Recovery Rec Temp	
Recovery, <i>ChargingStatus()</i> [<i>HT</i>] or [<i>OT</i>] = 1	<i>SafetyStatus()</i> [<i>COV</i>] = 1 AND Max cell voltage 1..2 ≤ COV:Recovery High Temp	

2.3 Overcurrent in Charge Protection

The device has two independent overcurrent in charge protections that can be set to different current and delay thresholds to accommodate different charging behaviors.

Status	Condition	Action
Normal	$Current() < OCC:Threshold$	$SafetyAlert()[OCC] = 0$
Alert	$Current() \geq OCC:Threshold$	$SafetyAlert()[OCC] = 1$
Trip	$Current()$ continuous $\geq OCC:Threshold$ for OCC:Delay duration	$SafetyAlert()[OCC1] = 0$ $SafetyStatus()[OCC] = 1$ $BatteryStatus()[TCA] = 1$ $OperationStatus()[XCHG] = 1$
Recovery	$[SafetyStatus()[OCC] = 1$ AND $Current()$ continuous $\leq OCC:Recovery Threshold$ for OCC:Recovery Delay time	$SafetyStatus()[OCC] = 0$ $BatteryStatus()[TCA] = 0$ $OperationStatus()[XCHG] = 0$

2.4 Overcurrent in Discharge Protection

The device has two independent overcurrent in discharge protections that can be set to different current and delay thresholds to accommodate different load behaviors.

Status	Condition	Action
Normal	$Current() > OCD:Threshold$	$SafetyAlert()[OCD] = 0$
Alert	$Current() \leq OCD:Threshold$	$SafetyAlert()[OCD] = 1$
Trip	$Current()$ continuous $\leq OCD:Threshold$ for OCD:Delay duration	$SafetyAlert()[OCD1] = 0$ $SafetyStatus()[OCD] = 1$ $BatteryStatus()[TDA] = 0$ $OperationStatus()[XDSDG] = 1$
Recovery	$[SafetyStatus()[OCD] = 1$ AND $Current()$ continuous $\geq OCD:Recovery Threshold$ for OCD:Recovery Delay time	$SafetyStatus()[OCD] = 0$ $BatteryStatus()[TDA] = 0$ $OperationStatus()[XDSDG] = 0$

2.5 Hardware-Based Protection

The bq28z610 device has three main hardware-based protections—AOLD, ASCC, and ASCD1,2—with adjustable current and delay time. Setting **AFE Protection Configuration[RSNS]** divides the threshold value in half. The **Threshold** settings are in mV, therefore, the actual current that triggers the protection is based on the R_{SENSE} used in the schematic design.

In addition, setting the **AFE Protection Configuration[SCDDx2]** bit provides an option to double all of the SCD1,2 delay times for maximum flexibility towards the application's needs.

For details on how to configure the AFE hardware protection, refer to the tables in [Appendix A](#).

All of the hardware-based protections provide a short term Trip/Latch Alert/Recovery protection to account for a current spike as well as a Trip/Alert/Latch protection for persistent faulty condition. The latch feature also stops the FETs from toggling on and off continuously, preventing damage to the FETs.

In general, when a fault is detected after the **Delay** time, both CHG and DSG FETs will be disabled (Trip stage), and an internal fault counter will be incremented (Alert stage). Since both FETs are off, the current will drop to 0 mA. After **Recovery** time, the CHG and DSG FETs will be turned on again (Recovery stage).

If the alert is caused by a current spike, the fault count will be decremented after **Counter Dec Delay** time. If this is a persistent faulty condition, the device will enter the Trip stage after **Delay** time, and repeat the Trip/Latch Alert/Recovery cycle. The internal fault counter is incremented every time the device goes through the Trip/Alert/Recovery cycle. Once the internal fault counter hits the **Latch Limit**, the protection enters a Latch stage and the fault will only be cleared through the Latch Reset condition.

The Trip/Alert/Recovery/Latch stages are documented in each of the following hardware-based protection sections.

NOTE: There is no **PRES** pin in the bq28z610 device.

2.5.1 Overload in Discharge Protection

The device has a hardware-based overload in discharge protection with adjustable current and delay.

Status	Condition	Action
Normal	$Current() > (AOLD\ Threshold[3:0] / R_{SENSE})$	$SafetyAlert()[AOLD] = 0,$
Trip	$Current()$ continuous $\leq (AOLD\ Threshold[3:0] / R_{SENSE})$ for AOLD Threshold[7:4] duration	$SafetyStatus()[AOLD] = 1$ $OperationStatus()[XDSG] = 1$
Recovery	$SafetyStatus()[AOLD] = 1$ for OLD:Recovery time	$SafetyStatus()[AOLD] = 0$ $OperationStatus()[XDSG] = 0$

2.5.2 Short Circuit in Charge Protection

The device has a hardware based short circuit in charge protection with adjustable current and delay.

Status	Condition	Action
Normal	$Current() > (ASCC\ Threshold[2:0] / R_{SENSE})$	$SafetyAlert()[ASCC] = 0,$
Trip	$Current()$ continuous $\leq (ASCC\ Threshold[2:0] / R_{SENSE})$ for ASCC Threshold[7:4] duration	$SafetyStatus()[ASCC] = 1$ $BatteryStatus()[TCA] = 1$ $OperationStatus()[XCHG] = 1$
Recovery	$SafetyStatus()[ASCC] = 1$ for SCC:Recovery time	$SafetyStatus()[ASCC] = 0$ $BatteryStatus()[TCA] = 1$ $OperationStatus()[XCHG] = 0$

2.5.3 Short Circuit in Discharge Protection

The device has a hardware based short circuit in discharge protection with adjustable current and delay.

Status	Condition	Action
Normal	$Current() > (ASCD1\ Threshold[2:0] / R_{SENSE})$ AND $Current() > (ASCD2\ Threshold[2:0] / R_{SENSE})$	$SafetyAlert()[ASCD] = 0,$
Trip	$Current()$ continuous $\leq (ASCD1\ Threshold[2:0] / R_{SENSE})$ for SCD1Threshold[7:4] duration OR $Current()$ continuous $\leq (ASCD2\ Threshold[2:0] / R_{SENSE})$ for ASCD2Threshold[7:4] duration	$SafetyStatus()[ASCD] = 1$ $OperationStatus()[XDSG] = 1$
Recovery	$SafetyStatus()[ASCD] = 1$ for SCD:Recovery time	$SafetyStatus()[ASCD] = 0$ $OperationStatus()[XDSG] = 0$

2.6 Temperature Protections

The device provides over-temperature and under-temperature protections based on Cell Temperature measurement. The Cell Temperature based protections are further divided into a protection-in-charging direction and discharging directions. This section describes in detail each of the protection functions.

For temperature reporting, the device supports a maximum of four external thermistors and one internal temperature sensor. Unused temperature sensors must be disabled by clearing the corresponding flag in **Settings:Temperature Enable[TS1][TSInt]**.

The external thermistor and the internal temperature sensor can be set up individually as a source for Cell Temperature reporting. Setting the corresponding flag to 1 in **Settings:Temperature Mode[TS1 Mode][TSInt Mode]** configures that temperature sensor to report for the appropriate Cell Temperature. The **Settings:DA Configuration[CTEMP]** allows users to use the maximal (setting the corresponding flag to 0) or the average (setting the corresponding flag to 1) of the source temperature sensors for Cell Temperature reporting.

The `Temperature()` command returns the Cell Temperature measurement. The MAC and extended command `DAStatus2()` also returns the temperature measurement from the internal temperature sensor, the external thermistors TS1, and the Cell Temperatures.

The Cell Temperature based over-temperature and under-temperature safety provide protections in charge and discharge conditions. The battery pack is considered in CHARGE mode when `BatteryStatus()[DSG] = 0`, where `Current() > Chg Current Threshold`. The over-temperature and under-temperature in charging protections are active in this mode. The `BatteryStatus()[DSG]` is set to 1 in a NON-CHARGE mode condition, which includes RELAX and DISCHARGE modes. The over-temperature and under-temperature in discharge protections are active in these two modes. See [Section 6.3](#) for detailed descriptions of the gas gauge modes.

2.7 Overtemperature in Charge Protection

The device has an overtemperature protection for cells charging.

Status	Condition	Action
Normal	<code>Temperatures() < OTC:Threshold</code> OR not charging	<code>SafetyAlert()[OTC] = 0</code>
Alert	<code>Temperatures() ≥ OTC:Threshold</code> AND charging	<code>SafetyAlert()[OTC] = 1</code> <code>BatteryStatus()[TCA] = 1</code>
Trip	<code>Temperatures() ≥ OTC:Threshold</code> AND charging for <code>OTC:Delay</code> duration	<code>SafetyAlert()[OTC] = 0</code> <code>SafetyStatus()[OTC] = 1</code> <code>BatteryStatus()[OTA] = 1</code> <code>BatteryStatus()[TCA] = 0</code> <code>OperationStatus()[XCHG] = 1</code>
Recovery	<code>SafetyStatus()[OTC]</code> AND Cell Temperature in <code>Temperatures() ≤ OTC:Recovery</code>	<code>SafetyStatus()[OTC] = 0</code> <code>BatteryStatus()[OTA] = 0</code> <code>BatteryStatus()[TCA] = 0</code> <code>OperationStatus()[XCHG] = 0</code>

2.8 Overtemperature in Discharge Protection

The device has an overtemperature protection for cells in DISCHARGE or RELAX state (i.e., non-charging state with `BatteryStatus[DSG] = 1`).

Status	Condition	Action
Normal	<code>Temperatures() < OTD:Threshold</code> OR charging	<code>SafetyAlert()[OTD] = 0</code>
Alert	<code>Temperatures() ≥ OTD:Threshold</code> AND not charging (i.e., <code>BatteryStatus[DSG] = 1</code>)	<code>SafetyAlert()[OTD] = 1</code> <code>BatteryStatus()[TDA] = 1</code>
Trip	Cell Temperature in <code>Temperatures() ≥ OTD:Threshold</code> AND not charging (i.e., <code>BatteryStatus[DSG] = 1</code>) for <code>OTD:Delay</code> duration	<code>SafetyAlert()[OTD] = 0</code> <code>SafetyStatus()[OTD] = 1</code> <code>BatteryStatus()[OTA] = 1</code> <code>OperationStatus()[XDSG] = 1.</code> <code>BatteryStatus()[TDA] = 0</code>
Recovery	<code>SafetyStatus()[OTD]</code> AND Cell Temperature in <code>Temperatures() ≤ OTD:Recovery</code>	<code>SafetyStatus()[OTD] = 0</code> <code>BatteryStatus()[OTA] = 0</code> <code>OperationStatus()[XDSG] = 0</code> <code>BatteryStatus()[TDA] = 0</code>

2.9 Undertemperature in Charge Protection

The device has an undertemperature protection for cells in charge direction.

Status	Condition	Action
Normal	<code>Temperatures() > UTC:Threshold</code> OR not charging	<code>SafetyAlert()[UTC] = 0</code>
Alert	<code>Temperatures() ≤ UTC:Threshold</code> AND charging	<code>SafetyAlert()[UTC] = 1</code>

Status	Condition	Action
Trip	$Temperatures() \leq UTC:Threshold$ AND charging for UTC:Delay duration	$SafetyAlert()[UTC] = 0$ $SafetyStatus()[UTC] = 1$ $OperationStatus()[XCHG] = 1$
Recovery	$SafetyStatus()[UTC]$ AND $Temperatures() \geq UTC:Recovery$	$SafetyStatus()[UTC] = 0$ $OperationStatus()[XCHG] = 0$

2.10 Undertemperature in Discharge Protection

The device has an undertemperature protection for cells in DISCHARGE or RELAX state (i.e., non-charging state with $BatteryStatus[DSG] = 1$).

Status	Condition	Action
Normal	$Temperatures() > UTD:Threshold$ OR charging	$SafetyAlert()[UTD] = 0$
Alert	$Temperatures() \leq UTD:Threshold$ AND not charging (i.e., $BatteryStatus[DSG] = 1$)	$SafetyAlert()[UTD] = 1$
Trip	$Temperatures() \leq UTD:Threshold$ AND not charging (i.e. $BatteryStatus[DSG] = 1$) for UTD:Delay duration	$SafetyAlert()[UTD] = 0$ $SafetyStatus()[UTD] = 1$ $OperationStatus()[XDSG] = 1$
Recovery	$SafetyStatus()[UTD]$ AND $Temperatures() \geq UTD:Recovery$	$SafetyStatus()[UTD] = 0$ $BatteryStatus()[OTA] = 0$ $OperationStatus()[XDSG] = 0$

2.11 Precharge Timeout Protection

The device can measure the precharge time and stop charging if it exceeds the adjustable period.

Status	Condition	Action
Enable	$Current() > PTO:Charge\ Threshold$ AND $ChargingStatus()[PV] = 1$	Start PTO timer $SafetyAlert()[PTOS] = 0$
Suspend or Recovery	$Current() < PTO:Suspend\ Threshold$	Stop PTO timer $SafetyAlert()[PTOS] = 1$
Trip	PTO timer > PTO:Delay	Stop PTO timer $SafetyStatus()[PTO] = 1$ $OperationStatus()[XCHG] = 1$
Reset	$SafetyStatus()[PTO] = 1$ AND (Discharge by an amount of PTO:Reset)	Stop and reset PTO timer $SafetyAlert()[PTOS] = 0$ $SafetyStatus()[PTO] = 0$ $BatteryStatus()[TCA] = 0$ $OperationStatus()[XCHG] = 0$

2.12 Fast Charge Timeout Protection

The device can measure the charge time and stop charging if it exceeds the adjustable period.

Status	Condition	Action
Enable	$Current() > CTO:Charge\ Threshold$ AND ($ChargingStatus()[LV] = 1$ OR $ChargingStatus()[MV] = 1$ OR $ChargingStatus()[HV] = 1$)	Start CTO timer $SafetyAlert()[CTOS] = 0$
Suspend or Recovery	$Current() < CTO:Suspend\ Threshold$	Stop CTO timer $SafetyAlert()[CTOS] = 1$
Trip	CTO time > CTO:Delay	Stop CTO timer $SafetyStatus()[CTO] = 1$ $BatteryStatus()[TCA] = 1$ $OperationStatus()[XCHG] = 1$

Status	Condition	Action
Reset	<i>SafetyStatus()[CTO] = 1 AND (Discharge by an amount of CTO:Reset)</i>	Stop and reset CTO timer <i>SafetyAlert()[CTOS] = 0 SafetyStatus()[CTO] = 0 BatteryStatus()[TCA] = 0 OperationStatus()[XCHG] = 0</i>

DRAFT ONLY

Permanent Fail

3.1 Introduction

The device can permanently disable the use of the battery pack in case of a severe failure, like IFC or DF. When one of these failure modes is detected the following actions are taken in sequence:

1. Charge, and discharge FETs are turned off.
2. $OperationStatus()[PF] = 1$
3. The following data is changed: $BatteryStatus()[TCA] = 1$, $BatteryStatus()[TDA] = 1$, $ChargingCurrent() = 0$, and $ChargingVoltage() = 0$.
4. A backup of the internal AFE hardware registers are written to data flash: **AFE Interrupt Status, AFE FET Status, AFE RXIN, AFE Latch Status, AFE Interrupt Enable, AFE FET Control, AFE RXIEN, AFE Cell Balance, AFE AD/CC Control, AFE ADC Mux, AFE State Control, Wake Control, AFE Protection Control, AFE OCD, AFE SCC, AFE SCD1, and AFE SCD2.**
5. The following values are preserved in data flash for failure analysis:
 - $SafetyAlert()$
 - $SafetyStatus()$
 - $OperationStatus()$
 - $ChargingStatus()$
 - $GaugingStatus()$
 - Voltages in $DAStatus1()$
 - $Current()$
 - TSINT, TS1, from $DAStatus2()$
 - Cell DOD0 and passed charge
6. Data flash writing is disabled.

While the device is in this PERMANENT FAIL mode, any new $SafetyAlert()$, $SafetyStatus()$, flags that are set are added to the permanent fail log.

3.2 Safety Cell Overvoltage Permanent Fail

The device can permanently disable the battery in the case of severe overvoltage in any of the cells.

Status	Condition	Action
Normal	All Cell voltages in $DAStatus1() < SOV:Threshold$	$PFAAlert()[SOV] = 0$
Alert	Any Cell voltages in $DAStatus1() \geq SOV:Threshold$	$PFAAlert()[SOV] = 1$ $BatteryStatus()[TCA] = 1$ $BatteryStatus()[OCA] = 1$
Trip	Any Cell voltages in $DAStatus1()$ continuous $\geq SOV:Threshold$ for $SOV:Delay$ duration	$PFAAlert()[SOV] = 0$ $PFStatus()[SOV] = 1$ $BatteryStatus()[OCA] = 1$ $BatteryStatus()[TCA] = 1$ $BatteryStatus()[TDA] = 1$

3.3 Instruction Flash (IF) Checksum Permanent Fail

The device can permanently disable the battery if it detects a difference between the stored IF checksum and the calculated IF checksum only following a device reset.

Status	Condition	Action
Normal	Stored and calculated IF checksum match	—
Trip	Stored and calculated IF checksum after reset does not match	<i>PFStatus()[IFC] = 1</i> <i>BatteryStatus()[TCA] = 1</i> <i>BatteryStatus()[TDA] = 1</i>

3.4 Data Flash (DF) Permanent Fail

The device can permanently disable the battery in case a data flash write fails.

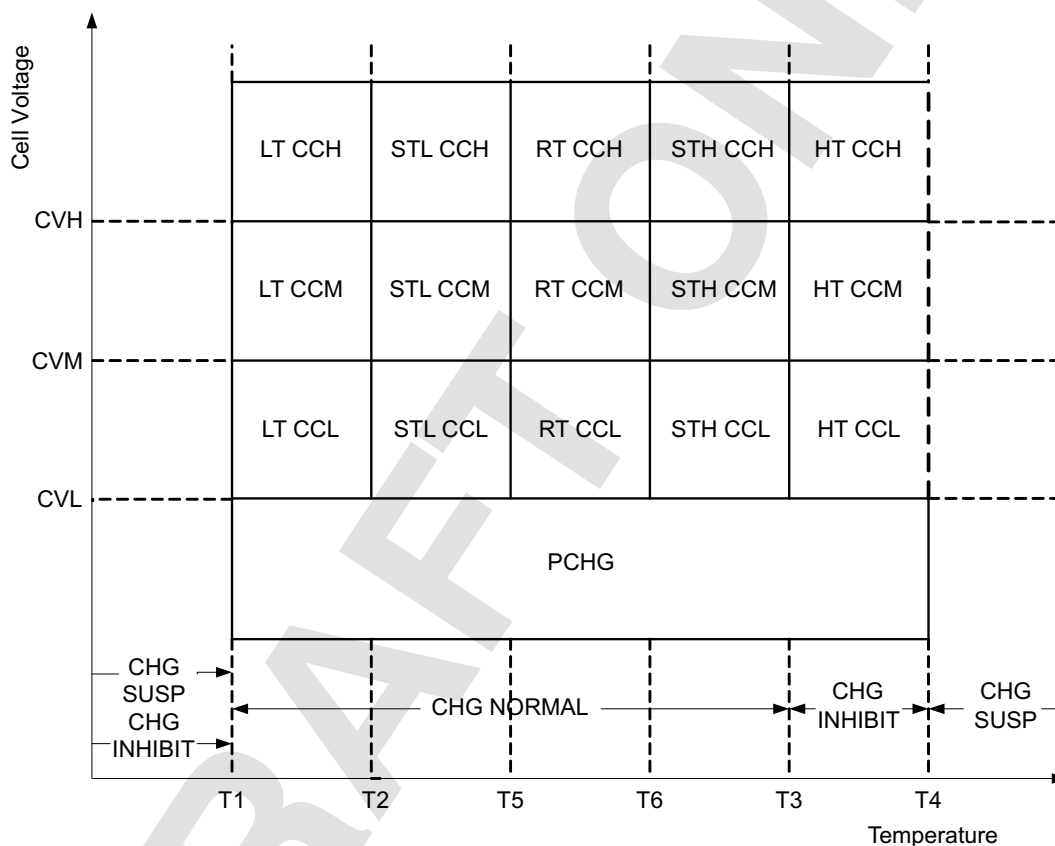
NOTE: A DF write failure causes the gauge to disable further DF writes.

Status	Condition	Action
Normal	Data flash write ok	—
Trip	Data flash write not successful	<i>PFStatus()[DFW] = 1</i> <i>BatteryStatus()[TCA] = 1</i> <i>BatteryStatus()[TDA] = 1</i>

Advanced Charge Algorithm

4.1 Introduction

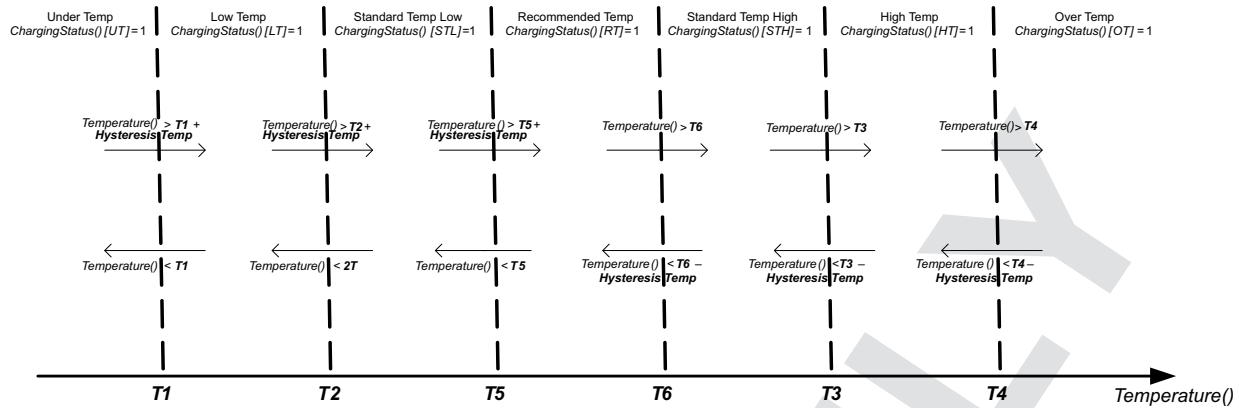
The device can change the values of *ChargingVoltage()* and *ChargingCurrent()* based on *Temperature()* and *Cell Voltage1..4()*. Its flexible charging algorithm is JEITA compatible and can also meet other specific cell manufacturer charge requirements. The *ChargingStatus()* register shows the state of the charging algorithm.



4.2 Charge Temperature Ranges

The measured temperature is segmented into several temperature ranges. The charging algorithm adjusts *ChargingCurrent()* and *ChargingVoltage()* according to the temperature range. The temperature ranges set in data flash should adhere to the following format:

$$T1 \leq T2 \leq T5 \leq T6 \leq T3 \leq T4$$

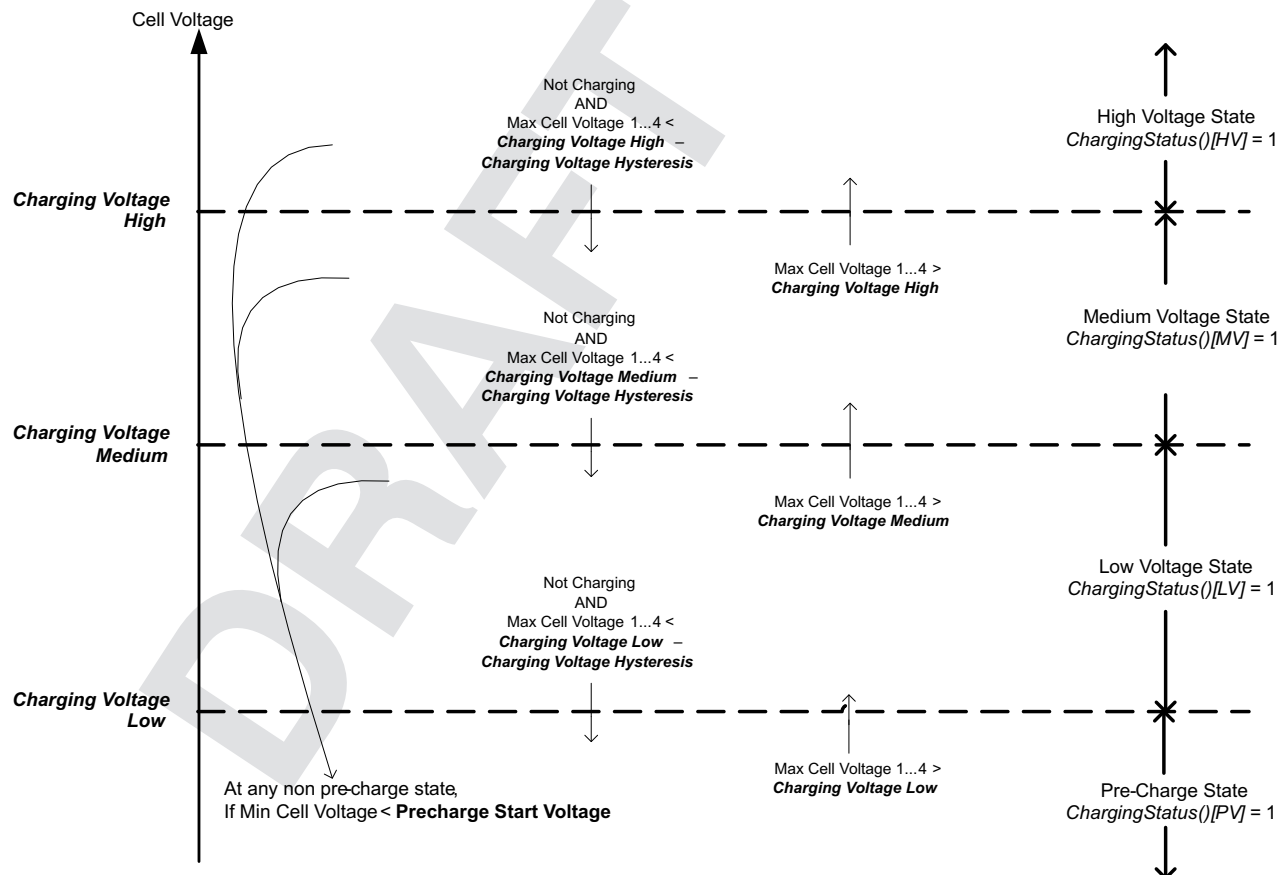


4.3 Voltage Range

The measured cell voltage is segmented into several voltage ranges. The charging algorithm adjusts *ChargingCurrent()* according to the temperature range and voltage range. The voltage ranges set in data flash need to adhere to the following format:

$$Charging\ Voltage\ Low \leq Charging\ Voltage\ Med \leq Charging\ Voltage\ High \leq x\ Temp\ Charging:Voltage$$

where x is Standard or Rec. Depending on the specific charging profile, the **Low Temp Charging:Voltage** and **High Temp Charging:Voltage** settings do not necessarily have the highest setting values.



4.4 Charging Current

The *ChargingCurrent()* value changes depending on the detected temperature and voltage per the charging algorithm.

The **Charging Configuration[CRATE]** flag provides an option to adjust the *ChargingCurrent()* based on *FullChargeCapacity()/DesignCapacity()*.

For example, with **[CRATE] = 1**, if *FullChargeCapacity()/DesignCapacity()* = 90% and **Rec Temp Charging: Current Med** is active per the charging algorithm, the *ChargeCurrent()* = **Rec Temp Charging: Current Med** × 90%.

NOTE: Table priority is top to bottom.

Temp Range	Voltage Range	Condition	Action
Any	Any	<i>OperationStatus()[XCHG] = 1</i>	<i>ChargingCurrent() = 0</i>
UT or OT	Any	—	<i>ChargingCurrent() = 0</i>
Any	PV	—	Charging:Current Pre-Charging:Current
Any	LV, MV, or HV	<i>ChargingStatus()[MCHG] = 1</i>	<i>ChargingCurrent() = Maintenance Charging:Current</i>
LT	LV	—	<i>ChargingCurrent() = Low Temp Charging:Current Low</i>
	MV	—	<i>ChargingCurrent() = Low Temp Charging:Current Med</i>
	HV	—	<i>ChargingCurrent() = Low Temp Charging:Current High</i>
STL or STH	LV	—	<i>ChargingCurrent() = Standard Temp Charging:Current Low</i>
	MV	—	<i>ChargingCurrent() = Standard Temp Charging:Current Med</i>
	HV	—	<i>ChargingCurrent() = Standard Temp Charging:Current High</i>
RT	LV	—	<i>ChargingCurrent() = Rec Temp Charging:Current Low</i>
	MV	—	<i>ChargingCurrent() = Rec Temp Charging:Current Med</i>
	HV	—	<i>ChargingCurrent() = Rec Temp Charging:Current High</i>
HT	LV	—	<i>ChargingCurrent() = High Temp Charging:Current Low</i>
	MV	—	<i>ChargingCurrent() = High Temp Charging:Current Med</i>
	HV	—	<i>ChargingCurrent() = High Temp Charging:Current High</i>

4.5 Charging Voltage

The *ChargingVoltage()* changes depending on the detected temperature per the charge algorithm.

NOTE: Table priority is top to bottom.

Temp Range	Condition	Action
Any	$OperationStatus()[XCHG] = 1$	$ChargingVoltage() = 0$
UT or OT	—	$ChargingVoltage() = 0$
LT	—	$ChargingVoltage() = \text{Low Temp Charging:Voltage} \times (DA\ Configuration[CC1:CC0] + 1)$
STL or STH	—	$ChargingVoltage() = \text{Standard Temp Charging:Voltage} \times (DA\ Configuration[CC1:CC0] + 1)$
RT	—	$ChargingVoltage() = \text{Rec Temp Charging:Voltage} \times (DA\ Configuration[CC1:CC0] + 1)$
HT	—	$ChargingVoltage() = \text{High Temp Charging:Voltage} \times (DA\ Configuration[CC1:CC0] + 1)$

4.6 Valid Charge Termination

The charge termination condition must be met to enable valid charge termination. The device has the following actions at charge termination, based on the flags settings:

- If **FETOption[CHGFET] = 1**, CHG FET turns off.
- If **Gauging Configuration[CSYNC] = 1**, $RemainingCapacity() = FullChargeCapacity()$.
- If **Gauging Configuration[RSOCL] = 1**, $RelativeStateOfCharge()$ and $RemainingCapacity()$ are held at 99% until charge termination occurs. Only on entering charge termination is 100% displayed.
- If **Gauging Configuration[RSOCL] = 0**, $RelativeStateOfCharge()$ and $RemainingCapacity()$ are not held at 99% until charge termination occurs. Fractions of % greater than 99% are rounded up to display 100%.

Status	Condition	Action
Charging	$GaugingStatus()[REST] = 0$ AND $GaugingStatus()[DSG] = 0$	Charge Algorithm active
Valid Charge Termination	All of the following conditions must occur for two consecutive 40-s periods: Charging (i.e., $BatteryStatus[DSG] = 0$) AND $AverageCurrent() < \text{Charge Term Taper Current}$ AND $\text{Max}(CellVoltage2...1) + \text{Charge Term Voltage} \geq ChargingVoltage() / \text{number of cells in series}$ AND The accumulated change in capacity > 0.25 mAh.	$ChargingStatus()[VCT] = 1$ $ChargingStatus()[MCHG] = 1$ $ChargingVoltage() = \text{Charging Algorithm}$ $ChargingCurrent() = \text{Charging Algorithm}$ $BatteryStatus()[FC] = 1$ and $GaugingStatus()[FC] = 1$ if SOCFlagConfig A[FCSETVCT] = 1 $BatteryStatus()[TCA] = 1$ and $GaugingStatus()[TCA] = 1$ if SOCFlagConfig B[TCASETVCT] = 1

Charge and Discharge Alarms

The $[TCA]$ and $[FC]$ bits in $GaugingStatus()$ can be set at charge termination as well as based on RSOC or cell voltages. If multiple set and clear conditions are selected, then the corresponding flag will be set whenever a valid set or clear condition is met. If both set and clear conditions are true at the same time, the flag will clear. The same functionality is applied to the $[TDA]$ and $[FD]$ bits in $GaugingStatus()$.

NOTE: $GaugingStatus[TC][TD][FC][FD]$ are the status flags based on the gauging conditions only. These flags are set and cleared based on **SOCFlagConfigA** and **SOCFlagConfigB**.

The $BatteryStatus[TC][TD][FC][FD]$ flags will be set and cleared according to the $BatteryStatus[TCA][TDA][FC][FD]$ flags as well as the safety and permanent failure protections status.

The table below summarizes the various options to set and clear the $[TC]$ and $[FC]$ flags in $GaugingStatus()$.

Flag	Set Criteria	Set Condition	Enable
[TC]	Cell Voltage	Max cell voltage _{1..2} ≥ TC: Set Voltage Threshold	SOCFlagConfigA[TCSetV] = 1
	RSOC	<i>RelativeStateOfCharge()</i> > = TC: Set % RSOC Threshold	SOCFlagConfigA[TCSetRSOC] = 1
	Valid Charge Termination (enable by default)	When <i>ChargingStatus[VCT]</i> = 1	SOCFlagConfigA[TCSetVCT] = 1
[FC]	Cell Voltage	Max cell voltage _{1..2} ≥ FC: Set Voltage Threshold	SOCFlagConfigB[FCSetV] = 1
	RSOC	<i>RelativeStateOfCharge()</i> > = FC: Set % RSOC Threshold	SOCFlagConfigB[FCSetRSOC] = 1
	Valid Charge Termination (enable by default)	When <i>ChargingStatus[VCT]</i> = 1	SOCFlagConfigA[FCSetVCT] = 1

Flag	Clear Criteria	Clear Condition	Enable
[TC]	cell voltage	Max cell voltage _{1..2} ≤ TC: Clear Voltage Threshold	SOCFlagConfigA[TCClearV] = 1
	RSOC (enable by default)	<i>RelativeStateOfCharge()</i> ≤ TC: Clear % RSOC Threshold	SOCFlagConfigA[TCClearRSOC] = 1
[FC]	cell voltage	Max cell voltage _{1..2} ≤ FC: Clear Voltage Threshold	SOCFlagConfigB[FCClearV] = 1
	RSOC (enable by default)	<i>RelativeStateOfCharge()</i> ≤ FC: Clear % RSOC Threshold	SOCFlagConfigB[FCClearRSOC] = 1

The tables below summarize the various options to set and clear the [TD] and [FD] flags in both *BatteryStatus()* and *GaugingStatus()*.

Flag	Set Criteria	Set Condition	Enable
[TD]	cell voltage	Max cell voltage _{1..2} ≤ TD: Set Voltage Threshold	SOCFlagConfigA[TDSetV] = 1
	RSOC (enable by default)	<i>RelativeStateOfCharge()</i> ≤ = TD: Set % RSOC Threshold	SOCFlagConfigA[TDSetRSOC] = 1
[FD]	cell voltage	Max cell voltage _{1..2} ≤ = FD: Set Voltage Threshold	SOCFlagConfigB[FDSetV] = 1
	RSOC (enable by default)	<i>RelativeStateOfCharge()</i> ≤ = FD: Set % RSOC Threshold	SOCFlagConfigB[FDSetRSOC] = 1

Flag	Clear Criteria	Clear Condition	Enable
[TD]	cell voltage	Max cell voltage _{1..2} ≥ TD: Clear Voltage Threshold	SOCFlagConfigA[TDClearV] = 1
	RSOC (enable by default)	<i>RelativeStateOfCharge()</i> ≥ TD: Clear % RSOC Threshold	SOCFlagConfigA[TDClearRSOC] = 1
[FD]	cell voltage	Max cell voltage _{1..2} ≥ FD: Clear Voltage Threshold	SOCFlagConfigB[FDClearV] = 1
	RSOC (enable by default)	<i>RelativeStateOfCharge()</i> ≥ FD: Clear % RSOC Threshold	SOCFlagConfigB[FDClearRSOC] = 1

Terminate Charge and Discharge Alarms

When the protections are triggered, the *BatteryStatus()*[TCA][TDA][FD][OCA][OTA] will be set according to the type of safety protections. The following is a summary of the set conditions and their various alarm flags.

[TCA] = 1

- *SafetyAlert()*[OCC], [COV], [OTC], = 1 OR

- $GaugingStatus()[TC] = 1$ AND in CHARGE Mode
[OCA] = 1 if
- $SafetyStatus()[OC] = 1$ AND in CHARGE Mode
[TDA] = 1
- $SafetyAlert()[OCC1], [COV], [OTC], = 1$ OR
- $GaugingStatus()[TD] = 1$ AND in DISCHARGE Mode
[FD] = 1 if
- $GaugingStatus()[FD] = 1$
- [OTA] = 1 if
- $SafetyStatus()[OTC], [OTD] = 1$

Precharge

The device enters PRECHARGE mode if any cell voltage goes below **Charging Voltage Low**. The external CHG FET can be used in PRECHARGE mode. Setting the **Pre-Charging: Current** = 0 mA disables the precharge function by requesting 0 mA charging current from the charger. The [PCHG] = 1 (CHG FET is used in PRECHARGE mode).

The device also supports 0-V charging. It enables the hardware 0-V charging circuit automatically when the battery stack voltage is below the minimum operation voltage of the device (see the *bq28z610 1-Cell to 2-Series Cell Li-Ion Battery Pack Manager* data sheet [SLUSB49] for bq28z610 electrical specifications).

4.7 Maintenance Charge

Maintenance charge can be configured to provide charge current after charge termination is reached.

Status	Condition	Action
Set	$ChargingStatus()[IN] = 0$ AND $ChargingStatus()[SU] = 0$ AND $ChargingStatus()[PV] = 0$ AND $GaugingStatus()[TCA] = 1$	$ChargingStatus()[MCHG] = 1$ $ChargingVoltage() =$ Charging Algorithm $ChargingCurrent() =$ Charging Algorithm
Clear	$ChargingStatus()[IN] = 1$ OR $ChargingStatus()[SU] = 1$ OR $ChargingStatus()[PV] = 1$ OR $GaugingStatus()[TCA] = 0$	$ChargingStatus()[MCHG] = 0$ $ChargingVoltage() =$ Charging Algorithm $ChargingCurrent() =$ Charging Algorithm

4.8 Charge Control Broadcasts

The [BCAST] bit enables all broadcasts to a host or a smart charger. When the [BCAST] bit is enabled, the following broadcasts are sent:

- $ChargingVoltage()$ and $ChargingCurrent()$ broadcasts are sent to the smart-charger device address, which is set in Data Flash Register **Settings>Charger>Device Address** and the broadcast period is set in **Settings>Charger>Broadcast Pacing**.
- If any of the [OCA], [TCA], [OTA], [TDA], [RCA], [RTA] flags are set, the *AlarmWarning* broadcast is sent to the host device address (0x14) every 10 seconds. Broadcasts stop when all flags above have been cleared.
- If any of the [OCA], [TCA], [OTA], [TDA] flags are set, the *AlarmWarning* broadcast is sent to a smart-charger device address every 10 seconds. Broadcasts stop when all flags above have been cleared.

4.9 Charge Disable And Discharge Disable

The device can disable charging if certain safety conditions are detected, setting the $OperationStatus()[XCHG] = 0$.

Status	Condition	Action
Normal	$SafetyStatus()[COV] = 0$ AND $SafetyStatus()[OCC] = 0,0$ AND $SafetyStatus()[ASCC] = 0$ AND AND $SafetyStatus()[CTO] = 0$ AND $SafetyStatus()[PTO] = 0$ AND $GaugingStatus()[TCA] = 0$ if Charging Configuration[CHGFET] = 1	$ChargingVoltage() =$ Charging Algorithm $ChargingCurrent() =$ Charging Algorithm $OperationStatus()[XCHG] = 0$
Trip	$ManufacturingStatus()[FET_EN] = 0$ OR $SafetyStatus()[COV] = 1$ OR $SafetyStatus()[OCC] = 1$ OR $SafetyStatus()[ASCC] = 1$ OR $SafetyStatus()[CTO] = 1$ OR $SafetyStatus()[PTO] = 1$ OR $SafetyStatus()[OC] = 1$ OR $SafetyStatus()[UTC] = 1$ OR $SafetyStatus()[OTC] = 1$ if $ChargingStatus()[IN] = 1$ if [CHGIN] = 1 OR $ChargingStatus()[SU] = 1$ if [CHGSU] = 1 OR $OperationStatus()[SLEEP] = 1$ if AND [SLEEPCHG] = 0 OR $GaugingStatus()[TCA] = 1$ if Charging Configuration[CHGFET] = 1	$ChargingVoltage() = 0$ $ChargingCurrent() = 0$ $OperationStatus()[XCHG] = 1$

Similarly, the device can disable discharge if certain safety conditions of any if the following conditions is detected, setting the $OperationStatus()[XDSG] = 1$.

- $ManufacturingStatus()[FET_EN] = 0$, OR
- Any $PFStatus()$ set, OR
- $SafetyStatus()[OCD]$ or $[CUV]$ or $[CUVC]$ or $[AOLD]$ or $[ASCD]$ or $[UTD] = 1$, OR
- $SafetyStatus()[OTD] =$, OR
- $OperationStatus()[SDM] = 1$ AND delay time > **FET Off Time**, OR
- $OperationStatus()[SDV] = 1$ AND low voltage time \geq **Shutdown Time**

4.10 Charge Inhibit

The device can inhibit the start of charging at high and low temperatures to prevent damage of the cells. This feature prevents the start of charging when the temperature is at the inhibit range; therefore, if the device is already in the charging state when the temperature reaches the inhibit range, a FET action will not take place even if **FET Options[CHGIN] = 1**.

Status	Condition	Action
Normal	$ChargingStatus()[LT] = 1$ OR $ChargingStatus()[STL] = 1$ OR $ChargingStatus()[RT] = 1$ OR $ChargingStatus()[STH] = 1$	$ChargingStatus()[IN] = 0$ $ChargingVoltage() =$ charging algorithm $ChargingCurrent() =$ charging algorithm
Trip	Not charging AND ($ChargingStatus()[HT] = 1$ OR $ChargingStatus()[OT] = 1$) OR $ChargingStatus()[UT] = 1$	$ChargingStatus()[IN] = 1$ $ChargingStatus()[SU] = 0$ $ChargingVoltage() = 0$ $ChargingCurrent() = 0$ $ChargingCurrent()[XCHG] = 1$ if FET Options[CHGIN] = 1 .

4.11 Charge Suspend

The device can stop charging at high and low temperatures to prevent damage of the cells.

Status	Condition	Action
Normal	<i>ChargingStatus()[LT] = 1 OR</i> <i>ChargingStatus()[STL] = 1 OR</i> <i>ChargingStatus()[RT] = 1 OR</i> <i>ChargingStatus[STH] = 1 OR</i> <i>ChargingStatus()[HT] = 1</i>	<i>ChargingStatus()[SU] = 0</i> <i>ChargingVoltage() = charging algorithm</i> <i>ChargingCurrent() = charging algorithm</i>
Trip	<i>ChargingStatus()[UT] = 1 OR</i> <i>ChargingStatus()[OT] = 1</i>	<i>ChargingStatus()[SU] = 1</i> <i>ChargingVoltage() = 0</i> <i>ChargingCurrent() = 0</i> No charging is allowed if FET Options[CHGSU] = 1 .

DRAFT ONLY

Power Modes

Introduction

To enhance battery life, the bq28z610 supports several power modes to minimize power consumption during operation.

5.1 NORMAL Mode

In NORMAL mode, the device takes voltage, current, and temperature readings every 250 ms, performs protection and gauging calculations, and updates data, and makes status decisions at 1-s intervals. Between these periods of activity, the device is in a reduced power state.

The [NR] bit is set, and the system assumes a non removal battery pack.

5.2 SLEEP Mode

5.2.1 Device Sleep

When the sleep conditions are met, the device goes into SLEEP mode with periodic wake-ups to reduce power consumption. The device returns to NORMAL mode if any exit Sleep condition is met.

Status	Condition	Action
Activate	If [IN_SYSTEM_SLEEP] = 0, or no communication for Bus Timeout if [IN_SYSTEM_SLEEP] = 1 AND DA Config[SLEEP] = 1 ⁽¹⁾ AND Current() ≤ Sleep Current AND Voltage Time > 0 AND OperationStatus()[SDM] = 0 AND No SafetyAlert() bits set AND ⁽²⁾ No [AOLD], [ASCC], [ASCD], set in SafetyStatus()	Turn off CHG FET if DA Configuration[SLEEPCHG] = 0 . Device goes to sleep. Device wakes up every Sleep:Voltage Time period to measure voltage and temperature. Device wakes up every Sleep:Current Time period to measure current.
Exit	SMBus connected ⁽¹⁾ OR SMBus command received ⁽³⁾ OR DA Config[SLEEP] = 1 ⁽¹⁾ OR Current() > Sleep Current OR Wake comparator activates ⁽⁴⁾ OR Voltage Time = 0 OR OperationStatus()[SDM] = 1 OR SafetyAlert() bits set OR [AOLD], [ASCC], [ASCD], set in SafetyStatus()	Return to NORMAL mode

⁽¹⁾ **DA Config[SLEEP]** and SMBus low are not checked if the **ManufacturerAccess()** SLEEP mode command is used to enter SLEEP mode.

⁽²⁾ **SafetyAlert()[PTO], [PTOS], [CTO], [CTOS]** will not prevent the gauge to enter SLEEP mode.]

⁽³⁾ Wake on SMBus command is only possible when the gas gauge is put to sleep using the **ManufacturerAccess()** SLEEP mode command or **[IN_SYSTEM_SLEEP]** is enabled with **Bus Timeout = 0**. Otherwise, the gas gauge wakes on an SMBus connection (clock or data high).

⁽⁴⁾ The wake comparator threshold is set through **Power.WakeComparator[WK1,WK0]** (see [Section 5.2.3](#)).

In System Sleep

When the **DA Config**[*IN_SYS_SLEEP*] = 1, the device will enter SLEEP mode. All the other sleep conditions must be met for the device to enter SLEEP mode.

5.2.2 ManufacturerAccess() MAC Sleep

The SLEEP MAC command can override the requirement for bus low to enter sleep. In this case, the part clock and data high condition is ignored for sleep to exit, though sleep will also exit if there is any further communication. The device can be sent to sleep with *ManufacturerAccess()* if specific sleep entry conditions are met.

5.2.3 Wake Function

The device can exit SLEEP mode if enabled by the presence of a voltage across SRP and SRN. The voltage threshold needed for the device to wake from sleep mode is programmed in **Power:Wake Comparator**.

Reserved (Bits 7–4, 1–0): Reserved, do not use.

WK1,0 (Bits 3–2): Wake Comparator Threshold

WK1	WK0	Voltage
0	0	±0.625 mV
0	1	±1.25 mV
1	0	±2.5 mV
1	1	±5 mV

5.3 SHUTDOWN Mode

5.3.1 Voltage Based Shutdown

To minimize power consumption and avoid draining the battery, the device can be configured to shutdown at a programmable stack voltage threshold.

Status	Condition	Action
Enable	Min cell voltage < Shutdown Voltage	<i>OperationStatus()</i> [SDV] = 1
Trip	Min cell voltage continuous < Shutdown Voltage for Shutdown Time	Turn DSG FET off
Shutdown	Voltage at PACK pin < Charger Present Threshold	Send device into SHUTDOWN mode
Exit	Voltage at PACK pin > $V_{STARTUP}$	<i>OperationStatus()</i> [SDV] = 0 Return to NORMAL mode

NOTE: The device goes through a full reset when exiting from SHUTDOWN mode, which means the device will re-initialized. On power up, the gauge will check some special memory locations. If the memory checksum is incorrect, or if either the gauge or the AFE watchdog has been triggered, the gauge will do a full reset.

If the memory checksum is good, for example in the case of a short power glitch, the gauge will do a partial reset. The initialization is faster in partial reset, and certain memory data will not be re-initialized (for example, all SBS registers, last known FET state, last ADC and CC readings, and so on) and so partial reset is usually transparent to the host.

5.3.2 *ManufacturerAccess()* MAC Shutdown

In SHUTDOWN mode, the device turns off the CHG and DSG FETs after **FET Off Time**, and then shuts down to minimize power consumption after **Delay** time. Both **FET Off Time** and **Delay** time are referenced to the time the gauge received the command. Hence, the **Delay** time must be set longer than the **FET Off Time**. The device returns to NORMAL mode when the voltage at PACK pin $> V_{\text{Startup}}$. The device can be sent to this mode with the *ManufacturerAccess()*Shutdown command. Charger voltage must NOT be present for the device to enter SHIP SHUTDOWN mode.

Note: If the gauge is unsealed and MAC Shutdown() command is sent twice in a row, the gauge will execute the shutdown sequence immediately and skip the normal delay sequence.

5.3.3 *Time Based Shutdown*

The device can be configured to shutdown after staying in SLEEP mode without communication for a preset time interval specified in the **Auto Ship Time**. setting the **PowerConfig[AUTO_SHIP_EN] = 1** enables this feature. Any communication to the device will restart the timer. When the timer reaches the Auto Ship Time, the time based shutdown effectively trigger the MAC shutdown command to start the shutdown sequence. The device returns to NORMAL mode when voltage at PACK pin $> V_{\text{Startup}}$.

DRAFT ONLY

Gauging

6.1 Introduction

The bq28z610 measures individual cell voltages, pack voltage, temperature, and current. It determines battery state of charge by analyzing individual cell voltages when a time exceeding 10 minutes has passed since the last charge or discharge activity of the battery.

The bq28z610 measures charge and discharge activity by monitoring the stable voltage across a small-value series sense resistor (1 mΩ typ.) between the negative terminal of the cell stack and the negative terminal of the battery pack. The battery state of charge is subsequently adjusted during load or charger application using the integrated charge passed through the battery. The device is capable of supporting a maximum battery pack capacity of 32Ah. See the Theory and Implementation of Impedance Track Battery Fuel-Gauging Algorithm in the *bq20zxx Product Family Application Report* ([SLUA364B](#)) for further details.

The default for Impedance Track gauging is *off*. To enable the gauging function, set **Manufacturing Status[GAUGE_EN]** = 1. The gauging function will be enabled after a reset or a seal command is set. Alternatively, the MAC command, *Gauging()*, can be used to turn on and off the gauging function. The *Gauging()* will take immediately effect and the **[GAUGE_EN]** will also be updated accordingly.

The *ITStatus1()*, *ITStatus2()*, and *ITStatus3()* commands return various gauging related information. It is usefully for problem analysis.

6.2 Impedance Track Configuration

Load Mode — During normal operation, the battery-impedance profile compensation of the Impedance Track algorithm can provide more accurate full-charge and remaining state-of-charge information if the typical load type is known. The two selectable options are constant current (**Load Mode** = 0) and constant power (**Load Mode** = 1).

Load Select — To compensate for the $I \times R$ drop near the end of discharge, the bq28z610 must be configured for whatever current (or power) will flow in the future. While it cannot be exactly known, the bq28z610 can use load history such as the average current of the present discharge to make a sufficiently accurate prediction.

The bq28z610 can be configured to use several methods of this prediction by setting the **Load Select** value. Because this estimate has only a second-order effect on remaining capacity accuracy, different measurement-based methods (methods 0 to 3, and method 7) result in only minor differences in accuracy. However, methods 4–6, where an estimate is arbitrarily assigned by the user, can result in significant error if a fixed estimate is far from the actual load. For highly variable loads, selection 7 provides the most conservative estimate and is preferable.

Constant Current (Load Mode = 0)	Constant Power (Load Mode = 1)
0 = Avg I Last Run	Avg P Last Run
1 = Present average discharge current	Present average discharge power
2 = <i>Current()</i>	<i>Current()</i> × <i>Voltage()</i>
3 = <i>AverageCurrent()</i>	<i>AverageCurrent()</i> × average <i>Voltage()</i>
4 = Design Capacity/5	Design Energy/5
5 = <i>AtRate()</i> (mA)	<i>AtRate()</i> (10 mW)
6 = User Rate-mA	User Rate-mW
7 = Max Avg I Last Run (default)	Max Avg P Last Run

Pulsed Load Compensation and Termination Voltage — To take into account pulsed loads while calculating remaining capacity until **Term Voltage** threshold is reached, the bq28z610 monitors not only average load but also short load spikes. The maximum voltage deviation during a load spike is continuously updated during discharge and stored in **Term Voltage Delta**.

Reserve Battery Capacity — The bq28z610 allows an amount of capacity to be reserved in either mAh (**Reserve Cap-mAh, Load Mode = 0**) or 10 mWh (**Reserve Cap-mWh, Load Mode = 1**) units between the point where the *RemainingCapacity* function reports zero capacity and the absolute minimum pack voltage, **Term Voltage**. This enables a system to report zero energy, but still have enough reserve energy to perform a controlled shutdown or provide an extended sleep period for the host system.

The reserve capacity is compensated at the present discharge rate as selected by **Load Select**.

Pack Based AND Cell Based Termination Voltage — The bq28z610 will force *RemainingCapacity()* to 0mAh when battery stack voltage reaches **Term Voltage**. If **IT GaugingConfiguration[CELL_TERM] = 1**, the cell based termination is used, the **Term Min Cell V** threshold checked for termination condition. The cell based termination is to provide an option to allow the gauge to reach 0mAh before the device triggers CUV especially for a imbalance pack.

6.3 Gas Gauge Modes

Resistance updates take place only in DISCHARGE mode, while OCV and QMax updates only take place in RELAX mode. Entry and exit of each mode is controlled by data flash parameters in the subclass **Gas Gauging: Current Thresholds** section. When the device is determined to be in RELAX mode and OCV is taken, the *GaugingStatus[REST]* flag is set. In RELAX mode or DISCHARGE mode, the DSG flag in *BatteryStatus* is set.

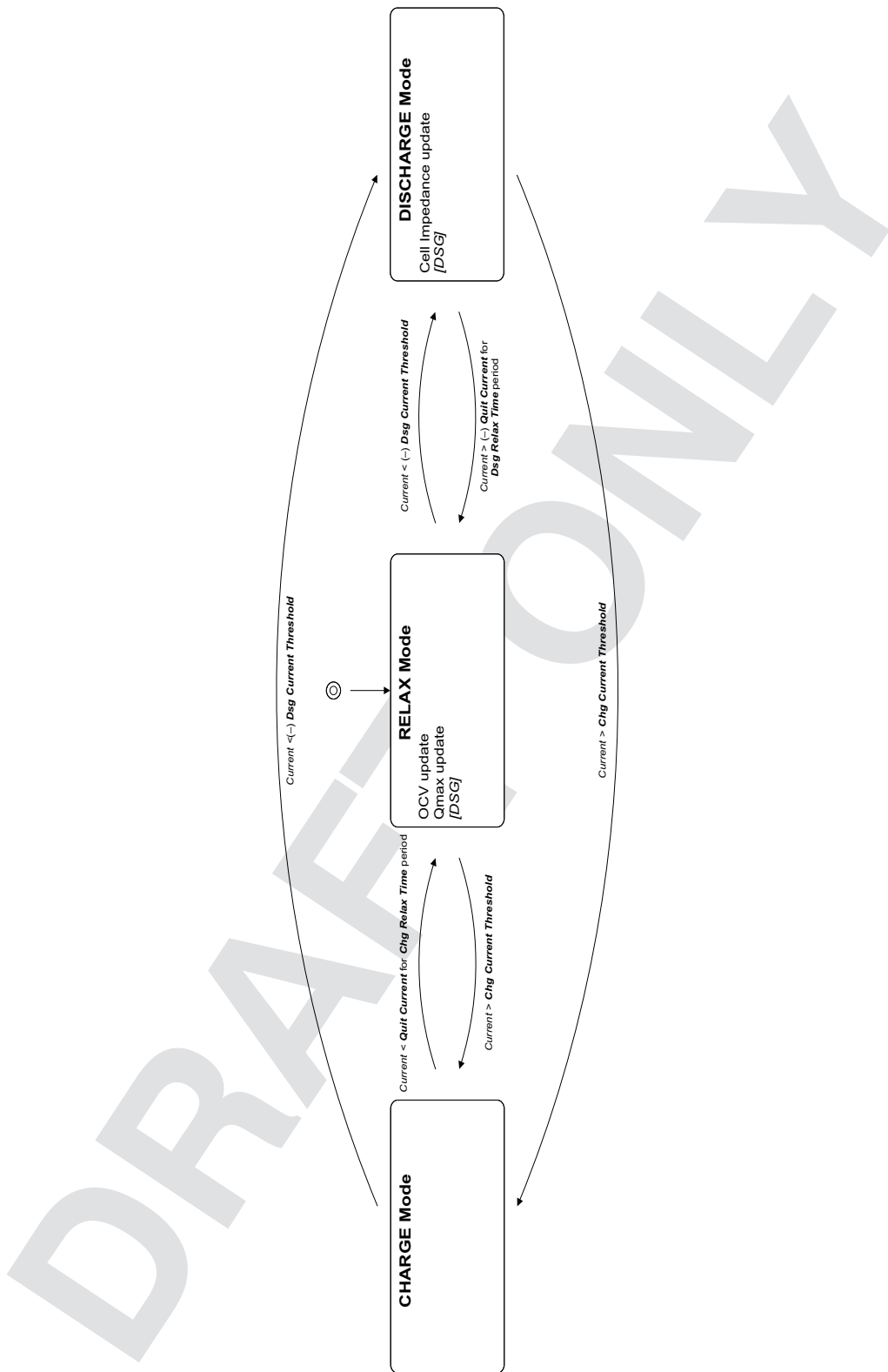


Figure 6-1. Gas Gauge Operating Modes

CHARGE mode is exited and RELAX mode is entered when *Current* goes below **Quit Current** for a period of **Chg Relax Time**. DISCHARGE mode is entered when *Current* goes below **(-)Dsg Current Threshold**. DISCHARGE mode is exited and RELAX mode is entered when *Current* goes above **(-)Quit Current** threshold for a period of **Dsg Relax Time**. CHARGE mode is entered when *Current* goes above **Chg Current Threshold**.

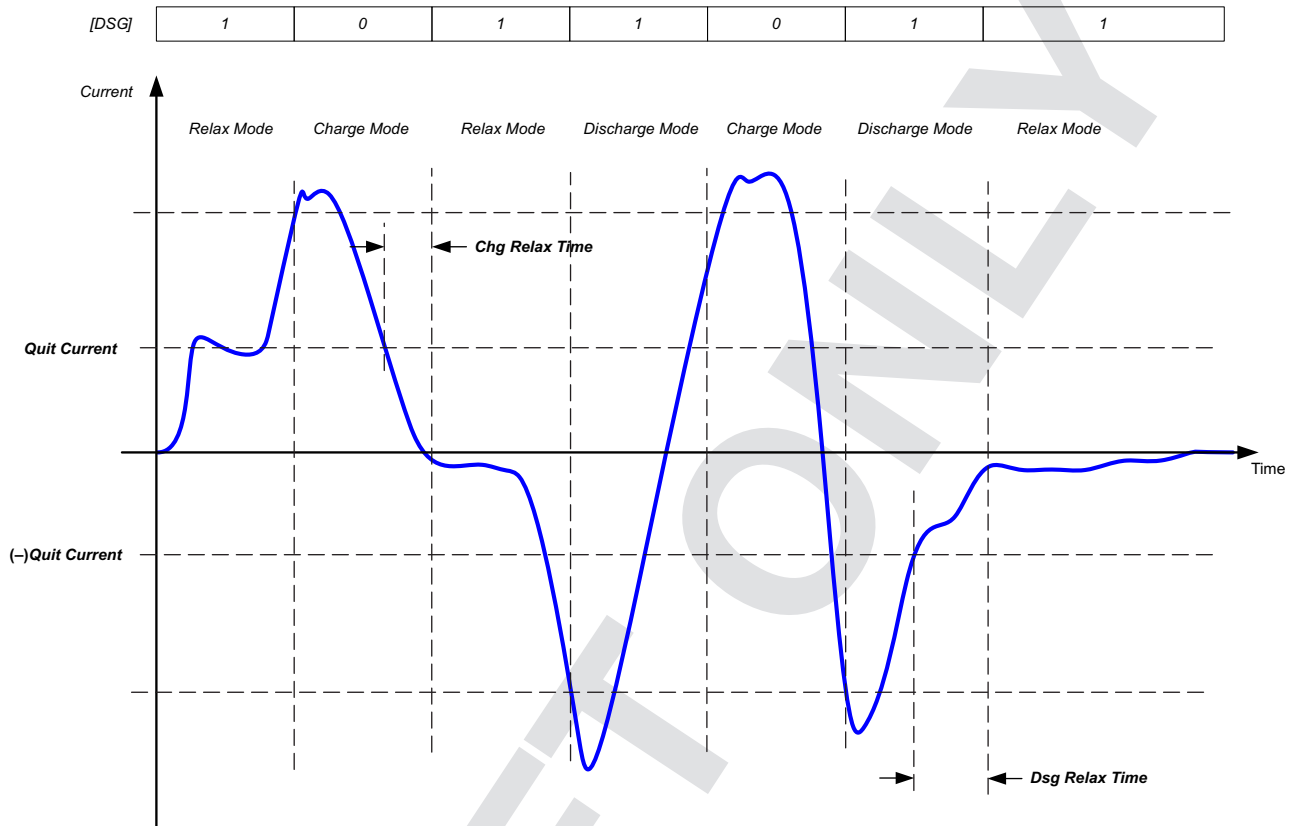


Figure 6-2. Gas Gauge Operating Mode Example

6.4 QMax and Ra

The total battery capacity is found by comparing states of charge before and after applying the load with the amount of charge passed. When an applications load is applied, the impedance of each cell is measured by comparing the open circuit voltage (OCV) obtained from a predefined function for present state of charge with the measured voltage under load.

Measurements of OCV and charge integration determine chemical state of charge and Chemical Capacity (*QMax*).

The bq28z610 acquires and updates the battery-impedance profile during normal battery usage. It uses this profile, along with state-of-charge and the *QMax* values, to determine *FullChargeCapacity* and *RelativeStateOfCharge* specifically for the present load and temperature. *FullChargeCapacity* reports a capacity or energy available from a fully charged battery reduced by **Reserve Cap-mAh** or **Reserve Cap-mWh** under the present load and present temperature until *Voltage* reaches the **Term Voltage**.

6.4.1 QMax Initial Values

The initial **QMax Pack**, **QMax Cell 0**, and **QMax Cell 1** values should be taken from the cell manufacturers' data sheet multiplied by the number of parallel cells, and are also used for the *DesignCapacity* function value in the **Design Capacity** data flash value.

See the *Theory and Implementation of Impedance Track Battery Fuel-Gauging Algorithm in bq20zxx Product Family Application Report (SLUA364B)* for further details.

6.4.2 QMax Update Conditions

QMax update is enabled when gauging is enabled. This is indicated by the *GaugingStatus[QEN]* flag. The bq28z610 updates the no-load full capacity (QMax) when two open circuit voltage (OCV) readings are taken. These OCV readings are taken when the battery is in a relaxed state before and after charge or discharge activity. A relaxed state is achieved if the battery voltage has a dV/dt of $< 4 \mu V/s$. Typically it takes 2 hours in a charged state and 5 hours in a discharged state to ensure that the dV/dt condition is satisfied. If 5 hours is exceeded, a reading is taken even if the dV/dt condition was not satisfied. The *GaugingStatus[REST]* flag is set when a valid OCV reading occurs. If a valid DOD0 (took at previous QMax update) is available, then QMax will also be updated when a valid charge termination is detected.

Temperature — If *Temperature* is outside of the range 10°C to 40°C.

Delta Capacity — If the capacity change between suitable battery rest periods is less than 37%.

Voltage — If *CellVoltage2..1* is inside a flat voltage region. (See the *Support of Multiple Li-Ion Chemistries With Impedance Track Gas Gauges Application Report (SLUA372)* for the voltage ranges of other chemistries.) This flat region is different with different chemistry. The *GaugingStatus[OCVFR]* flag indicates if the cell voltage is inside this flat region.

Offset Error— If offset error accumulated during time passed from previous OCV reading exceeds 1% of *Design Capacity*, update is disqualified. Offset error current is calculated as **CC Deadband** / sense resistor value.

Several flags in *GaugingStatus()* are helpful to track for QMax update conditions. The *[REST]* flag indicates a OCV is taken in RELAX mode. The *[VOK]* flag indicates the last OCV reading is qualified for the QMax update. The *[VOK]* is set when charge or discharge starts. It will be cleared when the QMax update occurs, when the offset error for a QMax disqualification is met, or when there is a full reset. The *[QMax]* flag will be toggled when the QMax update occurs. *ITStatus2()* and *ITStatus3()* return the QMax and DOD (depth of discharge, corresponding to the OCV reading) data.

6.4.3 Fast QMax Update Conditions

The Fast QMax update Conditions are very similar to the QMax update Conditions with the following differences:

- Instead of taking two OCV readings for QMax update, Fast QMax update requires only one OCV reading, AND
- The battery pack should discharge $> 10\%$ RSOC.

The differences in requirements allow the Fast QMax feature to have QMax update at the end of discharge (given one OCV reading is already available and discharge $< 10\%$ RSOC) without a longer relax time after a discharge event. The Temperature, Delta Capacity, Voltage, and Offset Error requirements for QMax update are still required for the Fast QMax update.

This feature is particularly useful for reducing production QMax learning cycle time, or for an application that is mostly in charge or discharge stage with infrequent relaxation. Setting **IT Gauging Configuration[FAST_QMax_LRN]** = 1 enables Fast QMax during production learning only (i.e., that is **Update Status** = 6). When setting **IT Gauging Configuration[FAST_QMax_FLD]** = 1, Fast QMax is enabled when impedance Trak (IT) is enabled (i.e., **Update Status** ≥ 6).

6.4.4 QMax and Fast QMax Update Boundary Check

The bq28z610 implements a QMax and Fast QMax check prior to saving the value to data flash. This improves the robustness of QMax update in case of potential QMax corruption during the update process.

The verifications are as follows:

1. Verify that the updating QMax or Fast QMax value is within **QMaxMaxDeltaPercent**, which is the maximum allowed QMax change for each update. If the updating value is outside of this data flash parameter, the bq28z610 caps the change to **QMaxMaxDeltaPercent** of the Design Capacity.
2. Bound the absolute QMax value, **UpperBoundQMax**. This is the maximum allowed QMax value over the lifetime of the pack.
3. Ensure that QMax is greater than 0 before saving to data flash.

6.4.5 Ra Table Initial Values

The Ra table is part of the impedance profile that updates during discharge when gauging is enabled. The initial **Cell0 R_a0...14**, **Cell1 R_a0...14**, values should be programmed by selecting the correct chemistry data during data flash configuration. A chemistry database is constantly updating, and can be downloaded from the Gas Gauge Chemistry Updater product web page (<http://www.ti.com/tool/gasgaugechem-sw>). The initial **xCell0 R_a0...14**, **xCell1 R_a0...14**, values are a copy of the non-x data set. Two sets of Ra tables are used alternatively when gauging is enabled to prevent wearing out the data flash.

The **Cell0 R_a Flag**, **Cell1 R_a Flag**, and the **xCell0 R_a Flag**, **xCell1 R_a Flag**, indicate the validity of the cell impedance table for each cell. FW updates these values: It is not recommended to change them manually.

High Byte		Low Byte	
0x00	Cell impedance and QMax updated	0x00	Table not used and QMax updated
0x05	RELAX mode and QMax update in progress	0x05	RSVD
0x55	DISCHARGE mode and cell impedance updated	0x55	Table being used
0xFF	Cell impedance never updated	0xFF	Table never used, no QMax or cell impedance update

6.4.6 Ra Table Update Conditions

The impedance is different across different DOD states. Each cell has 15 Ra grid points presenting the impedance from 0%~100% DOD. In general, the Ra table is updated during discharge. The **GaugingStatus[RX]** flag will toggle when the Ra grid point is updated. The Ra update is disabled if any of the following conditions are met. The **GaugingStatus[R_DIS]** is set to indicate the Ra update is disabled.

- During the optimization cycle, the Ra update is disabled until QMax is updated (i.e., Ra will not be updated if Update Status = 4), OR
- Ra update is disabled if the charge accumulation error > 2% of Design Capacity, OR
- During a discharge, a bad Ra value is calculated:
 - A negative Ra is calculated or
 - A bad RaScale value is calculated.

A valid OCV reading during RELAX mode or a fast Qmax update without an OCV read will clear the **[R_DIS]** flag.

FullChargeCapacity(FCC), RemainingCapacity(RemCap), and RelativeStateOfCharge(RSOC)

The Impedance Track algorithm applies QMax, impedance, temperature, voltage, and current data to predict the runtime **FullChargeCapacity()**, **RemainingCapacity()**, and **RelativeStateOfCharge()**. These values are updated if any of the following conditions are met, reflecting the battery capacity at real time.

- QMax update occurs
- Ra update occurs
- At onset of charge and discharge
- At exit of discharge
- Every 5 hours in RELAX mode
- If temperature changes more than 5°C

IT Configuration Options

The bq28z610 provides several Impedance Track (IT) configuration options to fine tune the gauging performance. These configurations can be turned on or off through the corresponding flags in **Settings** : **IT Gauging Configuration**.

[LOCK0]: After a discharge event, cell voltage will usually recover to a slightly higher voltage during RELAX state. A new OCV reading during this time can result in a slightly higher state of charge. This flag provides an option to keep *RemainingCapacity()* and *RelativeStateOfCharge()* jumping back during relaxation after 0% and FD are reached during discharge.

[RSOC_HOLD]: An IT simulation will be run at the onset of discharge. If charge terminates at a low temperature and discharge occurs at a higher temperature, the difference in temperature could cause a small rise of RSOC for a short period of time at the beginning of discharge. This flag option prevents RSOC rises during discharge. RSOC will be held until the calculated value falls below the actual state.

[RSOCL]: When set will be held to 99% until charge termination is detected.

[RFACTSTEP]: The gauge keeps track of an Ra factor of the old (old Ra)/(new Ra) during the Ra update. This factor is used for Ra scaling. It is limited to 3 max. During an Ra update, if (old Ra)/(new Ra) > 3, the gauge can take on two different actions based on the setting of this flag.

If the flag is set to 1 (default), the gauge allows Ra to update once using the max factor of 3, then disables the Ra update. If this flag is set to 0, the gauge will not update Ra and also disables the Ra update. It is recommended to keep the default setting.

[OCVFR]: An OCV reading is taken when a dV/dt condition is met. This is not the case if charging stops within the flat voltage region. The change of cell voltage in this region is very small; therefore, a same voltage error can correspond to a larger DOD error. By default, this flag is set. The device will take a 48-hour wait before taking an OCV reading if charging stops below the FlatVoltMax (max flat region voltage). The FlatVoltMax is different with different chemistry. A short discharge will not cancel this 48-hour wait. The 48-hour wait will only be cleared if charging stops above the FlatVoltMax level. Setting this flag to 0 will remove the 48-hour wait requirement, and OCV will be taken whenever the dV/dt condition is met. Removing the 48-hour requirement can be useful sometimes to reduce test time during evaluation.

[DOD0EW]: DOD0 readings have an associated error based on the elapsed time since reading, the conditions at the time of the reading (reset, charge termination, etc), the temperature, and the amount of relax time at the time of the reading, etc. This flag provides an option to take into account both the previous and new calculated DOD0, which are weighted according to their respective accuracies. This can result in improved accuracy and in reduction of RSOC jumps after relaxation.

[RSOC_CONV]: This function is also called fast scaling. It is an option to address the convergence of RSOC to 0% at a low temperature and a very high rate of discharge. Under such conditions, it is possible to have a drop of RSOC to 0%, especially if the termination voltage is reached at the DOD region with a higher Ra grid interval. To account for the error caused by the high granularity of the impedance grid interval, the **[ROSC_CONV]**, when enabled, applies a scale factor to impedance, allowing more frequent impedance data updates used for RemCap simulation leading up to 0% ROSC.

[Fast_QMAX_LRN] and [Fast_QMAX_FLDRSOC_CONV]: The first flag enables fast Qmax during the learning cycle when **Update Status** = 06. The second flag enables fast QMax in the field when **Update Status** ≥ 06.

If **[ROSC_CONV]** is enabled, it is recommended to start this function around the knee region of the discharge curve. This is usually around 10% of ROSC or around 3.3~3.5 V. This function will check for both cell voltage and RSOC status and start the function when either condition is met. The RSOC and cell voltage setting can be configured through **Fast Scale Start SOC** or **Term Voltage**.

If **[FF_NEAR_EDV]:** Fast Filter Near EDV. If this flag is set, the gauge applies an alternative filter, **Near EDV Ra Param Fiter**, for Ra update in the fast scaling region (starting around 105 RSOC). This flag should be kept to 1 as a default. When this flag is 0, the gauge uses the regular Ra filter, **Resistance Parameter Filter**. Both DF filters should not be changed from the default value.

[SMOOTH]: A change in temperature or current rate can cause a significant change in Remaining Capacity (RemCap), and therefore results in a jump or drop in the Relative State Of Charge (RSOC). This function provides an option to prevent an RSOC jump or drop during charge and discharge.

If a jump or drop of RSOC occurs, the device examines the amount of RSOC jump or drop versus the expected end point (that is the charge termination for the charging condition or the EDV for the discharge condition) and automatically smooths the change of RSOC, and always converges with the filtered (or smoothed) value to the actual charge termination or EDV point. The actual and filtered values are always available. The **[SMOOTH]** flag selects either the actual or filtered values as returned SBS command.

[RELAX_JUMP_OK] and [RELAX_SMOOTH_OK]: When the battery enters RELAX mode from CHARGE or DISCHARGE mode, the transient voltage may change to RSOC as the battery goes into its relaxation state. Once the battery is in RELAX mode, a change in temperature or self-discharge may also cause a change in RSOC.

[RELAX_JUMP_OK] = 1, this allows the amount of RSOC jump to occur during RELAX mode. Otherwise, RSOC holds constant during RELAX mode and any RSOC jump will be passed into the onset of charge or discharge phase.

[CELL_TERM]: This flag provides an option to have a cell voltage based discharge termination. If the minimum cell voltage reaches **Term Min Cell V**, *RemainingCapacity()* will be forced to 0mAh. See the Pack based and Cell based Termination section for details.

[CYSNC]: This flag if set to 1, synchronizes *FullChargeCapacity()* to **FullChargeCapacity()** at valid charge termination.

[CCT]: This flag provides an option to use *RemainingCapacity()* (**[CCT]**) = 1 or *DesignCapacity()* (**[CCT]**) = 0 for cycle count threshold calculation. If *FullChargeCapacity()* is selected for cycle count threshold calculation, the minimum cycle count threshold is always 10% of Design capacity. This is to avoid any erroneous cycle count increment caused by extremely low *FullChargeCapacity()*.

[VOLTAGE_CONSIST]: Voltage Consistency Check. This function helps to prevent an RSOC jump. The flag should be set to 1 as default. The resistance toward the EDV level is not linear. The non-linearity can result in a raise in voltage in DISCHARGE mode. When this function is enabled, the gauge checks will ignore the increase of voltage from the voltage measurement. Instead, an interpolation using previous measurements is applied. The voltage consistency check will take place when the voltage is within the **Voltage Consistency Delta** from the **Term Voltage**.

State Of Health (SoH)

In previous similar TI devices, the state of health (SoH) of a battery was typically represented by the actual runtime **FullChargeCapacity/Design Capacity** (or FCC/DC). Using the runtime FCC is not a very good representation for the state of health because the runtime FCC reflects the usable capacity under load. A high current load reduces the runtime FCC. If using just the FCC/DC calculation for SoH, the SoH under high load will be worse than the SoH under typical load. However, a smaller usable capacity at high load does not mean the SoH of a battery is degraded. This is the same when FCC is reduced at a lower temperature.

The bq28z610 implementation of state of health addresses these concerns. It provides the SoH of the battery through an I2C command, *SoH()*. The *SoH()* is calculated using the FCC simulated at 25°C with current specified by **SoH Load Rate**. The **SoH Load Rate** can be set to the typical current of the application, and it is specified in C-rate (i.e., **Design Capacity/SoH Load Rate** will be the current used for the SoH simulation). This data flash setting is used for *SoH()* calculation only. This SoH FCC is updated at the same time ASOC and RSOC are updated. Since this implementation removes the variation of current or temperature, it is a better representation of a battery's state of health. The SoH is available on MAC *StateOfHealth()*.

6.5 Battery Trip Point (BTP)

Required for WIN8 OS, the battery trip point (BTP) feature indicates when the RSOC of a battery pack has depleted to a value set in a DF register.

The BTP feature allows a host to program two capacity-based thresholds that govern the triggering of a BTP interrupt on the BTP_INT pin and the setting or clearing of the *OperationStatus()*[BTP_INT] on the basis of *RemainingCapacity()*. The interrupt is enabled or disabled via **Settings.Configuration.IO Config[BTP_EN]**. Similarly, the polarity of the interrupt is configurable based on the value set in **Settings.Configuration.IO Config[BTP_POL]**.

- *OperationStatus()*[BTP_INT] is set when:
 - Current > 0 and RemCap > “clear” threshold (“charge set threshold”). This threshold is initialized at reset from **Settings.BTP.Init Charge Set**.
 - Current ≤ 0 and RemCap < “set” threshold (“discharge set threshold”). This threshold is initialized at reset from **Settings.BTP.Init Discharge Set**.
- When *OperationStatus()*[BTP_INT] is set, if **Settings.Configuration.IO Config[BTP_EN]** is set, then

the BTP_INT pin output is asserted.

- If **Settings.Configuration.IO Config[BTP_POL]** is set, it will assert high; otherwise, it will assert low.
- When either *BTPDischargeSet()* or *BTPChargeSet()* commands are received, *OperationStatus()[BTP_INT]* will clear and the pin will be de-asserted. The new threshold is written to either *BTPDischargeSet()* or *BTPChargeSet()*.
- At reset, the pin is set to the de-asserted state.
 - If you change **[BTP_POL]**, one of the BTP commands must be reset or sent to "clear" the state.

DRAFT ONLY

Cell Balancing

7.1 Introduction

The bq28z610 can determine the chemical state of charge of each cell using the Impedance Track algorithm. The cell balancing algorithm used in the device decreases the differences in imbalanced cells in a fully charged state gradually, which prevents fully charged cells from becoming overcharged, causing excessive degradation. This increases overall pack energy by preventing premature charge termination.

The algorithm determines the amount of charge needed to fully charge each cell. There is a bypass FET in parallel with each cell connected to the gas gauge. The FET is enabled for each cell with a charge greater than the lowest charged cell to reduce charge current through those cells. Each FET is enabled for a precalculated time as calculated by the cell balancing algorithm. When any bypass FET is turned on, then the *OperationStatus()[CB]* operation status flag is set; otherwise, the *[CB]* flag is cleared.

The gas gauge balances the cells by balancing the SOC difference. Thus, a field updated QMax (**Update Status** = 0E) is required prior to any attempt of Cell Balance Time calculation. This ensures the accurate SOC delta is calculated for the cell balancing operation. If Qmax update has only occurred once (**Update Status** = 06), then the gauge will only attempt to calculate the Cell Balance Time if a fully charged state is reached, *GaugingStatus()[FC]* = 1.

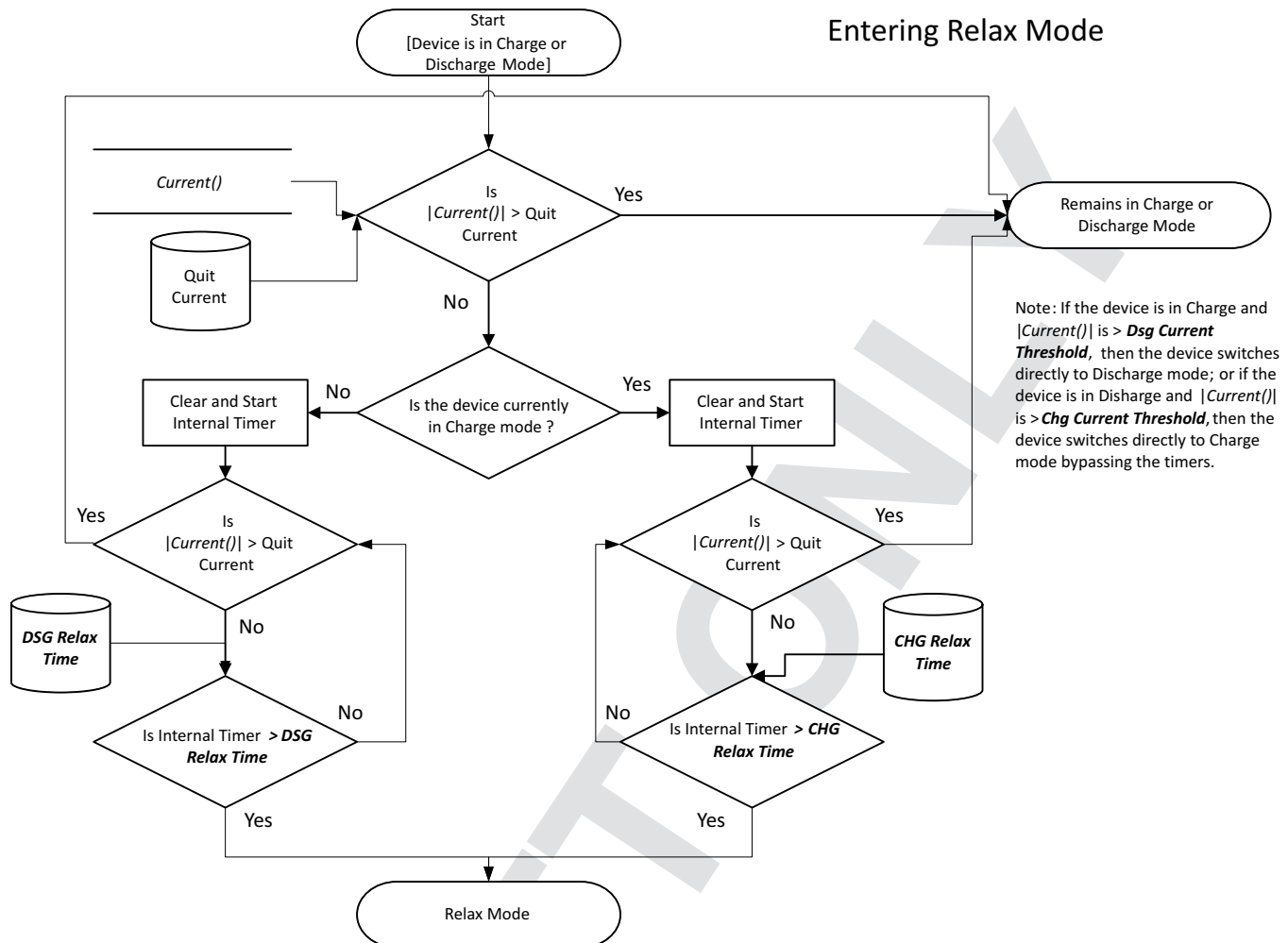
The cell balancing is enabled if **Settings:Balancing Configuration [CB]** = 1. The cell balancing at rest can be enabled separately by setting **Balancing Configuration [CBR]** = 1. If **Settings:Balancing Configuration [CB]** = 0, both cell balancing at charging and at rest are disabled.

The cell balancing at rest can be configured by determining the data flash **Min Start Balance Delta**, **Relax Balance Interval**, and **Min RSOC for Balancing**. For the data flash setting description, see [Section 13.5.10](#). The gas gauge balances cells by bypassing the energy. It is recommended to perform cell balancing at rest when there is capacity in the battery pack.

7.2 Cell Balancing Setup

The bq28z610 is required to be in RELAX mode before it can determine if the cells are unbalanced and how much balancing is required. The bq28z610 enters RELAX mode when:

Current() < *Quit Current* for at least *Dsg Relax Time* when coming from DISCHARGE mode or *Chg Relax Time* when coming for CHARGE mode.


Figure 7-1. Entering CHARGE or RELAX Mode

Once in RELAX mode the bq28z610 waits until an OCV measurement is taken, which occurs after:

1. A dV/dt condition of $< 4\ \mu V/s$ is satisfied,
2. After 5 hours from when $Current() < Quit\ Current$,
3. Upon gas gauge reset,
4. An IT Enable command is issued.

The determination of when to update the OCV data is part of the normal Impedance Track algorithm and is not specific to the cell balancing algorithm.

OCV Measurement

Note: If charge stop below the flat voltage max (this value is part of the chemistry data and is different from ChemID to ChemID), and the *GaugingStatus()*[OCVFR] = 1, the gauge will wait 48 hours before taking an OCV measurement.

The 48-hr requirement is removed if *IT Gauging Configuration*[OCVFR] = 0.

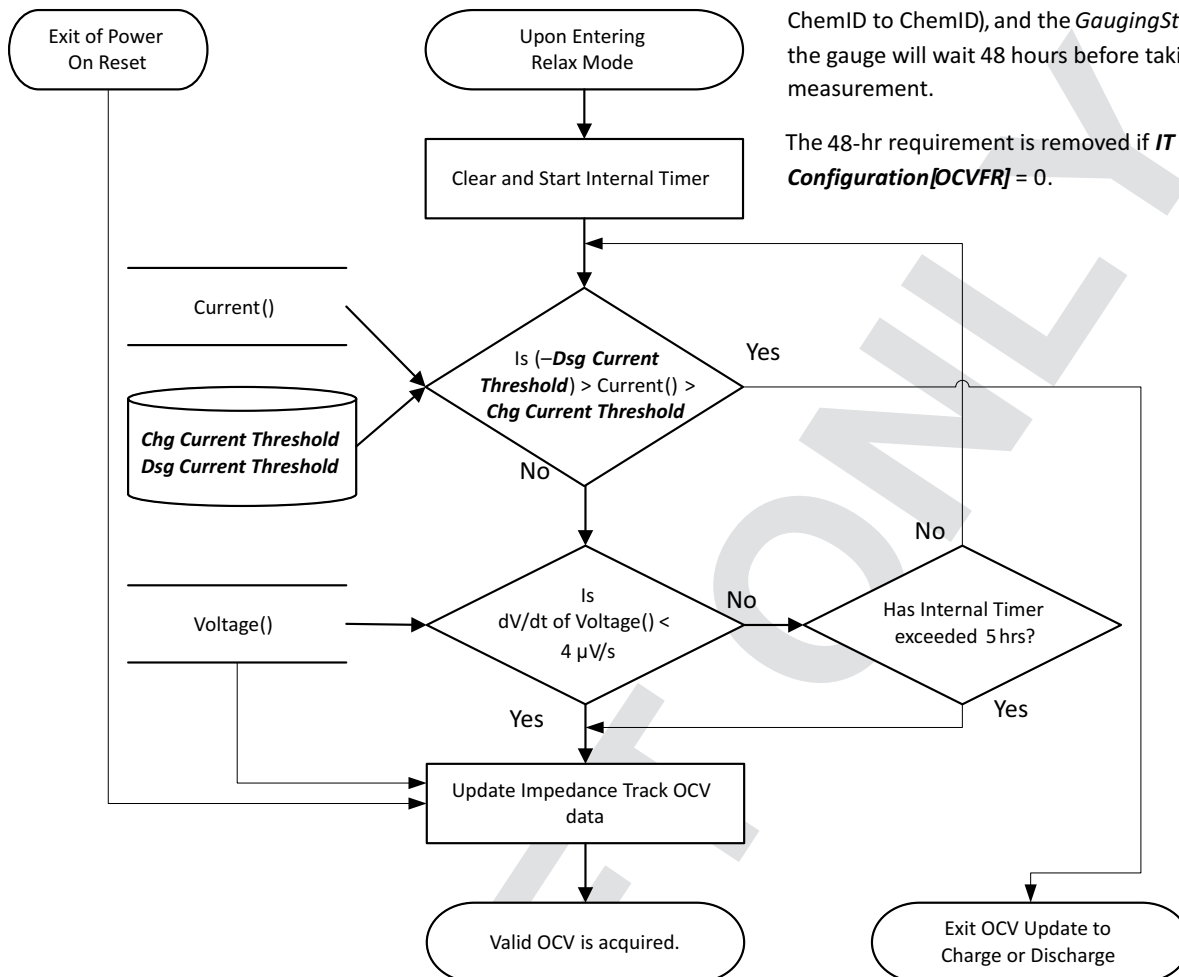


Figure 7-2. OCV Measurement

The bq28z610 then calculates the amount of charge difference between cells with a higher state of charge than the lowest cell SOC. The value, dQ, is determined for each cell based by converting the measured OCV to Depth-of-Discharge (DOD) percentages using a temperature-compensated DOD vs. OCV table lookup table. If the measured, OCV does not coincide with a specific table entry then the DOD value is linearly interpolated from the two adjacent DODs of the respective table adjacent OCVs.

The delta in DOD% between each cell and the cell of lowest SOC is multiplied by the respective cells QMax to create dQ: for example, $dQ = \text{CellInDOD} - \text{CellLowest_SOC DOD} \times \text{CellInQMax (mAh)}$.

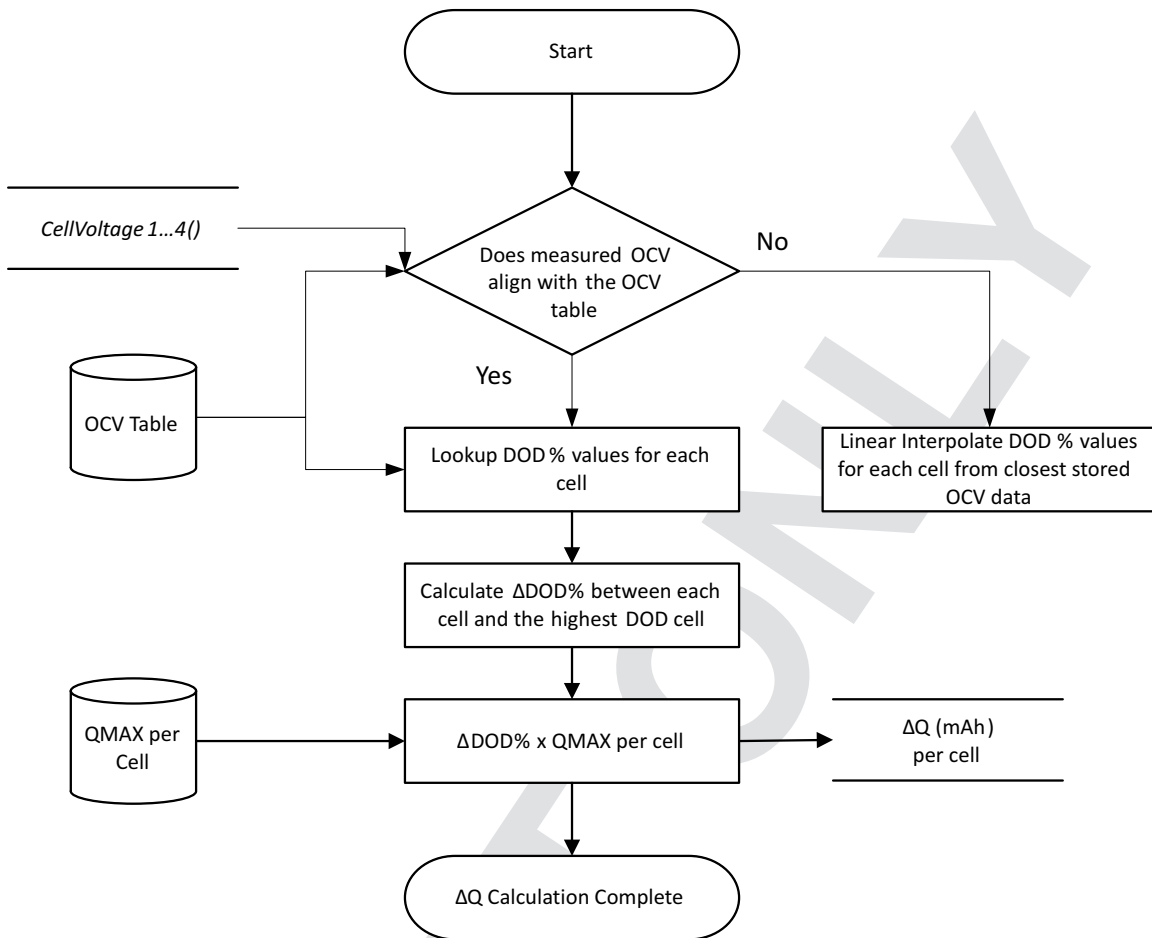


Figure 7-3. ΔQ Calculation

The bq28z610 calculates the required balancing time using dQ and **Bal Time/mAh Cell 1** (for cell 1) or **Bal Time/mAh Cell 2–4** (for cell 2–4). The value of **Bal Time/mAh Cell 1** and **Bal Time/mAh Cell 2–4** are fixed value determined based on key system factors and is calculated by:

$$\mathbf{Bal\ Time/mAh\ Cell\ 1} = 3600\ \text{mAs}/(V_{\text{CELL}}/R_{\text{VCx}} + R_{\text{cb}}) \times \text{DUTY}/1000$$

$$\mathbf{Bal\ Time/mAh\ Cell\ 2-4} = 3600\ \text{mAs}/(V_{\text{CELL}}/(2 \times R_{\text{VCx}} + R_{\text{cb}}) \times \text{DUTY})/1000$$

Where:

V_{CELL} = average cell voltage (for example, 3.7 V for most chemistry)

R_{VCx} = resistor value in series to VCx input (for example, 100 Ω , based on the reference schematic)

R_{cb} = cell balancing FET R_{dson} , which is 150 Ω

DUTY = cell balancing duty cycle, which is 66% typ

The cell balancing time for each cell to be balanced is calculated by: $dQ_{\text{Cell}n} \times \mathbf{Bal\ Time/mAh\ Cell\ 1}$ for cell1 or and $dQ_{\text{Cell}n} \times \mathbf{Bal\ Time/mAh\ Cell\ 2-4}$ for Cell 2–4. The cell balancing time is stored in the 16-bit RAM register `CellnBalanceTimer`, providing a maximum calculated time of 65535 s (or 18.2 hrs). This update only occurs if a valid QMax update has been made; otherwise, they are all set to 0.

The `CellnBalanceTimer` registers are clamped at 0xffff and cannot roll over.

7.3 Cell Balancing Operation

Note: Cell balancing is called every 1 s.

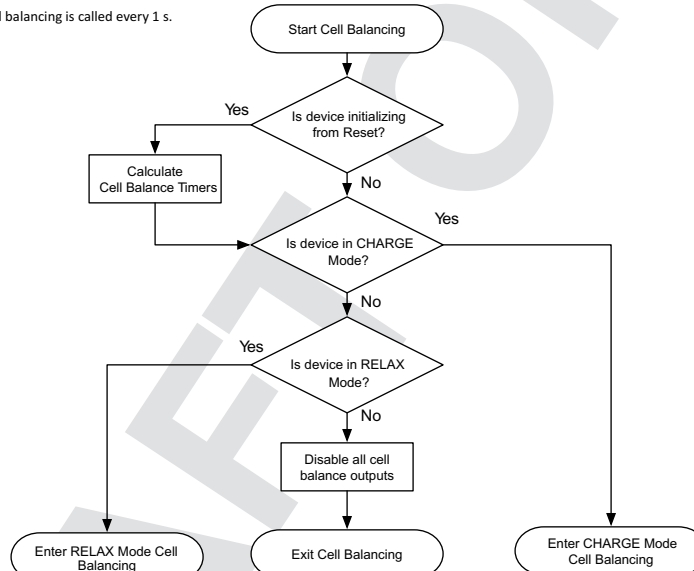


Figure 7-4. Cell Balance Mode Detection

The bq28z610 calls the cell balancing algorithm every 1 s during normal operation. Cell balancing is not called when the device is in SLEEP mode. All algorithm decisions are made on this same 1-s timer.

In RELAX mode, if cell balancing at rest is enabled, **Balancing Configuration[CBR]** = 1, the gauge will verify if the dv/dt condition is met at the entry of the RELAX mode. If so, then the cell balance at rest will start when all of the conditions below are met:

- Any of the pre-calculated Cell Balance Timer is non-zero, AND
- **RelativeStatofCharge()** > **Min RSOC for Balancing**

The gauge will attempt to re-calculate the cell balancing time in RELAX mode every **Relax Balance Interval**. The cell balancing time is updated if the conditions below are met:

- The Relax Balance Interval has passed, AND
- A OCV measurement is taken, AND
- The max cell voltage delta > **Min Start Balance Delta**

On exit of the RELAX mode, cell balancing time is re-calculated as long as a valid OCV update is available.

Note that cell balancing is paused during OCV measurement.

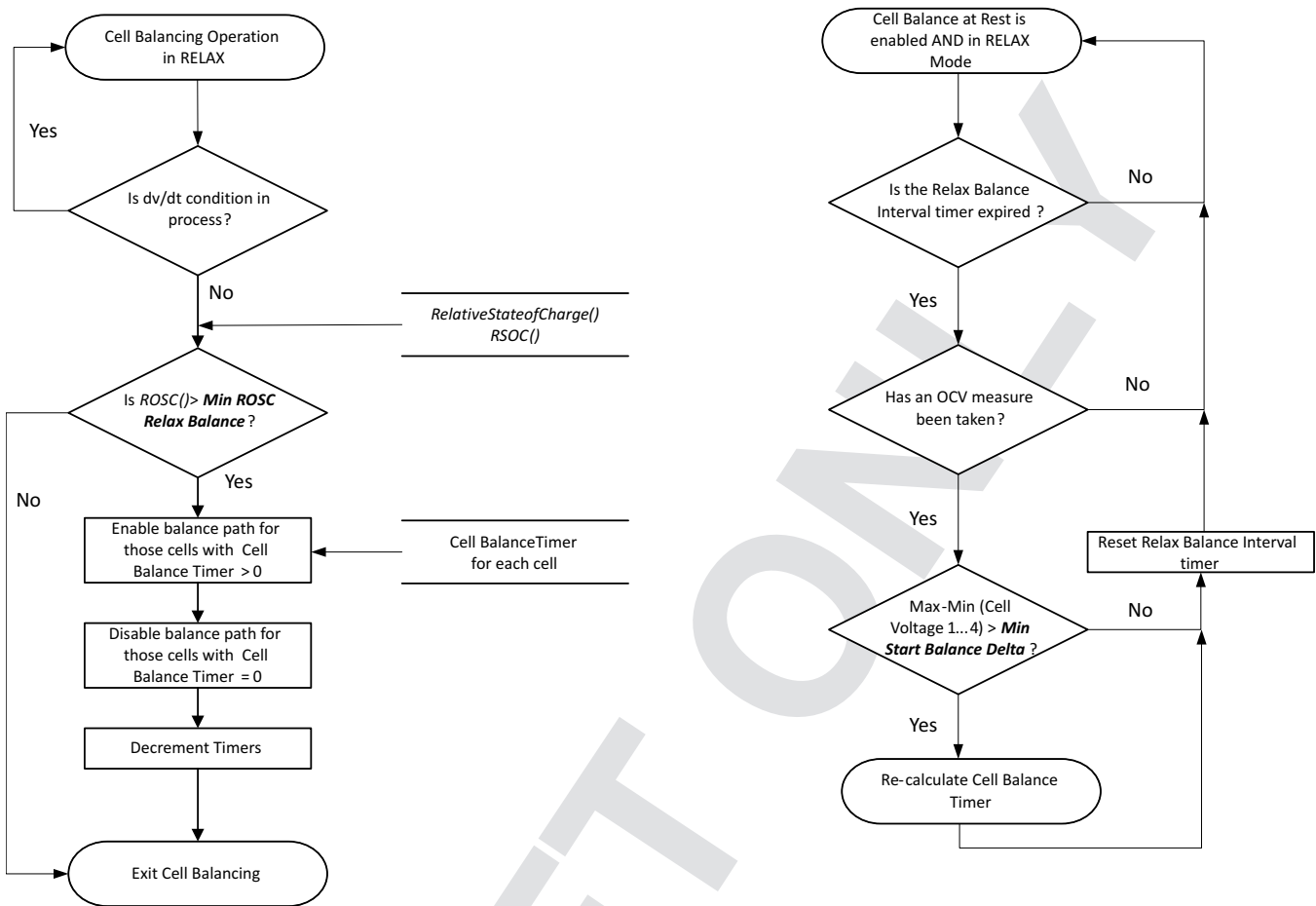


Figure 7-5. Cell Balance Operation in RELAX Mode

When the bq28z610 is in CHARGE mode, then it follows these steps during cell balancing:

- (a) Check if any of the pre-calculated Cell Balance Timers are > 0.
- (b) The cell balance FETs are turned ON for the corresponding cell balance timers that are ≠ 0.

NOTE: There are no SOC restrictions controlling the enabling of cell balancing in CHARGE mode.

Note: Cell balancing is called every 1 s so this loop will execute every 1 s as long as the appropriate conditions exist.

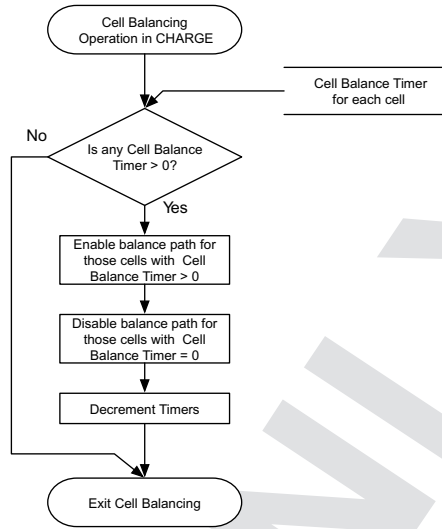


Figure 7-6. Cell Balance Operation in CHARGE Mode

DRAFT ONLY

Lifetime Data Collection

8.1 Description

The device has extensive capabilities for logging events over the life of the battery useful for analysis. The Lifetime data collection is enabled by setting **ManufacturingStatus[LF_EN]** = 1. The data is collected in RAM and only written to DF under the following conditions to avoid wear out of the data flash:

- Every 10 hours if RAM content is different from flash
- In permanent fail, before data flash updates are disabled
- A reset counter increments
- Before scheduled shutdown
- Before low voltage shutdown

The lifetime data stops collecting under following conditions:

- After permanent fail
- Lifetime Data collection is disabled by setting **ManufacturingStatus[LF_EN]** = 0

Total firmware Runtime starts when lifetime data is enabled.

- Voltage
 - Max Cell Voltage for Each Cell
- Current
 - Max Charge/Discharge Current
- Temperature
 - Max/Min Cell Temp

Device Security

9.1 Description

There are three levels of secured operation within the device. To switch between the levels, different operations are needed with different keys. The three levels are SEALED, UNSEALED, and FULL ACCESS. The device also supports SHA-1 HMAC authentication with the host system.

9.2 SHA-1 Description

The SHA-1 is known as a one-way hash function, meaning there is no known mathematical method of computing the input given only the output. The specification of the SHA-1, as defined by FIPS 180–2, states that the input consists of 512 bit blocks with a total input length less than 264 bits. Inputs which do not conform to integer multiples of 512 bit blocks are padded before any block is input to the hash function. The SHA-1 algorithm outputs 160 bits, commonly referred to as the digest.

(As of April 23, 2004 the latest revision is FIPS 180–2). SHA-1 or secure hash algorithm is used to compute a condensed representation of a message or data also known as hash. For messages $< 2^{64}$ the SHA-1 produces an 160-bit output called digest.

The device generates an SHA-1 input block of 288 bits (total input = 160 bit message + 128 bit key). To complete the 512 bit block size requirement of the SHA-1, the device pads the key and message with a 1, followed by 159 0s, followed by the 64 bit value for 288 (000...00100100000), which conforms to the pad requirements specified by FIPS 180–2.

Detailed information about the SHA-1 algorithm can be found:

1. <http://www.itl.nist.gov/fipspubs/fip180-1.htm>
2. <http://csrc.nist.gov/publications/fips>
3. www.faqs.org/rfcs/rfc3174.html

9.3 HMAC Description

The SHA-1 engine calculates a modified HMAC value. Using a public message and a secret key, the HMAC output is considered to be a secure fingerprint that authenticates the device used to generate the HMAC.

To compute the HMAC: Let H designate the SHA-1 hash function, M designate the message transmitted to the device, and KD designate the unique 128-bit Unseal/Full Access/Authentication key of the device. HMAC(M) is defined as:

$H[KD || H(KD || M)]$, where || symbolizes an append operation.

The message, M, is appended to the unseal/full access/authentication key, KD, and padded to become the input to the SHA-1 hash. The output of this first calculation is then appended to the unseal/full access/authentication key, KD, padded again, and cycled through the SHA-1 hash a second time. The output is the HMAC digest value.

9.4 Authentication

1. Generate 160-bit message M using a random number generator that meets approved random number generators described in FIPS PUB 140–2.
2. Generate SHA-1 input block B1 of 512 bytes (total input = 128-bit authentication key KD + 160 bit message M + 1 + 159 0s + 100100000).
3. Generate SHA-1 hash HMAC1 using B1.

4. Generate SHA-1 input block B2 of 512 bytes (total input = 128-bit authentication key KD + 160 bit hash HMAC1 + 1 + 159 0s + 100100000)
5. Generate SHA-1 hash HMAC2 using B2.
6. With no active *BlockData()* data waiting, write 160-bit message M to *BlockData()* in the format 0xAABBCCDDEEFFGGHHIIJJKLLMMNNOOPPQQRRSSTT, where AA is LSB.
7. Wait 250 ms, then read *BlockData()* for HMAC3.
8. Compare host HMAC2 with device HMAC3, it matches, both host and device have the same key KD and device is authenticated.

9.5 Security Modes

Changing the security keys requires using the change MAC command, the code to unseal the device can be sent to 0x3e, 0x3f. The order of the data is in little endian. To change the keys, the write operations must send through *ManufacturerAccess()*0x3e, 0x3f with the *SecurityKey()* followed by the key information. Each parameter entry must be sent in little endian.

Example:

Changing the Unseal key to 0x0123, 0x4567 and the Full Access key to 0x89AB, 0xCDEF:

Write block: command = 0x3E, block = 0x35 + 0x00 + 0x23 + 0x12 + 0x67 + 0x45 + 0xAB + 0x89 + 0xEF + 0xCD + 1byte for Check sum + 1 byte for data length

Starting address 0x3E, data block (hex) is [35 00 23 01 67 45 ab 89 EF CD], then Starting address 0x60, data block (hex) is [0a 0c] (checksum followed by length) Checksum = 0x0a = ~(0x35 + 0x00 + 0x23 + 0x01 + 0x67 + 0x45 + 0xAB + 0x89 + 0xEF + 0xCD). The final Checksum is the bitwise inversion of the result.

Byte0: Unseal Key LSB
 Byte1: Unseal Key MSB
 Byte2: Full Access Key LSB
 Byte3: Full Access Key MSB

For this activity the 2nd key must be sent within 4 seconds of sending the first key, otherwise the request will NOT be accepted

9.5.1 SEALING and UNSEALING Data Flash

The gas gauge has a key access scheme to transition between SEALED, UNSEALED and FULL ACCESS modes. Each transition requires that a unique set of two keys be sent to the gas gauge via the *ManufacturerAccess()* command. The keys must be sent consecutively, with no other data being written to the *ManufacturerAccess()* resiter. The MAC command Do NOT set the two keys to identical vaues. The *Seal Device* command instructs the device to limit access to the registers, functions and data flash space and sets the [SEC1][SEC0] flags. In SEALED mode, standard register information is accessible. Extended MAC Commands functions and data flash are not accessible. Once in SEALED mode, the part can never permanently return to UNSEALED or FULL ACCESS modes. The status of the device is shown in *OperationStatus()* register using [SEC1][SEC0] bits.

9.5.2 SEALED to UNSEALED

SEALED to UNSEALED instructs the device to extend access to the Standard and extended Registers and data flash space and clears the [SEC1][SEC0] flags. In UNSEALED mode, all data, Standard and extended Registers and DF have read/write access. Unsealing is a two-step command performed by writing the first word of the unseal key to *ManufacturerAccess()* (MAC), followed by the second word of the unseal key to *ManufacturerAccess()*. The unseal key can be read and changed via the *MAC SecurityKey()* command when in the FULL ACCESS mode. To return to the SEALED mode, either a hardware reset is needed, or the *MAC Seal Device()* command is needed to transit from FULL ACCESS or UNSEALED to SEALED.

UNSEALED to FULL ACCESS

UNSEALED to FULL ACCESS instructs the device to allow full access to all Standard and extended Registers and data flash. The device is shipped from TI in this mode. The keys for UNSEALED to FULL ACCESS can be read and changed via the MAC command *SecurityKey()* when in FULL ACCESS mode. Changing from UNSEALED to FULL ACCESS is performed by using the *ManufacturerAccess()* command, by writing the first word of the Full Access Key to *ManufacturerAccess()*, followed by the second word of the Full Access Key to *ManufacturerAccess()*. In FULL ACCESS mode, the command to go to boot ROM can be sent.

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Manufacture Production

10.1 Manufacture Testing

To improve the manufacture testing flow, the gas gauge device allows certain features to be toggled on or off through *ManufacturerAccess()* commands. For example, the *CHG FET()*, *DSG FET()*, *Lifetime Data Collection()*, *Calibration()*, etc. Enabling only the feature under test can simplify the test flow in production by avoiding any feature interference. These toggling commands will only set the RAM data, meaning the conditions set by these commands will be cleared if a reset or seal is issued to the gauge. The *ManufacturingStatus()* keeps track of the status (enabled or disabled) of each feature.

The data flash **ManufacturingStatus** provide the option to enable or disable individual features for normal operation. Upon a reset or a seal command, The *ManufacturingStatus()* will be re-loaded from data flash *ManufacturingStatus()*. This also means if an update is made to *ManufacturingStatus()* to enable or disable a feature, the gauge will only take the new setting if a reset or seal command is sent.

10.2 Calibration

The device has integrated routines that support calibration of current, voltage, and temperature readings, accessible after writing 0xF081 or 0xF082 to *ManufacturerAccess()* when the *ManufacturingStatus()[CAL]* bit is ON. While the calibration is active, the raw ADC data is available on *ManufacturerData()*. The device stops reporting calibration data on *ManufacturerData()* if any other MAC commands are sent or the device is reset or sealed.

NOTE: The *ManufacturingStatus()[CAL]* bit must be turned OFF after calibration is completed. This bit is cleared at reset or after sealing.

ManufacturerAccess()	Description
0x002D	Enables/Disables <i>ManufacturingStatus()[CAL]</i>
0xF080	Disables raw ADC data output on <i>ManufacturerData()</i>
0xF081	Outputs raw ADC data of voltage, current, and temperature on <i>ManufacturerData()</i>
0xF082	Outputs raw ADC data of voltage, current, and temperature on <i>ManufacturerData()</i> . This mode enables an internal short on the coulomb counter inputs (SRP, SRN).

The *ManufacturerData()* output format is: ZZYYaaAAbbBBccCCddDDeeEEffFFggGGhhHHiiIjJkkKK, where:

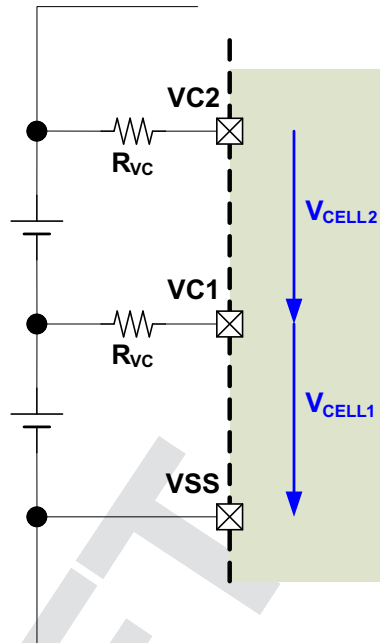
Value	Format	Description
ZZ	byte	8-bit counter, increments when raw ADC values are refreshed (every 250 ms)
YY	byte	Output status <i>ManufacturerAccess()</i> = 0xF081: 1 <i>ManufacturerAccess()</i> = 0xF082: 2
AAaa	2's comp	Current (coulomb counter)
BBbb	2's comp	Cell Voltage 1
CCcc	2's comp	Cell Voltage 2
FFff	2's comp	BAT Voltage
GGgg	2's comp	PACK Voltage
HHhh	2's comp	Cell Current 1

Value	Format	Description
lji	2's comp	Cell Current 2

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Calibration

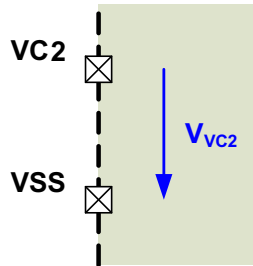
11.1 Cell Voltage Calibration



- Apply known voltages in mV to the cell voltage inputs:
 - V_{CELL1} between VC1 pin and VSS pin
 - V_{CELL2} between VC2 pin and VC1 pin
- If *ManufacturerStatus()[CAL]* = 0, send 0x002D to *ManufacturerAccess()* to enable the [CAL] flag.
- Send 0xF081 or 0xF082 to *ManufacturerAccess()* to enable raw cell voltage output on *ManufacturerData()*.
- Poll *ManufacturerData()* until the 8-bit counter value increments by 2 before reading data.
- Read the ADC conversion readings of cell voltages from *ManufacturerData()*:
 - ADC_{CELL1} = AAaa of *ManufacturerData()*
 - ADC_{CELL2} = BBbb of *ManufacturerData()*.
- Average several readings for higher accuracy. Poll *ManufacturerData()* until ZZ increments, to indicate that updated values are available:
 - $ADC_{CELLx} = [ADC_{CELLx}(\text{reading } n) + \dots + ADC_{CELLx}(\text{reading } 1)]/n$
- Calculate gain value:

$$\text{Cell Gain} = \left\{ \left[\frac{V_{CELL1}}{ADC_{CELL1}} + \frac{V_{CELL2}}{ADC_{CELL2}} + \frac{V_{CELL3}}{ADC_{CELL3}} + \frac{V_{CELL4}}{ADC_{CELL4}} \right] * 2^{16} \right\} / N$$
 where N = number of cells
- Write the new **Cell Gain** value to data flash.
- Re-check the voltage reading and if it is not accurate, repeat Steps 5 and 6.
- Send 0x002D to *ManufacturerAccess()* to clear the [CAL] flag if all calibration is complete.

11.2 VC2 (BAT) Voltage Calibration

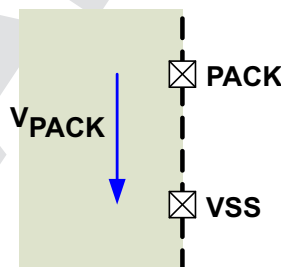


This device does NOT have a BAT pin and therefore the VC2 input is the BAT pin:

1. Apply known voltages in mV to the voltage input:
 - V_{BAT} between VC2 pin and VSS pin
2. If $ManufacturerStatus()[CAL] = 0$, send 0x002D to $ManufacturerAccess()$ to enable the [CAL] flag.
3. Send 0xF081 or 0xF082 to $ManufacturerAccess()$ to enable raw cell voltage output on $ManufacturerData()$.
4. Poll $ManufacturerData()$ until the 8-bit counter value increments by 2 before reading data.
5. Read ADC conversion readings of cell stack voltage from $ManufacturerData()$:
 - $ADC_{BAT} = LLLl$ of $ManufacturerData()$
6. Average several readings for higher accuracy. Poll $ManufacturerData()$ until ZZ increments to indicate that updated values are available:
 - $ADC_{BAT} = [ADC_{BAT}(\text{reading } n) + \dots + ADC_{BAT}(\text{reading } 1)]/n$
7. Calculate gain value:

$$BAT \text{ Gain} = \frac{V_{BAT}}{ADC_{BAT}} * 2^{16}$$
8. Write the new **BAT Gain** value to data flash.
9. Re-check the voltage readings and if they are not accurate, repeat Steps 4 through 6 .
10. Send 0x002D to $ManufacturerAccess()$ to clear the [CAL] flag if all calibration is complete.

11.3 PACK Voltage Calibration

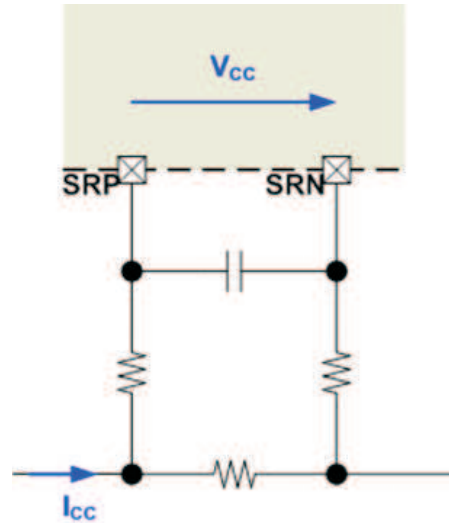


1. Apply known voltages in mV to the voltage input:
 - V_{PACK} between PACK pin and VSS pin
2. If $ManufacturerStatus()[CAL] = 0$, send 0x002D to $ManufacturerAccess()$ to enable the [CAL] flag.
3. Send 0xF081 or 0xF082 to $ManufacturerAccess()$ to enable raw cell voltage output on $ManufacturerData()$.
4. Poll $ManufacturerData()$ until the 8-bit counter value increments by 2 before reading data.
5. Read ADC conversion readings of pack voltage from $ManufacturerData()$:
 - $ADC_{PACK} = KKKk$ of $ManufacturerData()$
6. Average several readings for higher accuracy. Poll $ManufacturerData()$ until ZZ increments to indicate that updated values are available:

- $ADC_{PACK} = [ADC_{PACK}(\text{reading } n) + \dots + ADC_{PACK}(\text{reading } 1)]/n$
7. Calculate gain value:

$$PACK\ Gain = \frac{V_{PACK}}{ADC_{PACK}} * 2^{16}$$
 8. Write the new **PACK Gain** value to data flash.
 9. Re-check voltage readings and if they are not accurate, repeat Steps 4 through 6.
 10. Send 0x002D to *ManufacturerAccess()* to clear the [CAL] flag if all calibration is complete.

11.4 Current Calibration



11.4.1 CC Offset Calibration

NOTE: Due to hardware improvements in this device, CC Offset Calibration is not necessary. Only run the CC Offset Calibration procedure if offset current is observed.

1. Apply a known current of 0 mA, and ensure no current is flowing through the sense resistor connected between the SRP and SRN pins.
2. If *ManufacturerStatus()[CAL]* = 0, send 0x002D to *ManufacturerAccess()* to enable the [CAL] flag.
3. Send 0xF082 to *ManufacturerAccess()* to enable raw cell voltage output on *ManufacturerData()*.
4. Poll *ManufacturerData()* until ZZ increments by 2 before reading data.
5. Obtain the ADC conversion readings of current from *ManufacturerData()*:
 - $ADC_{CC} = \text{AAaa of } ManufacturerData()$
 - Is $ADC_{CC} < 0x8000$? If yes, use ADC_{CC} ; otherwise, $ADC_{CC} = -(0xFFFF - \text{AAaa} + 0x0001)$.
6. Average several readings for higher accuracy. Poll *ManufacturerData()* until ZZ increments to indicate that updated values are available:
 - $ADC_{CC} = [ADC_{CC}(\text{reading } n) + \dots + ADC_{CC}(\text{reading } 1)]/n$
7. Read *Coulomb Counter Offset Samples* from data flash.
8. Calculate offset value:
 - $CC\ offset = ADC_{CC} \times (\text{Coulomb Counter Offset Samples})$
9. Write the new **CC Offset** value to data flash.
10. Re-check the current reading and if it is not accurate, repeat the steps.
11. Send 0x002D to *ManufacturerAccess()* to clear the [CAL] flag if all calibration is complete.

11.4.2 Board Offset Calibration

NOTE: Due to hardware improvements in this device, Board Offset calibration is not necessary. Only run the Board Offset Calibration procedure if board offset current is observed.

1. Ensure that Offset Calibration was performed first.
2. Apply a known current of 0 mA, and ensure no current is flowing through the sense resistor connected between the SRP and SRN pins.
3. If *ManufacturerStatus()[CAL]* = 0, send 0x002D to *ManufacturerAccess()* to enable the [CAL] flag.
4. Send 0xF081 to *ManufacturerAccess()* to enable raw cell voltage output on *ManufacturerData()*.
5. Poll *ManufacturerData()* until ZZ increments by 2 before reading data.
6. Obtain the ADC conversion readings of current from *ManufacturerData()*:
 - $ADC_{CC} = \text{AAaa of } ManufacturerData()$
Is $ADC_{CC} < 0x8000$? If yes, use ADC_{CC} ; otherwise, $ADC_{CC} = -(0xFFFF - \text{AAaa} + 0x0001)$.
7. Average several readings for higher accuracy. Poll *ManufacturerData()* until ZZ increments to indicate that updated values are available:
 - $ADC_{CC} = [ADC_{CC}(\text{reading } n) + \dots + ADC_{CC}(\text{reading } 1)]/n$
8. Read *Coulomb Counter Offset Samples* from data flash.
9. Calculate offset value:
 - Board offset = $(ADC_{CC} - \text{CC Offset}) \times \text{Coulomb Counter Offset Samples}$
10. Write the new *Board Offset* value to data flash.
11. Re-check the current reading. If the reading is not accurate, repeat the steps.
12. Send 0x002D to *ManufacturerAccess()* to clear the [CAL] flag if all calibration is complete.

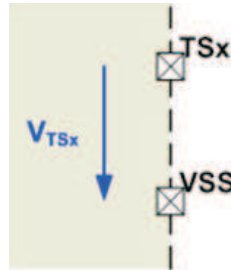
11.4.3 CC Gain/Capacity Gain Calibration

1. Apply a known current (typically 1 A to 2 A), and ensure I_{CC} is flowing through the sense resistor connected between the SRP and SRN pins.
2. If *ManufacturerStatus()[CAL]* = 0, send 0x002D to *ManufacturerAccess()* to enable the [CAL] flag.
3. Send 0xF081 to *ManufacturerAccess()* to enable raw CC output on *ManufacturerData()*.
4. Poll *ManufacturerData()* until ZZ increments by 2 before reading data.
5. Read the ADC conversion readings of current from *ManufacturerData()*:
 - $ADC_{CC} = \text{AAaa of } ManufacturerData()$
Is $ADC_{CC} < 0x8000$? If yes, use ADC_{CC} ; otherwise, $ADC_{CC} = -(0xFFFF - \text{AAaa} + 0x0001)$.
6. Average several readings for higher accuracy. Poll *ManufacturerData()* until ZZ increments to indicate that updated values are available:
 - $ADC_{CC} = [ADC_{CC}(\text{reading } n) + \dots + ADC_{CC}(\text{reading } 1)]/n$
7. Read **Coulomb Counter Offset Samples** from data flash.
8. Calculate gain values:

$$CC\ Gain = \frac{I_{CC}}{ADC_{CC} - \frac{Board\ Offset + CC\ Offset}{Coulomb\ Counter\ Offset\ Samples_W}}$$

$$Capacity\ Gain = CC\ Gain * 298261.6178$$
9. Write the new **CC Gain** and **Capacity Gain** values to data flash.
10. Re-check the current reading. If the reading is not accurate, repeat the steps.
11. Send 0x002D to *ManufacturerAccess()* to clear the [CAL] flag if all calibration is complete.

11.5 Temperature Calibration



11.5.1 Internal Temperature Sensor Calibration

1. Apply a known temperature in 0.1°C, and ensure that temperature $TEMP_{TINT}$ is applied to the device.
2. Read the $TINT\ offset_{old}$ from **Internal Temp Offset**.
3. Read the reported temperature from `DAStatus2()`:
 - $TINT = AAaa$ of `DAStatus2()`
 Is $TINT > 0$? If yes, $TINT = AAaa - 2732$.
4. Calculate temperature offset:

$$TINT\ offset = TEMP_{TINT} - TINT + TINT\ offset_{old}$$
5. Write the new **Internal Temp Offset** value to data flash.
6. Re-check the `DAStatus2()` reading. If the reading is not accurate, repeat the steps.

11.5.2 TS1 Calibration

1. Apply a known temperature in 0.1°C, and ensure that temperature $TEMP_{TSx}$ is applied to the thermistor connected to the TSx pin. "TSx" refers to TS1.
2. Read the $TSx\ offset_{old}$ from **External x Temp Offset**, where x is 1, 2, 3, or 4.
3. Read the appropriate temperature from the `DAStatus2()` block as TSx.
4. Calculate the temperature offset:

$$TSx\ offset = TEMP_{TSx} - TSx + TSx\ offset_{old}$$
 where x is 1,
5. Write the new **External x Temp Offset** (where x is 1) value to data flash.
6. Re-check the `DAStatus2()` reading. If the reading is not accurate, repeat the steps.

I²C Commands

12.1 0x00, 0x01 ManufacturerAccess() and 0x3E, 0x3F AlternateManufacturerAccess()

ManufacturerBlockAccess() provides a method of reading and writing data in the Manufacturer Access System (MAC). This block MAC access method is a new standard for the bq40zxy family. The MAC command is sent via *ManufacturerBlockAccess()* by a block protocol. The result is returned on *ManufacturerBlockAccess()* via a block read.

Commands are set by writing to registers 0x00/0x01. On valid word access the MAC command state is set, in addition, commands 0x3E and 0x3F are also used for MAC commands. This new addresses work the same as 0x00 and 0x01, but are primarily intended for block writes and reads.

Example: Send a MAC *Gauging()* to enable IT via *ManufacturerBlockAccess()*.

1. With Impedance Track disabled, send *Gauging()* (0x0021) to *ManufacturerBlockAccess()*
 - (a) A block write. Command = 0x3E, 0x3F. Data = 21 00 (data must be sent in little endian)
2. IT is enabled, *ManufacturingStatus()[GAUGEN_EN]* = 1.

Example: Read *Chemical ID()* (0x0006) via *ManufacturerBlockAccess()*

1. Send *Chemical ID()* to *ManufacturerBlockAccess()*.
 - (a) A block write. Command = 0x3E and 0x3F. Data sent = 06 00 (data must be sent in little endian)
2. Read the result from *ManufacturerBlockAccess()*.
 - (a) A block read. Command = 0x3E and 0x3F input. Data read = 06 00 00 01 (each data entity is returned in little endian).
 - (b) The first 2 bytes, "06 00", is the MAC command.
 - (c) The second 2 bytes, "00 01", is the chem ID returning in little endian. That is 0x0100, chem ID 100.

For backwards compatibility with the bq30zxy families, sending MAC commands via *ManufacturerAccess()* (0x00) as well as the returning data on *ManufacturerData()* are supported in bq28z610. Note that MAC commands are sent through *ManufacturerAccess()* (0x00) by a byte wise protocol using I2C. The result reading from *ManufacturerData()* does not include the MAC command.

Example: Send a MAC *Gauging()* to enable IT via *ManufacturerAccess()*.

1. With Impedance Track disabled, send *Gauging()* (0x0021) to *ManufacturerAccess()*.
 - (a) A word write. Command = 0x00. Data = 00 21
2. IT is enabled, *ManufacturingStatus()[GAUGEN_EN]* = 1.

Example: Read *Chemical ID()* (0x0006) via *ManufacturerAccess()*

1. Send *Chemical ID()* to *ManufacturerAccess()*
 - (a) A word write. Command = 0x00. Data sent = 00 06
2. Read the result from *ManufacturerBlockAccess()*
 - (a) A block read. Command = 0x23. Data read = 00 01
 - (b) That is 0x0100, chem ID 100.

The *ManufacturerAccess()* and *ManufacturerBlockAccess()* are interchangeable. However, the result must be read from *ManufacturerAccess()*

To support legacy method

It is recommended to send “command only” operations to 0x00 and 0x01, and also to set the command for read back in the same way. The reason for this is that it can always reset any legacy support options that may be in effect, whereas some legacy support options use 0x3e and 0x3f for other purposes. However, 0x3e and 0x3f can always safely be used for block writes. For backward compatibility, request of device number or version will report a value for read on 0x00/0x01. The response word for both MAC command DEV and VERSION (0x0001 and 0x0002) should report 0xFFA5 as the legacy response. This is meant as a token to indicate to the host that the real response is on the extended block. As before “command only” operations take place immediately after the word write.

Table 12-1. ManufacturerAccess() Command List

Command	Function	Access	Format	Data Read on BlockData()	Not Available in SEALED Mode	Type	Units
0x0001	DeviceType	R	Block	√	—	Hex	—
0x0002	FirmwareVersion	R	Block	√	—	Hex	—
0x0003	HardwareVersion	R	Block	√	—	Hex	—
0x0004	IFChecksum	R	Block	√	—	Hex	—
0x0005	StaticDFSSignature	R	Block	√	—	Hex	—
0x0006	ChemID	R	Block	√	—	Hex	—
0x0007	Prev_MacWrite	R	Block	√	—	Hex	—
0x0008	StaticChemDFSSignature	R	Block	√	—	Hex	—
0x0009	AllDFSSignature	R	Block	√	—	Hex	—
0x0010	ShutdownMode	W	—	—	—	Hex	—
0x0011	SleepMode	W	—	—	—	Hex	—
0x0012	Reset	W	—	—	—	Hex	—
0x0013	Auto_CAL_MAC	W	—	—	—	Hex	—
0x001F	ChargeFET	W	—	—	√	Hex	—
0x0020	DischargeFET	W	—	—	√	Hex	—
0x0021	Gauging (IT Enable)	W	—	—	√	Hex	—
0x0022	FETControl	W	—	—	√	Hex	—
0x0023	LifetimeDataCollection	W	—	—	√	Hex	—
0x0024	PermanentFailure	W	—	—	√	Hex	—
0x0028	LifetimeDataReset	W	—	—	√	Hex	—
0x0029	PermanentFailureDataReset	W	—	—	√	Hex	—
0x002D	CalibrationMode	W	—	—	√	Hex	—
0x002E	LifetimeDataFlush	W	—	—	√	Hex	—
0x002F	LifetimeDataTest	W	—	—	√	Hex	—
0x0030	SealDevice	W	—	—	—	Hex	—
0x0035	SecurityKeys	R/W	Block	√	—	Hex	—
0x0037	AuthenticationKey	R/W	Block	—	—	Hex	—
0x0041	Reset	W	—	—	—	Hex	—
0x004A	Device Name	R/W	Block	√	—	Hex	—
0x004B	Device Chem	R/W	Block	√	—	Hex	—
0x004C	Manufacturer Name	R/W	Block	√	—	Hex	—
0x004D	Manufacturer Date	R/W	Block	√	—	Hex	—
0x004E	Serial Number	R/W	—	√	—	Hex	—
0x0050	SafetyAlert	R	Block	√	—	Hex	—
0x0051	SafetyStatus	R	Block	√	—	Hex	—
0x0052	PFAlert	R	Block	√	—	Hex	—
0x0053	PFStatus	R	Block	√	—	Hex	—
0x0054	OperationStatus	R	Block	√	—	Hex	—
0x0055	ChargingStatus	R	Block	√	—	Hex	—
0x0056	GaugingStatus	R	Block	√	—	Hex	—
0x0057	ManufacturingStatus	R	Block	√	—	Hex	—
0x0058	AFERegister	R	Block	√	—	Hex	—
0x0060	LifetimeDataBlock1	R	Block	√	—	Mixed	Mixed
0x0070	ManufacturerData	R	Block	√	—	Hex	—
0x0071	DAStatus1	R	Block	√	—	Mixed	Mixed
0x0072	DAStatus2	R	Block	√	—	Mixed	Mixed
0x0073	ITStatus1	R	Block	√	—	Mixed	Mixed

Table 12-1. ManufacturerAccess() Command List (continued)

Command	Function	Access	Format	Data Read on BlockData()	Not Available in SEALED Mode	Type	Units
0x0074	ITStatus2	R	Block	√	—	Mixed	Mixed
0x0075	ITStatus3	R	Block	√	—	Mixed	Mixed
0x0076	CB Status	R	Block	√	—	Hex	—
0x0077	FCC_SOH	R	Block	√	—	Hex	—
0x01yy	DFAccessRowAddress	R/W	Block	—	√	Hex	—
0x0F00	ROMMode	W	—	—	√	Hex	—
0xF080	ExitCalibrationOutput	R/W	Block	√	√	Hex	—
0xF081	OutputCCandADCforCalibration	R/W	Block	√	√	Hex	—
0xF082	OutputShortedCCandADCforCalibration	R/W	Block	√	√	Hex	—

12.1.1 ManufacturerAccess() Control

A read on this register returns the Control bits

The following is a table of I2C registers, the control bits are read back on register 0x00/0x01. These control bits are provided for backward comparability/ease of use and are the following.

Name	Register code (LSB/MSB)	DESCRIPTION
<i>Control()</i>	CNTL 0x00/0x01	Control Register (See below)
<i>AtRate()</i>	AR 0x02/0x03	Read/Write, the value is a signed integer, with negative value indicating a discharge current value. The default value is zero and forces AtRateTimeTo Empty() to return 65,535.
<i>AtRateTimeToEmpty()</i>	ARTT E 0x04/0x05	This is a read only function returns an unsigned integer value to predict remaining operating time based on battery discharge at the AtRate() value in minutes with a range of 0 to 65,534. A value of 65,535 indicates AtRate() = 0. The gas gauge updates the AtRateTimeToEmpty() within 1s after the system sets the AtRate() value. The gas gauge updates these parameters every 1s. The commands are used in NORMAL mode
<i>Temperature()</i>	TEMP 0x06/0x07	This is read only function returns an unsigned integer value of temperature in units 0.1k measured by the gas gauge and is used for gauging algorithm. It reports either InternalTemperature() or external thermistor temperature depending on setting of [TEMPS] bit in Pack configuration
<i>Voltage()</i>	VOLT 0x08/0x09	This is read only function returns an unsigned integer value of the measured cell pack in mV with a range of 0 12000mV
<i>BatteryStatus()</i>	FLAG S 0x0a/0x0b	See Flags Register
<i>Current()</i>	INST CUR R 0x0c/0x0d	This is read only function and returns a signed integer value that is the instantaneous current flow through the sense resistor. The value is updated every 1 sec. Units are mA
<i>RemainingCapacity_mAh()</i>	RM 0x10/0x11	This is read only command and returns the compensated battery capacity remaining in mAh units
<i>FullChargeCapacity_mAh()</i>	FCC 0x12/0x13	This is read only command and returns the compensated battery capacity of the battery when fully charged. Units are mAh.
<i>AverageCurrent</i>	AI 0x14/0x15	This is read only function and returns a signed integer value that is the average current flow through the sense resistor. The value is updated every 1 sec. Units are mA
<i>AverageTimeToEmpty</i>	TTE 0x16/0x17	Uses average current value with a time constant of 15secs for this method. A value of 65535 means battery is NOT being discharged

(continued)

Name		Register code (LSB/MSB)	DESCRIPTION
<i>AverageTimeToFull</i>	TTF	0x18/0x19	This is read only function and returns a unsigned integer value, predicting time to reach full charge for the battery in units of minutes based on <i>AverageCurrent()</i> . The computation accounts for the taper current time extension from linear TTF computation based on a fixed <i>AverageCurrent()</i> rate of charge accumulation. A value of 65,535 indicates the battery is NOT being charged
<i>StandbyCurrent</i>	SI	0x1a/0x1b	This is a read only function and returns a signed integer value of measured standby current through the sense resistor. The <i>StandbyCurrent()</i> is an adaptive measurement. Initially it will report the standby current programmed in Initial standby, and after several seconds in standby mode will report the measured standby. The register value is updated every 1sec when measured current is above the Deadband and is less than or equal to 2 x initial standby. The first and last values that meet these criteria are NOT averaged in, since they may NOT be stable values. To approximate to a 1min time constant, each new value of <i>StandbyCurrent()</i> is computed by taking approx 93% weight of the last standby current and approximate 7% of the current measured average current
<i>StandbyTimeToEmpty</i>	STTE	0x1c/0x1d	This is read only function and returns a unsigned integer value, predicting remaining battery life at standby rate of discharge in units of minutes. The computation uses Nominal Available Capacity (NAC) for the calculation. A value of 65,535 indicates the battery is NOT being discharged
<i>MaxLoadCurrent</i>	MLI	0x1e/0x1f	This is read only function and returns a signed integer value in units of mA, of maximum load conditions. The <i>MaxLoadCurrent()</i> is an adaptive measurement which is initially reported as the maximum load current programmed in initial Max Load Current register. If the measured current is ever greater than the initial Max Load Current then the <i>MaxLoadCurrent()</i> updates to the new current. <i>MaxLoadCurrent()</i> is reduced to the average of the previous value and initial Max Load Current whenever the battery is charged to full after a previous discharge to an SOC of less than 50%. This will prevent the reported value from maintaining an unusually high value
<i>MaxLoadTimeToEmpty</i>	MLTTE	0x20/0x21	This is read only function and returns a unsigned integer value, predicting remaining battery life at the maximum discharge load current rate in units of minutes. A value of 65,535 indicates that the battery is NOT being discharged
<i>AveragePower</i>	AP	0x24/0x25	This is read only function and returns a signed integer value of average power during battery charging and discharging. It is negative during discharge and positive during charge. A value of 0 indicates that the battery is NOT being discharged. The value is reported in units of mW
<i>InternalTemperature</i>	INT_TEMP	0x28/0x29	This is read only function and returns an unsigned integer value of the measured internal temperature of the device in 0.1k units measured by the gas gauge
<i>CycleCount</i>	CC	0x2a/0x2b	This is read only function and returns an unsigned integer value of the number of cycles the battery has experienced a discharge (range 0 to 65535). One cycle occurs when accumulated discharge greater than or equal to CC threshold.
<i>RelativeStateOfCharge</i>	SOC	0x2c/0x2d	This is read only function and returns an unsigned integer value of the predicted remaining battery capacity expressed as percentage of <i>FullChargeCapacity()</i> with a range of 0% to 100%
<i>StateOfHealth</i>	SOH	0x2e/0x2f	0x2e is SOH percentage read only function which returns unsigned integer value expressed as a percentage of the ratio of predicted FCC (25C SOH Load) over the <i>DesignCapacity()</i> . The range is 0x00 to 0x64 for 0% to 100% respectively. 0x2f is the SOH status; this is a read only function and returns an unsigned integer value to indicate the status of the SOH percentage. 0x00: SOH not valid, 0x01: instant SON value ready, 0x02: Initial SOH value ready, 0x03: SOH value ready
<i>ChargeVoltage</i>	CV	0x30/0x31	Returns the desired charging voltage in mV to the charger
<i>ChargeCurrent</i>	CC	0x32/0x33	Returns the desired charging current in mA to the charger
<i>DesignCapacity</i>		0x3c/0x3d	In SEALED and UNSEALED access: This command returns the value stored in Design Capacity and is expressed in mAh. This is intended to be a theoretical or nominal capacity of a new pack, but should have no bearing on the operation of the gas gauge functionality
<i>BlockDataCmd</i>		0x3e/0x3f	MAC Data block command 0x3e to 0x61

(continued)

Name	Register code (LSB/MSB)	DESCRIPTION
<i>BlockData</i>	0x40/0x5f	MAC Data block
<i>BlockDataSum</i>	0x60	MAC Data block Check Sum
<i>BlockDataLen</i>	0x61	MAC Data block Length
<i>TurboPower</i>	0x70/0x71	Read only word for Turbo_Power in cW
<i>TurboFinal</i>	0x72/0x73	Can be used to over write DF register content for Min Turbo Power level desired or read value for Turbo_final setting
<i>TurboPackR</i>	0x74/0x75	Can be used to over write DF register content for Pack side resistance value, or read information of Pack side resistance setting
<i>TurboSysR</i>	0x76/0x77	Can be used to over write DF register content for System side resistance value, or read information of System side resistance setting
<i>TurboEdv</i>	0x78/0x79	Can be used to over write DF register content for Minimum system side voltage desired for Turbo boost mode, or read information of Minimum system voltage settings
<i>TurboCurrent</i>	0x7a/0x7b	Read only word for Turbo_Current in mA

The following is the content of the Control Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RSVD	SEC1	SEC0	AUTH CALM	RSVD	RSVD	Check SumValid	RSVD	RSVD	RSVD	RSVD	RSVD	LDMD	R_DIS	VOK	QMax

RSVD (Bit 15): Reserved

SEC1, SEC0 (Bit 14, 13): Security

1, 0 Full Access Sealed

=

1, 1 Sealed

=

AUTHCALM (Bit 12): Automatic Calibration Mode

1 = Enabled

0 = Disabled

RSVD (Bit 11, 10): Reserved

ChecksumValid (Bit 9): Check Sum Valid

1 = Flash Writes are Enabled

0 = Flash Writes are disabled due to low voltage or PF condition

RSVD (Bit 8, 4): Reserved

LDMD (Bit 3): LOAD Mode

1 = Constant Power

0 = Constant Current

R_DIS (Bit 2): Resistance Updates

1 = Disabled

0 = Enabled

VOK (Bit 1): Voltage OK for QMax Update

1 = Detected

0 = Not Detected

QMax (Bit 0): QMax Updates

This bit toggles after every QMax Updates

12.1.2 *ManufacturerAccess() 0x0001 Device Type*

The device can be checked for the IC part number.

Status	Condition	Action
Enable	0x0001 to <i>ManufacturerAccess()</i>	Returns the IC part number on subsequent read on <i>BlockData()</i> in the following format: aaAA, where: aaAA: device type

12.1.3 *ManufacturerAccess() 0x0002 Firmware Version*

The device can be checked for the firmware version of the IC.

Status	Condition	Action
Enable	0x0002 to <i>ManufacturerAccess()</i>	Returns the firmware revision on <i>BlockData()</i> in the following format: ddDDvvVVbbBBttZZRRREE, where: ddDD: Device Number vvVV: Version bbBB: build number ttTT: Firmware type zzZZ: Impedance Track Version RR: reserved EE: reserved

12.1.4 *ManufacturerAccess() 0x0003 Hardware Version*

The device can be checked for the hardware version of the IC.

Status	Condition	Action
Enable	0x0003 to <i>ManufacturerAccess()</i>	Returns the hardware revision on subsequent read on <i>BlockData()</i>

12.1.5 *ManufacturerAccess() 0x0004 Instruction Flash Signature*

The device can return the instruction flash signature

Status	Condition	Action
Enable	0x0004 to <i>ManufacturerAccess()</i>	Returns the IF signature on subsequent read on <i>BlockData()</i> after a wait time of 250 ms

12.1.6 *ManufacturerAccess() 0x0005 Static DF Signature*

The device can return the data flash checksum.

Status	Condition	Action
Enable	0x0005 to <i>ManufacturerAccess()</i>	Returns the signature of all static DF on subsequent read on <i>BlockData()</i> after a wait time of 250 ms. MSB is set to 1 if the calculated signature does not match the signature stored in DF.

12.1.7 *ManufacturerAccess()* 0x0006 Chemical ID

This command returns the chemical ID of the OCV tables used in the gauging algorithm.

Status	Condition	Action
Enable	0x0006 to <i>ManufacturerAccess()</i>	Returns the chemical ID on subsequent read on <i>BlockData()</i>

12.1.8 *ManufacturerAccess()* 0x0007 Pre_MACWrite

This command enables copying the last MAC into a 2-byte block.

Status	Condition	Action
Enable	0x0007 to <i>ManufacturerAccess()</i>	Copies the last MAC information into a 2-byte block <i>BlockData()</i>

12.1.9 *ManufacturerAccess()* 0x0008 Static Chem DF Signature

The device can return the data flash checksum.

Status	Condition	Action
Enable	0x0008 to <i>ManufacturerAccess()</i>	Returns the signature of all static chemistry DF on subsequent read on <i>BlockData()</i> after a wait time of 250 ms. MSB is set to 1 if the calculated signature does not match the signature stored in DF.

12.1.10 *ManufacturerAccess()* 0x0009 All DF Signature

The device can return the data flash checksum.

Status	Condition	Action
Enable	0x0008 to <i>ManufacturerAccess()</i>	Returns the signature of all DF parameters on subsequent read on <i>BlockData()</i> after a wait time of 250 ms. MSB is set to 1 if the calculated signature does not match the signature stored in DF. It is normally expected that this signature will change due to update of lifetime, gauging, and other information.

12.1.11 *ManufacturerAccess()* 0x0010 SHUTDOWN Mode

The device can be sent to SHUTDOWN mode before shipping to reduce power consumption to a minimum. The device will wake up when a voltage is applied to PACK. When the pack is sealed, this feature requires the command be sent twice in a row for safety. Once SHUTDOWN mode is enabled, it is not possible to clear it without entering SHUTDOWN mode.

Status	Condition	Action
Normal	<i>OperationStatus()</i> [SDM] = 0	Shutdown feature is armed internally.
Arm	<i>OperationStatus()</i> [SEC1, SEC0] = [1, 1] 0x0010 sent to <i>ManufacturerAccess()</i>	Shutdown feature is armed internally.
Enable	0x0010 to <i>ManufacturerAccess()</i> when <i>OperationStatus</i> [SEC1, SEC0] = [1, 1] OR 0x0010 to <i>ManufacturerAccess()</i> when shutdown feature is armed.	<i>OperationStatus()</i> [SDM] = 1
Trip	[NR] = 1 AND <i>Current()</i> = 0 AND Voltage on PACK < Power. Charger Present AND <i>OperationStatus()</i> [SDM] = 1	No charging or discharging allowed. Device shutdown.
Recovery	Voltage on PACK pin and device in SHUTDOWN mode.	Device powers up (reset)

12.1.12 ManufacturerAccess() 0x0011 SLEEP Mode

The device can be sent to sleep with *ManufacturerAccess()* if the sleep conditions are met.

Status	Condition	Action
Enable	0x0011 to <i>ManufacturerAccess()</i>	<i>OperationStatus()[SLEEPM] = 1</i>
Activate	<i>DA Configuration[NR] = 1 AND Current() < Power:Sleep Current</i>	Turn off DSG FET, Turn off CHG FET if <i>DA Configuration[SLEEPCHG] = 0</i> Device goes to sleep Device wakes up every <i>Power:Sleep Voltage Time</i> period to measure voltage and temperature Device wakes up every <i>Power:Sleep Current Time</i> period to measure current
Exit	<i>DA Configuration[NR] = 0</i>	<i>OperationStatus()[SLEEPM] = 0</i> Return to NORMAL mode
Exit	<i> Current() > Configuration:Sleep Current</i>	<i>OperationStatus()[SLEEPM] = 0</i> Return to NORMAL mode
Exit	Wake Comparator trips	<i>OperationStatus()[SLEEPM] = 0</i> Return to NORMAL mode
Exit	<i>SafetyAlert()</i> flag or <i>PFAAlert()</i> flag set	<i>OperationStatus()[SLEEPM] = 0</i> Return to NORMAL mode

12.1.13 ManufacturerAccess() 0x0012 Device Reset

This command resets the device.

Status	Condition	Action
Enable	0x0012 to <i>ManufacturerAccess()</i>	Reset the device

NOTE: Command 0x0041 also resets the device

12.1.14 ManufacturerAccess() 0x001F CHG FET

This command turns on/off CHG FET drive function to ease testing during manufacturing.

Status	Condition	Action
Disable	<i>ManufacturingStatus()[FET,CHG] = 0,1 AND 0x001F to ManufacturerAccess()</i>	<i>ManufacturingStatus()[FET,CHG] = 0,0</i> CHG FET turns off
Enable	<i>ManufacturingStatus()[FET,CHG] = 0,0 AND 0x001F to ManufacturerAccess()</i>	<i>ManufacturingStatus()[FET,CHG] = 0,1</i> CHG FET turns on if no safety condition override

12.1.15 ManufacturerAccess() 0x0020 DSG FET

This command turns on/off DSG FET drive function to ease testing during manufacturing.

Status	Condition	Action
Disable	<i>ManufacturingStatus()[FET,DSG] = 0,1 AND 0x0020 to ManufacturerAccess()</i>	<i>ManufacturingStatus()[FET,DSG] = 0,0</i> DSG FET turns off <i>ManufacturingStatus()[FET,DSG] = 0,0 AND 0x0020 to ManufacturerAccess()</i>
Enable		<i>ManufacturingStatus()[FET,DSG] = 0,1</i> DSG FET turns on if no safety condition override

12.1.16 ManufacturerAccess() 0x0021 Gauging

This command enables or disables the gauging function to ease testing during manufacturing.

Status	Condition	Action
Disable	<i>ManufacturingStatus()</i> [Gauge] = 1 AND 0x0021 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [Gauge] = 0 Disables gauging feature
Enable	<i>ManufacturingStatus()</i> [Gauge] = 0 AND 0x0021 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [Gauge] = 1 Enable gauging feature

12.1.17 *ManufacturerAccess()* 0x0022 FET Control

This command disables/enables control of the CHG, DSG, and PCHG FET by the firmware.

Status	Condition	Action
Disable	<i>ManufacturingStatus()</i> [FET] = 1 AND 0x0022 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [FET] = 0 CHG and DSG FET are disabled and remain OFF.
Enable	<i>ManufacturingStatus()</i> [FET] = 0 AND 0x0022 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [FET] = 1 CHG and DSG FET are controlled by the firmware.

12.1.18 *ManufacturerAccess()* 0x0023 Lifetime Data Collection

This command disables/enables Lifetime data collection for ease of manufacturing.

Status	Condition	Action
Disable	<i>ManufacturingStatus()</i> [LF] = 1 AND 0x0023 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [LF] = 0 Lifetime Data collection feature disabled
Enable	<i>ManufacturingStatus()</i> [LF] = 0 AND 0x0023 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [LF] = 1 Lifetime Data collection feature enabled

12.1.19 *ManufacturerAccess()* 0x0024 Permanent Failure

This command disables/enables Permanent Failure for ease of manufacturing.

Status	Condition	Action
Disable	<i>ManufacturingStatus()</i> [PF] = 1 AND 0x0024 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [PF] = 0 Permanent Failure feature disabled
Enable	<i>ManufacturingStatus()</i> [PF] = 0 AND 0x0024 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [PF] = 1 Permanent Failure feature is enabled.

12.1.20 *ManufacturerAccess()* 0x0028 Lifetime Data Reset

This command resets Lifetime data in data flash for ease of manufacturing.

Status	Condition	Action
Reset	0x0028 to <i>ManufacturerAccess()</i>	Clear Lifetime Data in DF

12.1.21 *ManufacturerAccess()* 0x0029 Permanent Fail Data Reset

This command resets PF data in data flash for ease of manufacturing.

Status	Condition	Action
Reset	0x0029 to <i>ManufacturerAccess()</i>	Clear PF Data in DF

12.1.22 *ManufacturerAccess()* 0x002D CALIBRATION Mode

This command disables/enables entry into CALIBRATION mode. Status is indicated by the *ManufacturingStatus()*[CAL] flag.

Status	Condition	Action
Disable	<i>ManufacturingStatus()[CAL]</i> = 1 AND 0x002D to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()[CAL]</i> = 0 Disable output of ADC and CC raw data on <i>ManufacturingData()</i>
Enable	<i>ManufacturingStatus()[CAL]</i> = 0 AND 0x002D to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()[CAL]</i> = 1 Enable output of ADC and CC raw data on <i>ManufacturingData()</i> , controllable with 0xF081 and 0xF082 on <i>ManufacturerAccess()</i>

12.1.23 *ManufacturerAccess()* 0x0030 Seal Device

This command seals the device for the field, disabling certain commands and access to DF.

Status	Condition	Action
Sealed	<i>OperationStatus()[SEC1,SEC0]</i> = 0,1 or 1,0 AND 0x0030 to <i>ManufacturerAccess()</i>	<i>OperationStatus()[SEC1,SEC0]</i> = 1,1 Certain Commands are not available. See the command table for details.

12.1.24 *ManufacturerAccess()* 0x0035 Security Keys

This is a read/write command that changes the Unseal and Full Access keys. To read the keys, sending the *SecurityKeys()* command to either the *ManufacturerAccess()* 0x00 or 0x3e, followed by a read from *ManufacturerBlockAccess()*.

To change the keys, the write operations must send through *ManufacturerBlockAccess()* with the *SecurityKeys()* followed by the keys. Each parameter entry must be sent in little endian.

Example:

Changing the Unseal key to 0x0123, 0x4567 and the Full Access key to 0x89AB, 0xCDEF:

Byte0: Unseal Key LSB
 Byte1: Unseal Key MSB
 Byte2: Full Access Key LSB
 Byte3: Full Access Key MSB

Write block: command through *ManufacturerBlockAccess()* Starting address 0x3E, data block (hex) = [35 00 23 01 67 45 AB 89 EF CD].

Starting address 0x60, data block(hex) = [0A 0C] (checksum followed by length)

Checksum = 0x0A = $\sim(0x35 + 0x00 + 0x23 + 0x01 + 0x67 + 0x45 + 0xAB + 0x89 + 0xEF + 0xCD)$. The checksum is the 8 bit sum of the MSB and LSB of the command plus the (command length) bytes in the buffer. The final sum is the bitwise inversion of the result.

12.1.25 *ManufacturerAccess()* 0x0037 Authentication Key

This command enters a new authentication key into the device.

Status	Condition	Action
Initiate	<i>OperationStatus()[SEC1,SEC0]</i> = 0,1 AND 0x0037 to <i>ManufacturerAccess()</i>	<i>OperationStatus()[AUTH]</i> = 1 160-bit random number available at <i>BlockData()</i>
Enter Key	Correct 128-bit Key written to <i>BlockData()</i> in the format 0xAABBCCDDEEFFGGHHIIJJKLLMMNNOOPP, where AA is LSB. In addition to this information the the checksum + length data block is required	Wait time 250 ms <i>OperationStatus()[AUTH]</i> = 0 Device returns 160-bit HMAC digest at <i>BlockData()</i> in the format 0xAABBCCDDEEFFGGHHIIJJKLLMMNNOOPPQRR SSTTT, where AA is LSB. The HMAC digest was calculated using the random number + key. Compare with own calculations, check the validity of the key.

12.1.26 ManufacturerAccess() 0x0041 Device Reset

This command resets the device.

Status	Condition	Action
Enable	0x0041 to <i>ManufacturerAccess()</i>	Reset the device

NOTE: Command 0x0012 also resets the device.

12.1.27 ManufacturerAccess() 0x0050 SafetyAlert

This command returns the *SafetyAlert()* flags on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0050 to <i>ManufacturerAccess()</i>	Output <i>SafetyAlert()</i> flags on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
RSVD	RSVD	RSVD	RSVD	UTD	UTC	RSVD	RSVD	RSVD	RSVD	CTOS	RSVD	PTOS	RSVD	RSVD	RSVD
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RSVD	RSVD	OTD	OTC	RSVD	ASCD	RSVD	ASCC	RSVD	AOLD	RSVD	OCD	RSVD	OCC	COV	CUV

UTD (Bit 27): Undertemperature during Discharge

- 1 = Detected
- 0 = Not Detected

UTC (Bit 26): Undertemperature during Charge

- 1 = Detected
- 0 = Not Detected
- 0 = Not Detected

CTOS (Bit 21): Charge Timeout Suspend

- 1 = Detected
- 0 = Not Detected

PTOS (Bit 19): Precharge Timeout Suspend

- 1 = Detected
- 0 = Not Detected

OTD (Bit 13): Overtemperature during Discharge

- 1 = Detected
- 0 = Not Detected

OTC (Bit 12): Overtemperature during Charge

- 1 = Detected
- 0 = Not Detected

ASCD (Bit 10): Short-circuit during Discharge

- 1 = Detected
- 0 = Not Detected

ASCC (Bit 8): Short-circuit during Charge

- 1 = Detected

0 = Not Detected

AOLD (Bit 6): Overload during Discharge

1 = Detected

0 = Not Detected

OCD (Bit 4): Overcurrent during Discharge

1 = Detected

0 = Not Detected

OCC (Bit 2): Overcurrent during Charge

1 = Detected

0 = Not Detected

COV (Bit 1): Cell Overvoltage

1 = Detected

0 = Not Detected

CUV (Bit 0): Cell Undervoltage

1 = Detected

0 = Not Detected

12.1.28 *ManufacturerAccess() 0x0051 SafetyStatus*

This command returns the *SafetyStatus()* flags on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0051 to <i>ManufacturerAccess()</i>	Output <i>SafetyStatus()</i> flags on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
RSVD	RSVD	RSVD	RSVD	UTD	UTC	RSVD	RSVD	RSVD	RSVD	RSVD	CTO	RSVD	PTO	RSVD	RSVD
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RSVD	RSVD	OTD	OTC	RSVD	ASCD	RSVD	ASCC	RSVD	AOLD	RSVD	OCD	RSVD	OCC	COV	CUV

UTD (Bit 27): Undertemperature during Discharge

1 = Detected

0 = Not Detected

UTC (Bit 26): Undertemperature during Charge

1 = Detected

0 = Not Detected

CTO (Bit 20): Charge Timeout

1 = Detected

0 = Not Detected

PTO (Bit 18): Precharge Timeout

1 = Detected

0 = Not Detected

OTD (Bit 13): Overtemperature during Discharge

1 = Detected

0 = Not Detected

OTC (Bit 12): Overtemperature during Charge

- 1 = Detected
- 0 = Not Detected

ASCD (Bit 10): Short-circuit during Discharge

- 1 = Detected
- 0 = Not Detected

ASCC (Bit 8): Short-circuit during Charge

- 1 = Detected
- 0 = Not Detected

AOLD (Bit 6): Overload during Discharge

- 1 = Detected
- 0 = Not Detected

OCD (Bit 4): Overcurrent during Discharge

- 1 = Detected
- 0 = Not Detected

OCC (Bit 2): Overcurrent during Charge

- 1 = Detected
- 0 = Not Detected

COV (Bit 1): Cell Overvoltage

- 1 = Detected
- 0 = Not Detected

CUV (Bit 0): Cell Undervoltage

- 1 = Detected
- 0 = Not Detected

12.1.29 *ManufacturerAccess() 0x0052 PFAIert*

This command returns the *PFAIert()* flags on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0052 to <i>ManufacturerAccess()</i>	Output <i>PFAIert()</i> flags on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>

7	6	5	4	3	2	1	0
RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	SOV	RSVD

RSVD (Bit 7:2): Reserved

SOV (Bit 1): Safety Cell Overvoltage Failure

- 1 = Detected
- 0 = Not Detected

RSVD (Bit 0): Reserved

12.1.30 ManufacturerAccess() 0x0053 PFStatus

This command returns the *PFStatus()* flags on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0053 to <i>ManufacturerAccess()</i>	Output <i>PFStatus()</i> flags on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>

7	6	5	4	3	2	1	0
RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	SOV	RSVD

RSVD (Bit 7: 2): Reserved

SOV (Bit 1): Safety Cell Overvoltage Failure

1 = Detected

0 = Not Detected

RSVD (Bit 0): Reserved

12.1.31 ManufacturerAccess() 0x0054 OperationStatus

This command returns the *OperationStatus()* flags on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0054 to <i>ManufacturerAccess()</i>	Output <i>OperationStatus()</i> flags on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
SLEEP PM	XL	CAL OFFS ET	CAL	AUTO CALM	AUTH	RSVD	SDM	RSVD	RSVD	RSVD	CB	SLPC C	SLPA D	SMBL CAL	INIT
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
BTP_I NT	RSVD	RSVD	RSVD	RSVD	CHG	DSG	RSVD	SLEEP P	XCHG	XD SG	PF	SS	SDV	SEC1	SEC0

SLEEPM (Bit 31): SLEEP mode

1 = Active

0 = Inactive

XL (Bit 30): 400 kHz mode

1 = Active

0 = Inactive

CAL_OFFSET (Bit 29): Calibration Output (raw CC offset data)

1 = Active when MAC *OutputShortedCCADCCal()* is sent and the raw shorted CC data for calibration is available

0 = When the raw shorted CC data for calibration is not available

CAL (Bit 28): Calibration Output (raw ADC and CC data)

1 = Active when either the MAC *OutputCCADCCal()* or *OutputShortedCCADCCal()* is sent and the raw CC and ADC data for calibration is available

0 = When the raw CC and ADC data for calibration is not available

AUTHCALM (Bit 27): Auto CC Offset Calibration by MAC *AutoCCOffset()*

- 1 = The gauge receives the MAC *AutoCCOffset()* and starts the auto CC offset calibration
- 0 = Clear when the calibration is completed

AUTH (Bit 26): Authentication in progress

- 1 = Active
- 0 = Inactive

SDM (Bit 24): Shutdown triggered via command

- 1 = Active
- 0 = Inactive

SLPCC (Bit 19): CC Measurement in SLEEP mode

- 1 = Active
- 0 = Inactive

SLPAD (Bit 18): ADC Measurement in SLEEP mode

- 1 = Active
- 0 = Inactive

SMBL CAL (Bit 17): Auto-offset calibration when Bus low is detected

- 1 = Active
- 0 = Inactive

INIT (Bit 16): Initialization after full reset

- 1 = Active
- 0 = Inactive

BTP_INT (Bit 15): Battery Trip Point Interrupt. The set and clear of this bit depends on various condition. (See section on BTP)

- 1 = Active
- 0 = Inactive

CHG (Bit 10): CHG FET status

- 1 = Active
- 0 = Inactive

DSG (Bit 9): DSG FET status

- 1 = Active
- 0 = Inactive

SLEEP (Bit 7): SLEEP mode conditions met

- 1 = Active
- 0 = Inactive

XCHG (Bit 6): Charging disabled

- 1 = Active
- 0 = Inactive

XDSG (Bit 5): Discharging disabled

- 1 = Active
- 0 = Inactive

PF (Bit 4): PERMANENT FAILURE mode status

- 1 = Active
- 0 = Inactive

SS (Bit 3): SAFETY mode status

1 = Active
0 = Inactive

) **SDV (Bit 2):** Shutdown triggered via low pack voltage

1 = Active
0 = Inactive

SEC1, SEC0 (Bits 0–1): SECURITY mode

0, 0 Reserved
=
0, 1 Unsealed
=
1, 0 Full Access
=
1, 1 Sealed
=

12.1.32 *ManufacturerAccess()* 0x0055 *ChargingStatus*

This command returns the *ChargingStatus()* flags on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0055 to <i>ManufacturerAccess()</i>	Output <i>ChargingStatus()</i> flags on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>

7	6	5	4	3	2	1	0
VCT	MCHG	SU	IN	HV	MV	LV	PV

VCT (Bit 7): Charge Termination

1 = Active
0 = Inactive

MCHG (Bit 6): Maintenance Charge

1 = Active
0 = Inactive

SU (Bit 5): Charge Suspend

1 = Active
0 = Inactive

IN (Bit 4): Charge Inhibit

1 = Active
0 = Inactive

HV (Bit 3): High Voltage Region

1 = Active
0 = Inactive

MV (Bit 2): Mid Voltage Region

1 = Active
0 = Inactive

LV (Bit 1): Low Voltage Region

- 1 = Active
- 0 = Inactive

PV (Bit 0): Precharge Voltage Region

- 1 = Active
- 0 = Inactive

12.1.33 ManufacturerAccess() 0x0056 GaugingStatus

This command returns the *GaugingStatus()* flags on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0056 to <i>ManufacturerAccess()</i>	Output <i>GaugingStatus()</i> flags on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
NSFM	RSVD	SLPQ MAX	QEN	VOK	RDIS	RSVD	REST	RSVD	RSVD	RSVD	OCVFR	LDMD	RX	QMax	VDQ
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	CF	DSG	EDV	BAL_E N	TC	TD	FC	FD

NSFM (Bit 31): Negative Scale Factor Mode

- 1 = Negative Ra Scaling Factor Detected
- 0 = Negative Ra Scaling Factor Not Detected

SLPQMax (Bit 29): QMax Update During Sleep

- 1 = Active
- 0 = Inactive

QEN (Bit 28): Impedance Track Gauging (Ra and QMax updates are enabled)

- 1 = Enabled
- 0 = Disabled

VOK (Bit 27): Voltage OK for QMax Update

- 1 = Detected
- 0 = Not Detected

R_DIS (Bit 26): Resistance Updates

- 1 = Disabled
- 0 = Enabled

REST (Bit 24): Rest

- 1 = OCV Reading Taken
- 0 = OCV Reading Not Taken or Not in Relax

OCVFR (Bit 20): Open Circuit Voltage in Flat Region (during Relax)

- 1 = Detected
- 0 = Not Detected

LDMD (Bit 19): LOAD Mode

- 1 = Constant Power
- 0 = Constant Current

RX (Bit 18): Resistance Update (Toggles after every resistance update)

QMax (Bit 17): QMax Update (Toggles after every QMax update)

VDQ (Bit 16): Discharge Qualified for Learning (based on RU flag)

1 = Detected

0 = Not Detected

CF (Bit 7): Condition Flag

1 = *MaxError()* > Max Error Limit (Condition Cycle Needed)

0 = *MaxError()* < Max Error Limit (Condition Cycle Not Needed)

DSG (Bit 6): Discharge/Relax

1 = Charging Not Detected

0 = Charging Detected

EDV (Bit 5): End-of-Discharge Termination Voltage

1 = Termination voltage reached during discharge

0 = Termination voltage not reached, or not in DISCHARGE mode

BAL_EN (Bit 4): Cell Balancing

1 = Cell balancing is possible if enabled

0 = Cell balancing is not allowed

TC (Bit 3): Terminate Charge

1 = Detected

0 = Not Detected

TD (Bit 2): Terminate Discharge

1 = Detected

0 = Not Detected

FC (Bits 1): Fully Charged

1 = Detected

0 = Not Detected

FD (Bit 0): Fully Discharged

1 = Detected

0 = Not Detected

12.1.34 *ManufacturerAccess()* 0x0057 *ManufacturingStatus*

This command returns the *ManufacturingStatus()* flags on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0057 to <i>ManufacturerAccess()</i>	Output <i>ManufacturingStatus()</i> flags on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CAL	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	PF	LF	FET	GAUG E	DSG	CHG	RSVD

CAL (Bit 15): CALIBRATION Mode

1 = Enabled

0 = Disabled

RSVD (Bit 8): Reserved**PF (Bit 6):** Permanent Failure

1 = Enabled

0 = Disabled

LF (Bit 5): Lifetime Data Collection

1 = Enabled

0 = Disabled

FET (Bit 4): All FET Action

1 = Enabled

0 = Disabled

GAUGE (Bit 3): Gas Gauging

1 = Enabled

0 = Disabled

DSG (Bit 2): Discharge FET Test

1 = Discharge FET test activated

0 = Disabled

CHG (Bit 1): Charge FET Test

1 = Charge FET test activated

0 = Disabled

12.1.35 ManufacturerAccess() 0x0058 AFE Register

This command returns the *AFERegister()* values on *AlternateManufacturerAccess()* or *ManufacturerData()*. These are the AFE hardware registers and are intended for internal debug use only.

Status	Condition	Action
Activate	0x0058 to <i>ManufacturerAccess()</i>	Output AFE Register values on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i> in the following format: AABBCCDDEEFFGGHHIIJJKKLLMMNNOOPPQQRRSSTTUU where: AA: AFE Interrupt Status. AFE Hardware interrupt status (e.g., wake time, push-button, etc.) BB: AFE FET Status. AFE FET status (e.g., CHG FET, DSG FET, input, etc.) CC: AFE RXIN. AFE I/O port input status DD: AFE Latch Status. AFE protection latch status EE: AFE Interrupt Enable. AFE interrupt control settings FF: AFE Control. AFE FET control enable setting GG: AFE RXIEN. AFE I/O input enable settings HH: II: JJ: KK: AFE Cell Balance. AFE cell balancing enable settings and status LL: AFE ADC/CC Control. AFE ADC/CC Control settings MM: AFE ADC Mux. AFE ADC channel selections NN: OO: AFE Control. AFE control on various HW based features PP: AFE Timer Control. AFE comparator and timer control QQ: AFE Protection. AFE protection delay time control RR: AFE OCD. AFE OCD settings SS: AFE SCC. AFE SCC settings TT: AFE SCD1. AFE SCD1 settings UU: AFE SCD2. AFE SCD2 settings

12.1.36 *ManufacturerAccess()* 0x0060 Lifetime Data Block 1

This command returns the Lifetime data on *BlockData()*.

Status	Condition	Action
Activate	0x0060 to <i>ManufacturerAccess()</i>	Output lifetime data values of Voltage, Current, Power, and Temperature on <i>BlockData()</i>

12.1.37 *ManufacturerAccess()* 0x0070 ManufacturerInfo

This command returns ManufacturerInfo on *BlockData()*.

Status	Condition	Action
Activate	0x0070 to <i>ManufacturerAccess()</i>	Output 32 bytes of ManufacturerInfo on <i>BlockData()</i> in the following format: AABBCCDDEEFFGGHHIIJJKKLLMMNN OOPPQQRRSSTTUUVVWWXXVZZ112233 445566

12.1.38 *ManufacturerAccess()* 0x0071 DStatus1

This command returns the CellVoltages, PackVoltage, BatVoltage, CellCurrents, CellPowers, Power, and AveragePower on *BlockData()*.

Status	Condition	Action
Activate	0x0071 to <i>ManufacturerAccess()</i>	Output 32 bytes of data on <i>BlockData()</i> in the following format: aaAAbbBBccCCddDDeeEEffFFggGGhhHHiilljJJkkK KILLmmMMnnNNooOOppPP where: AAaa: Cell Voltage 1 BBbb: Cell Voltage 2 CCcc: DDdd: EEee: BAT Voltage. Voltage at the VC2 (BAT) pin FFff: PACK Voltage GGgg: Cell Current 1. Simultaneous current measured during Cell Voltage1 measurement HHhh: Cell Current 2. Simultaneous current measured during Cell Voltage2 measurement Iiii: JJjj: KKkk: Cell Power 1. Calculated using Cell Voltage1 and Cell Current 1 data LLll: Cell Power 2. Calculated using Cell Voltage2 and Cell Current 2 data MMmm: NNnn: OOoo: Power calculated by <i>Voltage()</i> × <i>Current()</i> PPpp: Average Power. Calculated by <i>Voltage()</i> × <i>AverageCurrent()</i>

12.1.39 *ManufacturerAccess()* 0x0072 *DAStatus2*

This command returns the internal temp sensor, TS1 *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0072 to <i>ManufacturerAccess()</i>	Output 14 bytes of temperature data values on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i> in the following format: aaAAbbBBccCCddDDeeEEffFFggGG where:AAaa: Int Temperature BBbb: TS1 Temperature CCcc: DDdd: EEee: FFff: GGgg:

12.1.40 *ManufacturerAccess()* 0x0073 *ITStatus1*

This command instructs the device to return Impedance Track related gauging information on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0073 to <i>ManufacturerAccess()</i>	Output 32 bytes of IT data values on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i> in the following format: aaAAbbBBccCCddDDeeEEffFFggGGhhHHiiIjjJKkKKllLLmmMMnnNNooOOppPPqqQQ where: AAaa: True Rem Q. True remaining capacity in mAh from IT simulation before any filtering or smoothing function. This value can be negative or higher than FCC. BBbb: True Rem E. True remaining energy in cWh from IT simulation before any filtering or smoothing function. This value can be negative or higher than FCC. CCcc: Initial Q. Initial capacity calculated from IT simulation DDdd: Initial E. Initial energy calculated from IT simulation EEee: Reserve Q. Reserve Capacity FFff: Reserve E. Reserve Energy GGgg: T_sim. Temperature during the last simulation run. HHhh: T_ambient. Current assumed ambient temperature used by the IT algorithm for thermal modeling Iiii: RaScale 0. Ra table scaling factor of Cell1 JJJj: RaScale 1. Ra table scaling factor of Cell2 KKKk: LLLl: Mmmm: CompRes 0. Last temperature compensated Resistance of Cell1 NNNn: CompRes 1. Last temperature compensated Resistance of Cell2 OOOo: PPPp:

12.1.41 *ManufacturerAccess() 0x0074 ITStatus2*

This command instructs the device to return Impedance Track related gauging information on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0074 to <i>ManufacturerAccess()</i>	Output 32 bytes of IT data values on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i> in the following format: AABCCDDEEFFggGGhhHHiiiJJkkKKILLmmMMnnNNooOOppPPqqQRRrSS where: AA: Pack Grid. Active pack grid point (minimum of CellGrid0 to Cell Grid1) BB: LStatus—Learned status of resistance table Bit 3 Bit 2 Bit 1 Bit 0 QMax ITEN CF1 CF0 CF1, CF0: QMax Status 0,0 = Battery OK 0,1 = QMax is first updated in learning cycle 1,0 = QMax and resistance table updated in learning cycle ITEN: IT enable 0 = IT disabled 1 = IT enabled QMax: QMax update in field 0 = QMax has not been updated in the field 1= QMax updated in the field CC: Cell Grid 0. Active grid point of Cell1 DD: Cell Grid 1. Active grid point of Cell2 EE: FF: GGggHHhh: State Time. Time past since last state change (Discharge, Charge, Rest) Iiii: DOD0_0. Depth of discharge for Cell1 Jjji: DOD0_1. Depth of discharge for Cell2 Kkkk: LLli: Mmm: DOD0 Passed Q. Passed capacity since the last DOD0 update Nnn: DOD0 Passed E. Passed energy since last DOD0 update Ooo: DOD0 Time. Time passed since the last DOD0 update Ppp: DODEOC 0. Depth of discharge at end of charge of Cell1 Qqq: DODEOC 1. Depth of discharge at end of charge of Cell2 Rrr: Sss:

12.1.42 *ManufacturerAccess()* 0x0075 *ITStatus3*

This command instructs the device to return Impedance Track related gauging information on *AlternateManufacturerAccess()* or *ManufacturerData()*.

Status	Condition	Action
Activate	0x0075 to <i>ManufacturerAccess()</i>	Output 28 bytes of IT data values on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i> in the following format: aaAAbbBBccCCddDDeeEEffFGgGGhhHHiillJJkkKKILLmmMMnnNN where: AAaa: QMax 0. QMax of Cell1 BBbb: QMax 1. QMax of Cell2 CCcc: DDdd: EEee: QMax DOD0_0. DOD0 at last QMax update of Cell1 FFff: QMax DOD0_1. DOD0 at last QMax update of Cell2 GGgg: HHhh: Iiii: QMax Passed Q. Pass capacity since last QMax update JJjj: QMax Time. Time passed since last QMax update KKkk: Cell Balance Time 0. Calculated cell balancing time of Cell1 LLll: Cell Balance Time 1. Calculated cell balancing time of Cell2 MMmm: NNnn:

12.1.43 *ManufacturerAccess()* 0x0076 CB Status

This command returns the status of the cell being balanced.

Status	Condition	Action
Enable	0x0076 to <i>ManufacturerAccess()</i>	Returns the Cell Balance Status on subsequent read on <i>BlockData()</i>

12.1.44 *ManufacturerAccess()* 0x0077 State Of Health

This command returns the State Of Health percentage.

Status	Condition	Action
Enable	0x0077 to <i>ManufacturerAccess()</i>	Returns the State of Health percentage on subsequent read on <i>BlockData()</i>

12.1.45 *ManufacturerAccess()* 0x0F00 ROM Mode

This command sends the device into ROM mode in preparation for re-programming.

Status	Condition	Action
ROM Mode	<i>OperationStatus()</i> [SEC1,SEC0] = 0,1 AND 0x0F00 to <i>ManufacturerAccess()</i>	Device goes to ROM mode ready for update, use 0x08 to <i>ManufacturerAccess()</i> to return

NOTE: Command 0x0033 also puts the device in ROM mode (for backwards compatibility with the bq30z55 device).

0x4000–0x5FFF Data Flash Access()

Accessing data flash (DF) is only supported by the *AlternateManufacturerAccess()* by addressing the physical address.

To write to the DF, send the starting address, followed by the DF data block. The DF data block is the intended revised DF data to be updated to DF. The size of the DF data block ranges from 1 byte to 32 bytes. All individual data must be sent in little endian.

Write to DF example:

Assuming: data1 locates at address 0x4000 and data2 locates at address 0x4002.

Both data1 and data2 are U2 type.

To update data1 and data2, send a block write with command = 0x3e

block = starting address + DF data block

= 0x00 + 0x40 + data1_LowByte + data1_HighByte + data2_LowByte + data2_HighByte

To read the DF, send a block write to the *AlternateManufacturerAccess()*, followed by the starting address, then send a block read to the *AlternateManufacturerAccess()*. The return data contains the starting address followed by 32 bytes of DF data in little endian.

Read from DF example:

Taking the same assuming from the read DF example, to read DF,

a. Send write block with command 0x3e, block = 0x00 + 0x40

b. Send read block with command 0x3e

The returned block = a starting address + 32 bytes of DF data

= 0x00 + 0x40 + data1_LowByte + data1_HighByte + data2_LowByte + data2_HighByte...

data32_LowByte + data32_HighByte

The gauge supports an auto-increment on the address during a DF read. This greatly reduces the time required to read out the entire DF. Continue with the read from the DF example. If another read block is sent with command 0x3e, the gauge returns another 32 bytes of DF data, starting with address 0x4020.

12.1.46 *ManufacturerAccess() 0xF080 Exit Calibration Output Mode*

This command stops the output of calibration data to the *BlockData()* command.

Status	Condition	Action
Activate	<i>BlockData() = 1</i> AND 0xF080 to <i>ManufacturerAccess()</i>	Stop output of ADC or CC data on <i>BlockData()</i>

12.1.47 *ManufacturerAccess() 0xF081 Output CC and ADC for Calibration*

This command instructs the device to output the raw values for calibration purposes on *AlternateManufacturerAccess()* or *ManufacturerData()*. All values are updated every 250 ms and the format of each value is 2's complement, MSB first.

Status	Condition	Action
Disable	<i>ManufacturingStatus()</i> [CAL] = 1 AND 0xF080 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [CAL] = 0 Stop output of ADC and CC data on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>
Enable	0xF081 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [CAL] = 1 Outputs the raw CC and AD values on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i> in the format of ZZYyaaAAAbbBBccCCddDDeeEEffFF ggGGhhHHiilljJJkkKK: ZZ: rolling 8-bit counter, increments when values are refreshed YY: status, 1 when <i>ManufacturerAccess()</i> = 0xF081, 2 when <i>ManufacturerAccess()</i> = 0xF082 AAaa: Current (Coulomb Counter) BBaa: Cell Voltage 1 CCaa: Cell Voltage 2 DDaa: EEee: FFff:PACK Voltage GGgg: VC2 (BAT) Voltage HHhh: Cell Current 1 Iiii: Cell Current 2 JJjj: KKkk:

12.1.48 *ManufacturerAccess()* 0xF082 Output Shorted CC and ADC for Calibration

This command instructs the device to output the raw values for calibration purposes on *AlternateManufacturerAccess()* or *ManufacturerData()*. All values are updated every 250 ms and the format of each value is 2's complement, MSB first. This mode includes an internal short on the coulomb counter inputs for measuring offset.

Status	Condition	Action
Disable	<i>ManufacturingStatus()</i> [CAL] = 1 AND 0xF080 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [CAL] = 0 Stop output of ADC and CC data on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i>
Enable	0xF081 to <i>ManufacturerAccess()</i>	<i>ManufacturingStatus()</i> [CAL] = 1 Outputs the raw CC and AD values on <i>AlternateManufacturerAccess()</i> or <i>ManufacturerData()</i> in the format of ZZYyaaAAAbbBBccCCddDDeeEEffFF ggGGhhHHiilljJJkkKK: ZZ: rolling 8-bit counter, increments when values are refreshed YY: status, 1 when <i>ManufacturerAccess()</i> = 0xF081, 2 when <i>ManufacturerAccess()</i> = 0xF082 AAaa: Current (Coulomb Counter) BBaa: Cell Voltage 1 CCaa: Cell Voltage 2 DDaa: EEee: FFff:PACK Voltage GGgg: VC2 (BAT) Voltage HHhh: Cell Current 1 Iiii: Cell Current 2 JJjj: KKkk:

12.2 0x02/03 AtRate()

This read/write word function sets the value used in calculating *AtRateTimeToFull()* and *AtRateTimeToEmpty()*.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Default	Unit	Note
		SE	US	FA							
0x02/03	AtRate()	R/W			Word	I2	-32768	32767	0	mA	BatteryMode()[CAPM] = 0
										10 mW	BatteryMode()[CAPM] = 1

12.3 0x04/05 AtRateTimeToEmpty()

This word read function returns the remaining time to fully discharge the battery stack.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x04/05	AtRateTimeToEmpty()	R			Word	U2	0	65535	min	65535 indicates not being charged

12.4 0x06/07 Temperature()

This read word function returns the temperature in units 0.1°K.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x06/07	Temperature()	R			Word	U2	0	65535	0.1°K	

12.5 0x08/09 Voltage()

This read word function returns the sum of the measured cell voltages.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x08/09	Voltage()	R			Word	U2	0	65535	mV	

12.6 0x0A/0B BatteryStatus()

This read word function returns various battery status information.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Note
		SE	US	FA					
0x0A	BatteryStatus()	R	R	R	Word	H2			Bit 3:0: EC3,EC2,EC1,EC0 Error Code 0x0 = OK 0x1 = Busy 0x2 = Reserved Command 0x3 = Unsupported Command 0x4 = AccessDenied 0x5 = Overflow/Underflow 0x6 = BadSize 0x7 = UnknownError Bit 4: FD—Fully Discharged 0 = Battery ok 1 = Battery fully depleted Bit 5: FC—Fully Charged 0 = Battery not fully charged 01 = Battery fully charged Bit 6: DSG—Discharging 0 = Battery is charging. 1 = Battery is discharging. Bit 7: INIT—Initialization 0 = Inactive 1 = Active Bit 8: RTA—Remaining Time Alarm 0 = Inactive 1 = Active

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Note
		SE	US	FA					
0x0B	<i>BatteryStatus()</i>	R	R	R	Word	H2			Bit 9: RCA—Remaining Capacity Alarm 0 = Inactive 1 = Active Bit 10: Reserved Undefined Bit 11: TDA—Terminate Discharge Alarm 0 = Inactive 1 = Active Bit 12: OTA—Overtemperature Alarm 0 = Inactive 1 = Active Bit 13: Reserved Undefined Bit 14: TCA—Terminate Charge Alarm 0 = Inactive 1 = Active Bit 15: OCA—Overcharged Alarm 0 = Inactive 1 = Active

12.7 0x0C/0D Current()

This read word function returns the measured current from the coulomb counter.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x0C/0D	<i>Current()</i>	R			Word	I2	-32767	32768	mA	

12.8 0x10/11 RemainingCapacity()

This read word function returns the predicted remaining battery capacity.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x10/11	<i>RemainingCapacity()</i>	R	R	R	Word	U2	0	65535	mAh	<i>BatteryMode()[CAPM] = 0</i>
									10 mWh	<i>BatteryMode()[CAPM] = 1</i>

12.9 0x12/13 FullChargeCapacity()

This read word function returns the predicted battery capacity when full charged.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x12/13	<i>FullChargeCapacity()</i>	R	R	R	Word	U2	0	65535	mAh	<i>BatteryMode()[CAPM] = 0</i>
									10 mWh	<i>BatteryMode()[CAPM] = 1</i>

12.10 0x14/15 AverageCurrent()

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x14/15	<i>AverageCurrent()</i>	R			Word	I2	-32767	32768	mA	

12.11 0x16/17 *AverageTimeToEmpty()*

This read word function returns the predicted remaining battery capacity based on *AverageCurrent()*.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x16/17	<i>AverageTimeToEmpty()</i>	R	R	R	Word	U2	0	65535	min	65535 = Battery is not being discharged.

12.12 0x18/19 *AverageTimeToFull()*

This read word function returns the predicted time to full charge based on *AverageCurrent()*.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x18/19	<i>AverageTimeToFull()</i>	R	R	R	Word	U2	0	65535	min	65535 = Battery is not being discharged.

12.13 0x1A/1B *StandbyCurrent()*

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x1A/1B	<i>StandbyCurrent()</i>		R		Word	I2	-32767	32768	mA	

12.14 0x1C/1D *StandbyTimeToEmpty()*

This read word function returns the predicted remaining battery capacity based on the minimum load rate of discharge.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x1C/1D	<i>StandbyTimeToEmpty()</i>	R	R	R	Word	U2	0	65535	min	65535 = Battery is not being discharged.

12.15 0x1E/1F *MaxLoadCurrent()*

This read word function returns the maximum load conditions based on adaptive measurements using the values in initial the Max Load Current register and the measured Max Load Current.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x1E/1F	<i>MaxLoadCurrent()</i>		R		Word	I2	-32767	32768	mA	

12.16 0x20/21 *MaxLoadTimeToEmpty()*

This read word function returns the predicted remaining battery capacity based on the maximum load rate of discharge.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x20/21	<i>MaxLoadTimeToEmpty()</i>	R	R	R	Word	U2	0	65535	min	65535 = Battery is not being discharged.

12.17 0x24/25 AveragePower()

This read word function returns the average power during battery charging or discharging. It is negative due to discharge and positive due to charge. A zero value indicates the battery is NOT being discharged.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x24/25	AveragePower()		R		Word	I2	-32767	32768	mW	

12.18 0x28/29 InternalTemperature()

This read word function returns the internal die temperature in units 0.1°K.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x28/29	InternalTemperature()		R		Word	U2	0	65535	0.1°K	

12.19 0x2A/2B CycleCount()

This read word function returns the number of discharge cycles the battery has experienced.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x2A/2B	CycleCount()	R	R/W	R/W	Word	U2	0	65535	cycles	

12.20 0x2C/2D RelativeStateOfCharge()

This read word function returns the predicted remaining battery capacity as a percentage of FullChargeCapacity().

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x2C/2D	RelativeStateOfCharge()		R		Word	U1	0	100	%	

12.21 0x2E/2F State of Health (SoH)

This command returns the state of health (SoH) information of the battery in percentage of design capacity. It is a read-only command.

Byte 0: LSB of SoH in capacity
Byte 1: MSB of SoH in capacity

12.22 0x30/31 ChargingVoltage()

This read word function returns the desired charging voltage.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x30/31	ChargingVoltage()	R	R	R	Word	U2	0	65535	mV	65535 = request maximum voltage

12.23 0x32/33 ChargingCurrent()

This read word function returns the desired charging current.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Unit	Note
		SE	US	FA						
0x32/33	ChargingCurrent()	R	R	R	Word	U2	0	65535	mA	65535 = Request maximum current

12.24 0x34/35 BTP_SOC1_SET()

A read/write word command used to update the BTP set threshold that triggers the firing of a BTP interrupt and setting of the *BatteryStatus[BTP]* bit.

SBS Cmd	Name	Access			Format	Size in Bytes	Min	Max	Default	Unit	Note
		SE	US	FA							
0x34/35	BTP_SOC1_SET()	R/W	R/W	R/W	Signed Int	2	—	65535	150	mAh	

12.25 0x36/37 BTP_SOC1_CLEAR()

A read/write word command used to update the BTP clear threshold that triggers the firing of a BTP interrupt and clearing of the *BatteryStatus[BTP]* bit.

SBS Cmd	Name	Access			Format	Size in Bytes	Min	Max	Default	Unit	Note
		SE	US	FA							
0x36/37	BTP_SOC1_CLEAR()	R/W	R/W	R/W	Signed Int	2	—	65535	175	mAh	

12.26 0x3C/3D DesignCapacity()

This read word function returns the theoretical maximum pack capacity.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Default	Unit	Note
		SE	US	FA							
0x3C/3D	DesignCapacity()	R	R/W	R/W	Word	U2	0	65535	4400	mAh	BatteryMode()[CAPM] = 0
									6336	10 mWh	BatteryMode()[CAPM] = 1

12.27 0x3E/3F MAC Block Data Command

Writes to this command are interchangeable with *ManufacturerAccess()*. This command is provided to allow an easy way to verify the active MAC command while reading the *BlockData()* returned by the MAC. The host may simply read from *ManufacturerBlockAccess()* to *BlockDataLength()* with one block read. For a description of returned data values, see *ManufacturerBlockAccess()* version of same command in [Section 12.1](#).

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Default	Unit	Note
		SE	US	FA							
0x3E/3F	MACBlockDataCommand()	R	R	R	Word	—	—	—	—	—	

12.28 0x40/5F Block Data

This is the block data information from *ManufacturerBlockAccess()* Command.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Default	Unit	Note
		SE	US	FA							
0x40/5F	<i>BlockData ()</i>	R	R	R	Block	—	—	—	—	—	

12.29 0x60 Block Data Checksum

This is the check sum of the block data command.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Default	Unit	Note
		SE	US	FA							
0x60	<i>BlockDataCheckSum ()</i>	R	R	R	Byte	—	—	—	—	—	

The checksum is the 8 bit sum of the MSB and LSB of the command plus the (command length) bytes in the buffer. The final sum is the bitwise inversion of the result. Since the length is part of the checksum, the verification cannot take place till the length is written. The checksum and length must be written together as a word to be valid.

12.30 0x61 Block Data Length

This is the check sum of the block data command.

SBS Cmd	Name	Access			Protocol	Type	Min	Max	Default	Unit	Note
		SE	US	FA							
0x61	<i>BlockDataLen ()</i>	R	R	R	Byte	—	—	—	—	—	

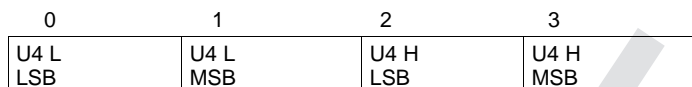
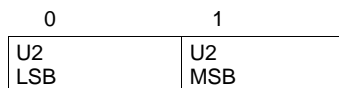
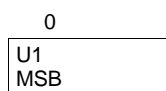
The length byte for all MAC commands will include the 2 byte command, the 1 byte checksum, the 1 byte length, and 1 to 32 bytes of data. This means the minimum length value is 5 for a valid block (no length or checksum is used for command only writes, so block of zero size is not necessary). For proper write command validation the checksum and length must be written in order (word access triggered).

Data Flash Values

13.1 Data Formats

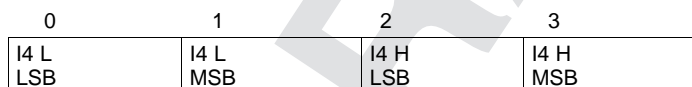
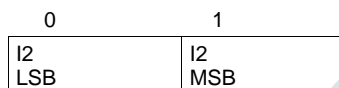
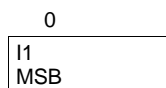
13.1.1 Unsigned Integer

Unsigned integer are stored without changes as 1-byte, 2-byte, or 4-byte values in Little Endian byte order.



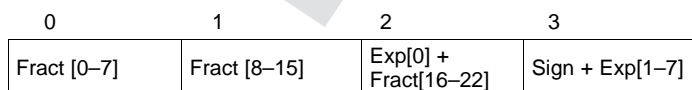
13.1.2 Integer

Integer values are stored in 2's-complement format in 1-byte, 2-byte, or 4-byte values in Little Endian byte order.



13.1.3 Floating Point

Floating point values are stored using the IEEE754 Single Precision 4-byte format in Little Endian byte order.



Where:

Exp: 8-bit exponent stored with an offset bias of 127. The values 00 and FF have special meaning.

Fract: 23-bit fraction. If the exponent is > 0, then the mantissa is 1.fract. If the exponent is zero, then the mantissa is 0.fract.

The floating point value depends on the special cases of the exponent:

- If the exponent is FF and the fraction is zero, this represents +/- infinity.
- If the exponent is FF and the fraction is non-zero this represents "not a number" (NaN).
- If the exponent is 00 then the value is a subnormal number represented by $(-1)^{\text{sign}} \times 2^{-126} \times 0.\text{fraction}$.
- Otherwise, the value is a normalized number represented by $(-1)^{\text{sign}} \times 2^{(\text{exponent} - 127)} \times 1.\text{fraction}$.

13.1.4 Hex

Bit register definitions are stored in unsigned integer format.

13.1.5 String

String values are stored with length byte first, followed by a number of data bytes defined with the length byte.

0	1	...	N
Length	Data0	...	DataN

13.2 Calibration

13.2.1 Voltage

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Voltage	Cell Gain	I2	-32768	32767	12101 ⁽¹⁾	—	VC[n]-VC[n-1] gain
Calibration	Voltage	PACK Gain	U2	0	65535	49669 ⁽¹⁾	—	PACK-VSS gain
Calibration	Voltage	VC2 (BAT) Gain	U2	0	65535	48936 ⁽¹⁾	—	VC2 (BAT)-VSS gain

⁽¹⁾ Setting this value to 0 causes the gauge to use the internal factory calibration default.

13.2.2 Current

Class	Subclass	Name	Type	Min	Max	Default	Description
Calibration	Current	CC Gain	F4	1.00E-001	4.00E+000	3.58422	Coulomb Counter Gain
Calibration	Current	Capacity Gain	F4	2.98E+004	1.19E+006	106903.5	Capacity Gain

13.2.3 Current Offset

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Current Offset	CC Offset	I2	-32768	32767	0	—	Coulomb Counter Offset
Calibration	Current Offset	Coulomb Counter Offset Samples	U2	0	65535	64	—	Coulomb Counter Offset Samples used for averaging
Calibration	Current Offset	Board Offset	I2	-32768	32767	0	—	PCB board offset

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Current Offset	CC Auto Config	H1	00	07	03	Hex	Bit 0: AUTO_CAL_EN: Auto CC offset calibration enable 0 = Disabled Auto CC calibration offset 1 = FW will perform auto CC calibration on entry into SLEEP mode. A min auto CC calibration interval is set to 10hr to prevent flash wear out. the result is saved to CCAuto Offset Bit 1: AUTO_NESTON: NEST Circuit ON 0 = HW NEST circuit is always on. individual cell current measurement may have error relative to <i>Current()</i> , but the <i>Current()</i> accuracy is not impacted 1 = When [OFFSET_TAKEN]= 1, FW automatically controls the HW NEST circuit for best current and cell current measurements. Bit 2: OFFSET_TAKEN: CC Auto offset is taken 0 = CC Auto Offset has not been measured 1 = CC Auto Offset has been measured Bit 3 to Bit 7: Reserved
Calibration	Current Offset	CC Auto Offset	I2	-10000	10000	0		CC offset collected via CC Auto Calibration. Used for cell current measurement and is different than CC Offset

13.2.4 Temperature

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Temperature	Internal Temp Offset	I1	-128	127	0	0.1 °C	Internal temperature sensor reading offset
Calibration	Temperature	External 1 Temp Offset	I1	-128	127	0	0.1 °C	TS1 temperature sensor reading offset

13.2.5 Internal Temp Model

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Internal Temp Model	Int Gain	I2	-32768	32768	-12143	—	Internal temperature gain
Calibration	Internal Temp Model	Int Base Offset	I2	-32768	32768	6232	—	Internal temperature base offset
Calibration	Internal Temp Model	Int Minimum AD	I2	-32768	32768	0	—	Minimum AD count used for calculation
Calibration	Internal Temp Model	Int Maximum Temp	I2	-32768	32768	6232	0.1 °K	Maximum Temperature boundary

13.2.6 Cell Temp Model

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Cell Temp Model	Coefficient a1	I2	-32768	32768	-11130	—	Cell Temperature calculation polynomial a1
Calibration	Cell Temp Model	Coefficient a2	I2	-32768	32768	19142	—	Cell Temperature calculation polynomial a2
Calibration	Cell Temp Model	Coefficient a3	I2	-32768	32768	-19262	—	Cell Temperature calculation polynomial a3

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Cell Temp Model	Coefficient a4	I2	-32768	32768	28203	—	Cell Temperature calculation polynomial a4
Calibration	Cell Temp Model	Coefficient a5	I2	-32768	32768	892	—	Cell Temperature calculation polynomial a5
Calibration	Cell Temp Model	Coefficient b1	I2	-32768	32768	328	—	Cell Temperature calculation polynomial b1
Calibration	Cell Temp Model	Coefficient b2	I2	-32768	32768	-605	—	Cell Temperature calculation polynomial b2
Calibration	Cell Temp Model	Coefficient b3	I2	-32768	32768	-2443	—	Cell Temperature calculation polynomial b3
Calibration	Cell Temp Model	Coefficient b4	I2	-32768	32768	4969	—	Cell Temperature calculation polynomial b4
Calibration	Cell Temp Model	Rc0	I2	-32768	32768	11703	Ω	Resistance at 25°C
Calibration	Cell Temp Model	Adc0	I2	-32768	32768	11703	—	ADC reading at 25°C
Calibration	Cell Temp Model	Rpad	I2	-32768	32768	0 ⁽¹⁾	Ω	Pad Resistance (0 to use factory calibration)
Calibration	Cell Temp Model	Rint	I2	-32768	32768	0 ⁽²⁾	Ω	Pull up resistor resistance (0 to use factory calibration)

⁽¹⁾ Setting this value to 0 causes the gauge to use the internal factory calibration default.

⁽²⁾ Setting this value to 0 causes the gauge to use the internal factory calibration default.

13.3 Current Deadband

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Current Deadband	Deadband	U1	0	255	3	mA	Pack-based Deadband to report 0 mA
Calibration	Current Deadband	Coulomb Counter Deadband	U1	0	255	9	116 nV	Coulomb counter deadband to report 0 charge (This setting should not be modified)

13.4 Settings

13.4.1 Configuration

Class	Subclass	Name	Type	Min	Max	Default	Description
Settings	Configuration	FET Options	H1	0x00	0xFF	0x20	Bit 0: Reserved Bit 1: Reserved Bit 2: OTFET—FET action in OVERTEMPERATURE mode 0 = No FET action for overtemperature condition (default) 1 = CHG and DSG FETs will be turned off for overtemperature conditions Bit 3: CHGSU—FET action in CHARGE SUSPEND mode 0 = FET active (default) 1 = Charging or Precharging disabled, FET off Bit 4: CHGIN—FET action in CHARGE INHIBIT mode 0 = FET active (default) 1 = Charging or Precharging disabled, FET off Bit 5: CHGFET—FET action on valid charge termination 0 = FET active (default) 1 = Charging or Precharging disabled, FET off Bit 6: SLEEPCHG—CHG FET enabled during sleep 0 = CHG FET off during sleep (default) 1 = CHG FET remains on during sleep Bit 7: Reserved

Class	Subclass	Name	Type	Min	Max	Default	Description
Settings	Configuration	Gauging Configuration	H1	0x00	0x0F	0x04	Bit 0: RSOCL— <i>RelativeStateOfCharge()</i> and <i>RemainingCapacity()</i> behavior at end of charge 0 = Actual value shown (default) 1 = Held at 99% until valid charge termination. On entering valid charge termination update to 100% Bit 1: RSOC_HOLD—Prevent RSOC from increasing during discharge 0 = RSOC not limited 1 = RSOC not allowed to increase during discharge Bit 2: LOCK0—Keep <i>RemainingCapacity()</i> and <i>RelativeStateOfCharge()</i> jumping back during relaxation after 0 was reached during discharge. 0 = Disabled (default) 1 = Enabled Bit 7:3: Reserved
Settings	Configuration	Configuration	H1	0x00	0x7F	0x21	Bit 0: BCAST—Enable alert and charging broadcast from device to host 0 = Disabled (default) 1 = Enabled Bit 1: CPE_PEC on charger broadcast 0 = Disabled (default) 1 = Enabled Bit 2: HPE—PEC on host communication 0 = Disabled (default) 1 = Enabled Bit 3: XL—Enable 400 kHz COM mode 0 = Normal bus speed (default) 1 = 400-kHz bus speed (slave mode) Bit 5,4: BLT1, BLT0—Bus low timeout 0,0 = no bus low timeout 0,1 = 1 s bus low timeout 1,0 = 2 s bus low timeout (default) 1,1 = 3 s bus low timeout Bit 7:6: Reserved
Settings	Configuration	Power Configuration	H1	0x00	0x01	0x00	Bit 0: AUTO_SHIP_EN—Automatically Shutdown for Shipment 0 = Disable auto shutdown feature (default) 1 = Enable auto shutdown after device is in SLEEP mode without communication for a set period of time
Settings	Configuration	I/O Configuration	H1	0x00	0x03	0x00	Bit 0: BTP_EN—Enable assertion of BTP pin 0 = Disable assertion of BTP pin when BTP is triggered (default) 1 = Enable assertion of BTP pin when BTP is triggered Bit 1: BTP_POL—Control polarity of BTP pin 0 = BTP pin is asserted low when BTP is triggered (default) 1 = BTP pin is asserted high when BTP is triggered Bit 7:2: Reserved
Settings	Configuration	SOC Flag Config A	H2	0x0000	0xFFFF	0x0C8C	Bit 0: TDSETV—Enable TD flag set by cell voltage threshold 0 = Disabled (default) 1 = Enabled Bit 1: TDCLEARV—Enable TD flag clear by cell voltage threshold 0 = Disabled (default) 1 = Enabled Bit 2: TDSETRSOC—Enable TD flag set by RSOC threshold 0 = Disabled 1 = Enabled (default) Bit 3: TDCLEARRSOC—Enable TD flag clear by RSOC threshold 0 = Disabled 1 = Enabled (default) Bit 4: TCSETV—Enable TC flag set by cell voltage threshold 0 = Disabled (default) 1 = Enabled Bit 5: TCCLEARV—Enable TC flag clear by cell voltage threshold 0 = Disabled (default) 1 = Enabled Bit 6: TCSETRSOC—Enable TC flag set by RSOC threshold 0 = Disabled (default) 1 = Enabled Bit 7: TCCLEARRSOC—Enable TC flag clear by RSOC threshold 0 = Disabled 1 = Enabled (default) Bit 8: Reserved Bit 9: Reserved Bit 10: FCSETVCT—Enable FC flag set by primary charge termination 0 = Disabled 1 = Enabled (default) Bit 11: TCSETVCT—Enable TC flag set by primary charge termination 0 = Disabled 1 = Enabled (default) Bit 15: 12: Reserved

Class	Subclass	Name	Type	Min	Max	Default	Description
Settings	Configuration	SOC Flag Config B	H1	0x0000	0x00FF	0x008C	Bit 0: FDSETV—Enable FD flag set by cell voltage threshold 0 = Disabled (default) 1 = Enabled Bit 1: FDCLEARV—Enable FD flag clear by cell voltage threshold 0 = Disabled (default) 1 = Enabled Bit 2: FDSETRSOC—Enable FD flag set by RSOC threshold 0 = Disabled 1 = Enabled (default) Bit 3: FDCLEARRSOC—Enable FD flag clear by RSOC threshold 0 = Disabled 1 = Enabled (default) Bit 4: FCSETV—Enable FC flag set by cell voltage threshold 0 = Disabled (default) 1 = Enabled Bit 5: FCCLEARV—Enable FC flag clear by cell voltage threshold 0 = Disabled (default) 1 = Enabled Bit 6: FCSETRSOC—Enable FC flag set by RSOC threshold 0 = Disabled (default) 1 = Enabled Bit 7: FCCLEARRSOC—Enable FC flag clear by RSOC threshold 0 = Disabled 1 = Enabled (default)
Settings	Configuration	Charging Configuration	H1	0x00	0x3F	0x00	Bit 0: CRATE—ChargeCurrent rate 0 = No adjustment to <i>ChargingCurrent()</i> (default) 1 = <i>ChargingCurrent()</i> adjusted based on <i>FullChargeCapacity() / DesignCapacity()</i> Bit 7:1: Reserved
Settings	Configuration	Temperature Enable	H1	0x00	0x03	0x03	Bit 0: internal TS— Enable Internal TS 0 = Disable internal TS (default) 1 = Enable internal TS Bit 1: TS1—Enable TS1 0 = Disable TS1 1 = Enable TS1 (default) Bit 7:2: Reserved
Settings	Configuration	DA Configuration	H1	0x00	0xFF	0x11	Bit 0: CC0—Cell Count 0 = 1 cell 1 = 2 cell Bit 1: Reserevd Bit 2: Reserevd Bit 3: IN_SYSTEM_SLEEP—In-system SLEEP mode 0 = Disable (default) 1 = Enable Bit 4: SLEEP—SLEEP Mode 0 = Disable SLEEP mode 1 = Enable SLEEP mode (default) Bit 5: Reserved Bit 6: CTEMP—Cell Temperature protection source 0 = MAX (default) 1 = Average Bit 7:Reserved

Class	Subclass	Name	Type	Min	Max	Default	Description
Settings	Configuration	IT Gauging Configuration	H2	0x0000	0xFFFF	0xD4DE	Bit 0: CCT—Cycle count threshold 0 = use CC % of <i>DesignCapacity()</i> (default) 1 = use CC % of <i>FullChargeCapacity()</i> Bit 1: CSYNC—Sync <i>RemainingCapacity()</i> with <i>FullChargeCapacity()</i> at valid charge termination 0 = Not synchronized 1 = Synchronized (default) Bit 2: RFACTSTEP—Reserve capacity calculation method 0 = Light load 1 = Use Load Select (default) Bit 3: OCVFR—Open Circuit Voltage Flat Region. 0 = Disabled 1 = Enabled (default) Bit 4: DOD0EW—DOD0 error weighting 0 = Disabled 1 = Enabled (enable) Bit 5: Reserved 0 = Disabled 1 = Enabled (enable) Bit 6: RSOC_CONV Bit 7: FAST_QMax_LRN Bit 8: Reserved Bit 9: CELL_TERM Bit 10: FF_NEAR_EDV Bit 11: RELAX_JUMP_OK- Allows for RSOC jump during RELAX Mode 0 = Enabled 1 = Disabled (default) Bit 12: SMOOTH Bit 13: TDELTA—Turbo Mode Delta Voltage 0 = Enables the use of Delta Voltage learned as the maximal difference between instantaneous and average voltage 1 = Enables calculating Delta Voltage that corresponds to the power spike defined in Min Turbo Power Bit 14: RELAX_SMOOTH_OK - Smooth RSOC during RELAX Mode 0 = Enabled 1 = Disabled 1 = Enabled (default) Bit 15: VOLT_CONSIST - Voltage Consistency Check 0 = Disabled 1 = Enabled (default)
Settings	Configuration	Balancing Configuration	H1	0x00	0xFF	0x01	Bit 0: CB—Cell balancing 0 = Cell balancing disabled 1 = Cell balancing enabled (default) Bit 1: CBM—Cell balancing method 0 = Internal cell balancing (default) 1 = External cell balancing Bit 7:2: Reserved

13.4.2 Battery Trip Point (BTP)

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Settings	BTP	Init Discharge Set	I2	0	32767	150	mA	Initial value for <i>BTPDischargeSet()</i>
Settings	BTP	Init Charge Set	I2	0	32767	175	mA	Initial value for <i>BTPChargeSet()</i>

13.4.3 Charger

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Settings	Charger	Device Address	H1	0	FF	D4	Hex	Sets the address of Save device for Broadcast Mode
Settings	Charger	Voltage Register	H1	0	FF	0C	Hex	Broadcast Mode: Sets the two byte Address and data information to transmit to slave device for charger output Voltage setting
Settings	Charger	Current Register	H1	0	FF	0A	Hex	Broadcast Mode: Sets the two byte Address and data information to transmit to slave device for charger output Current setting
Settings	Charger	Broadcast Pacing	U1	0	255	15	sec	Broadcast Mode: Period for broadcast

13.4.4 Protection

Class	Subclass	Name	Type	Min	Max	Default	Description
Settings	Protection	Protection Configuration	H1	0x00	0xFF	0x00	Bit 0:Reserved Bit 1: CUV_RECOV_CHG—Require charge to recover <i>SafetyStatus() [CUV]</i> 0 = Disabled 1 = Enabled (default) Bit 7:2: Reserved
Settings	Protection	Enabled Protections A	H1	0x00	0xFF	0x57	Bit 0: CUV—Cell Undervoltage 0 = Disabled 1 = Enabled (default) Bit 1: COV—Cell Overvoltage 0 = Disabled 1 = Enabled (default) Bit 2: OCC1—Overcurrent in Charge 1st Tier 0 = Disabled 1 = Enabled (default) Bit 3: Reserved Bit 4: OCD1—Overcurrent in Discharge 1st Tier 0 = Disabled 1 = Enabled (default) Bit 5: Reserved Bit 6: AOLD—Overload in Discharge 0 = Disabled 1 = Enabled (default) Bit 7: reserved
Settings	Protection	Enabled Protections B	H1	0x00	0xFF	0x35	Bit 0: ASCC—Short circuit in charge 0 = Disabled 1 = Enabled (default) Bit 1: Reserved Bit 2: ASCD—Short circuit in discharge 0 = Disabled 1 = Enabled (default) Bit 3: Reserved Bit 4: OTC—Overtemperature in charge 0 = Disabled 1 = Enabled (default) Bit 5: OTD—Overtemperature in discharge 0 = Disabled 1 = Enabled (default) Bit 7:6: Reserved
Settings	Protection	Enabled Protections C	H1	0x00	0xFF	0x3C	Bit 0: Reserved Bit 1: Reserved Bit 2: PTO—Pre-charging timeout 0 = Disabled 1 = Enabled (default) Bit 3: PTOS—Pre-charging timeout suspend 0 = Disabled 1 = Enabled (default) Bit 4: CTO—Charging timeout 0 = Disabled 1 = Enabled (default) Bit 5: CTOS—Charging timeout suspend 0 = Disabled 1 = Enabled (default) Bit 7:6: Reserved
Settings	Protection	Enabled Protections D	H1	0x00	0xFF	0x0C	Bit 0: Reserved Bit 1: Reserved Bit 2: UTC— Under temperature while charging 0 = Disabled 1 = Enabled (default) Bit 3: UTD— Under temperature while not charging 0 = Disabled 1 = Enabled (default) Bit 7:4: Reserved

13.4.5 Permanent Failure

Class	Subclass	Name	Type	Min	Max	Default	Description
Settings	Permanent Failure	Enabled PF A	H1	0x00	0xFF	0x00	Bit 0: Reserved Bit 1: SOV—Safety Cell overvoltage 0 = Disabled 1 = Enabled (default) Bit 7: 2: Reserved

13.4.6 AFE

Class	Subclass	Name	Type	Min	Max	Default	Description
Configuration	AFE	AFE Protection Control	H1	0x00	0xFF	0x00	Bit 0: RSNS—AOLD, ASCC, ASCD1, ASCD2 Thresholds 0 = 0.5 × AFE Protection Thresholds (default) 1 = Normal AFE Protection Thresholds Bit 1: SCDDx2—Double SCD Delay Times 0 = Normal SCD delay times (default) 1 = 2 × SCD delay times Bits 2–3: Reserved Bit 4–7: RSTRIM—"Unsupport" function. Should leave the default setting 0x7. Changing this setting may cause an error to the AFE current protection accuracy.
Configuration	AFE	ZVCHG Exit Threshold	I2	0	8000	2200	<i>Voltage()</i> threshold in mV when the gauge will exit ZVCHG mode when CFET is used for precharging

13.4.7 Manufacturing

Class	Subclass	Name	Type	Min	Max	Default	Description
Settings	Manufacturing	Manufacturing Status	H2	0x0000	0xFFFF	0x0000	Bit 0: Reserved Bit 1: Reserved Bit 2: Reserved Bit 3: GAUGE_EN—Gauging 0 = Disabled (default) 1 = Enabled Bit 4: FET_EN—FET action 0 = Disabled (default) 1 = Enabled Bit 5: LF_EN—Lifetime data collection 0 = Disabled (default) 1 = Enabled Bit 15.6: Reserved

13.5 Advanced Charging Algorithm

13.5.1 Temperature Ranges

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	Temperature Ranges	T1	I1	-128	127	0	°C	T1 low temperature range lower limit
Advanced Charging Algorithms	Temperature Ranges	T2	I1	-128	127	12	°C	T2 low temperature range to standard temperature range
Advanced Charging Algorithms	Temperature Ranges	T5	I1	-128	127	20	°C	T5 recommended temperature range lower limit
Advanced Charging Algorithms	Temperature Ranges	T6	I1	-128	127	25	°C	T6 recommended temperature range upper limit
Advanced Charging Algorithms	Temperature Ranges	T3	I1	-128	127	30	°C	T3 standard temperature range to high temperature range
Advanced Charging Algorithms	Temperature Ranges	T4	I1	-128	127	55	°C	T4 high temperature range upper limit
Advanced Charging Algorithms	Temperature Ranges	Hysteresis	I1	-128	127	1	°C	Temperature Hysteresis, applied when temperature is decreasing

13.5.2 Low Temp Charging

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	Low Temp Charging	Voltage	I2	0	32767	4000	mV	Low temperature range <i>ChargingVoltage()</i>
Advanced Charging Algorithms	Low Temp Charging	Current Low	I2	0	32767	132	mA	Low temperature range low voltage range <i>ChargingCurrent()</i>
Advanced Charging Algorithms	Low Temp Charging	Current Med	I2	0	32767	352	mA	Low temperature range medium voltage range <i>ChargingCurrent()</i>
Advanced Charging Algorithms	Low Temp Charging	Current High	I2	0	32767	264	mA	Low temperature range high voltage range <i>ChargingCurrent()</i>

13.5.3 Standard Temp Charging

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	Standard Temp Charging	Voltage	I2	0	32767	4200	mV	Standard temperature range <i>ChargingVoltage()</i>
Advanced Charging Algorithms	Standard Temp Charging	Current Low	I2	0	32767	1980	mA	Standard temperature range low voltage range <i>ChargingCurrent()</i>
Advanced Charging Algorithms	Standard Temp Charging	Current Med	I2	0	32767	4004	mA	Standard temperature range medium voltage range <i>ChargingCurrent()</i>
Advanced Charging Algorithms	Standard Temp Charging	Current High	I2	0	32767	2992	mA	Standard temperature range high voltage range <i>ChargingCurrent()</i>

13.5.4 High Temp Charging

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	High Temp Charging	Voltage	I2	0	32767	4000	mV	High temperature range <i>ChargingVoltage()</i>
Advanced Charging Algorithms	High Temp Charging	Current Low	I2	0	32767	1012	mA	High temperature range low voltage range <i>ChargingCurrent()</i>
Advanced Charging Algorithms	High Temp Charging	Current Med	I2	0	32767	1980	mA	High temperature range medium voltage range <i>ChargingCurrent()</i>
Advanced Charging Algorithms	High Temp Charging	Current High	I2	0	32767	1496	mA	High temperature range high voltage range <i>ChargingCurrent()</i>

13.5.5 Rec Temp Charging

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	Rec Temp Charging	Voltage	I2	0	32767	4100	mV	Recommended temperature range <i>ChargingVoltage()</i>
Advanced Charging Algorithms	Rec Temp Charging	Current Low	I2	0	32767	2508	mA	Recommended temperature range low voltage range <i>ChargingCurrent()</i>
Advanced Charging Algorithms	Rec Temp Charging	Current Med	I2	0	32767	4488	mA	Recommended temperature range medium voltage range <i>ChargingCurrent()</i>
Advanced Charging Algorithms	Rec Temp Charging	Current High	I2	0	32767	3520	mA	Recommended temperature range high voltage range <i>ChargingCurrent()</i>

13.5.6 Pre-Charging

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	PCHG	Current	I2	0	32767	88	mA	Precharge <i>ChargingCurrent()</i>

13.5.7 Maintenance Charging

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	MCHG	Current	I2	0	32767	44	mA	Maintenance <i>ChargingCurrent()</i>

13.5.8 Voltage Range

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	Voltage Range	Threshold for entering precharge state	I2	0	32767	2500	mV	Minimum Cell voltage to enter PRECHARGE Mode
Advanced Charging Algorithms	Voltage Range	Charging Voltage Low	I2	0	32767	2900	mV	Precharge Voltage range to Charging Voltage Low range
Advanced Charging Algorithms	Voltage Range	Charging Voltage Med	I2	0	32767	3600	mV	Charging Voltage Low range to Charging Voltage Med range
Advanced Charging Algorithms	Voltage Range	Charging Voltage High	I2	0	32767	4000	mV	Charging Voltage Med to Charging Voltage High range
Advanced Charging Algorithms	Voltage Range	Charging Voltage Hysteresis	U1	0	255	0	mV	Charging Voltage Hysteresis applied when voltage is decreasing

13.5.9 Termination Config

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	Termination Config	Charge Term Taper Current	I2	0	32767	250	mA	Valid Charge Termination taper current qualifier threshold
Advanced Charging Algorithms	Termination Config	Charge Term Voltage	I2	0	32767	75	mV	Valid Charge Termination delta voltage qualifier, max cell based

13.5.10 Cell Balancing Config

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Advanced Charging Algorithms	Cell Balancing Config	Balance Time per mAh cell 1	U2	0	65535	367	s/mAh	Required balance time per mAh. For information on how to calculate balancing time, see Section 7.1 .
Advanced Charging Algorithms	Cell Balancing Config	Balance Time per mAh cell 2	U2	0	65535	514	s/mAh	Required balance time per mAh. For information on how to calculate balancing time, see Section 7.1 .

13.6 Power

13.6.1 Power

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Power	Power	Valid Update Voltage	I2	0	32767	2800	mV	Min stack voltage threshold for Flash update

13.6.2 Shutdown

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Power	Shutdown	Shutdown Voltage	I2	0	32767	2300	mV	Cell based shutdown voltage trip threshold
Power	Shutdown	Shutdown Time	U2	0	255	10	s	Cell based shutdown voltage trip delay
Power	Shutdown	Charger Present Threshold	I2	0	32767	3000	mV	Pack pin charger present detect threshold

13.6.3 Sleep

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Power	Sleep	Sleep Current	I2	0	32767	10	mA	Current() threshold to enter SLEEP mode
Power	Sleep	Voltage Time	U1	0	255	5	s	Voltage sampling period in SLEEP mode
Power	Sleep	Current Time	U1	0	255	20	s	Current sampling period in SLEEP mode
Power	Sleep	Wake Comparator	H1	0x00	0xFF	0x00	—	Wake Comparator Configuration Setting Bits 7–4: Reserved Bits 3–2: Wk1, WK0 - Wake Comparator Threshold 0,0 = ±0.625 mV 0,1 = ±1.25 mV 1,0 = ±2.5 mV 1,1 = ±5 mV Bits 1–0: Reserved

13.6.4 Ship

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Power	Ship	FET OFF time	U1	0	127	10	s	Delay time to turn OFF FETs prior to entering SHUTDOWN mode. This setting should not be longer than Ship Delay setting
Power	Ship	Delay	U1	0	254	20	s	Delay time to enter SHUTDOWN mode after FETs are turned OFF
Power	Ship	Auto Ship Time	U2	0	65535	1440	min	The device will automatically enter SHUTDOWN mode after staying in SLEEP mode without communicatin for this amount of time when Power Config[AUTO_SHIP_EN] = 1

13.7 Gas Gauging

13.7.1 Standby

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	Standby	Standby Current	I2	-32768	0	-10	mA	

13.7.2 Max Load

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	Max Load	Max Load Current	I2	-32768	32767	-500	mA	
Gas Gauging	Max Load	Max Load RSOC	U1	0	100	50	%	

13.7.3 Current Thresholds

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	Current Thresholds	Dsg Current Threshold	I2	-32768	32767	100	mA	DISCHARGE mode <i>Current()</i> threshold
Gas Gauging	Current Thresholds	Chg Current Threshold	I2	-32768	32767	50	mA	CHARGE mode <i>Current()</i> threshold
Gas Gauging	Current Thresholds	Quit Current	I2	0	32767	10	mA	$ Current()$ threshold to enter rest mode
Gas Gauging	Current Thresholds	Dsg Relax Time	U1	0	255	1	mA	Discharge to relax timeout
Gas Gauging	Current Thresholds	Chg Relax Time	U1	0	255	60	mA	Charge to relax timeout

13.7.4 Design

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	Design	Design Capacity mAh	I2	0	32767	4400	mAh	Design Capacity in mAh
Gas Gauging	Design	Design Capacity cWh	I2	0	32767	6336	cWh	Design Capacity in cWh
Gas Gauging	Design	Design Voltage	I2	0	32767	7200	mV	Design Voltage

13.7.5 Cycle

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	Cycle	Cycle Count Percentage	U1	0	100	90	%	Cycle Count Percentage

13.7.6 FD

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	FD	Set Voltage Threshold	I2	0	5000	3000	mV	<i>BatteryStatus()</i> [FD] cell voltage set threshold
Gas Gauging	FD	Clear Voltage Threshold	I2	0	5000	3100	mV	<i>BatteryStatus()</i> [FD] cell voltage clear threshold
Gas Gauging	FD	Set RSOC % Threshold	U1	0	100	0	%	<i>BatteryStatus()</i> [FD] <i>RemainingStateOfCharge()</i> set threshold
Gas Gauging	FD	Clear RSOC % Threshold	U1	0	100	5	%	<i>BatteryStatus()</i> [FD] <i>RemainingStateOfCharge()</i> clear threshold

13.7.7 FC

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	FC	Set Voltage Threshold	I2	0	5000	4200	mV	<i>BatteryStatus()[FC]</i> cell voltage set threshold
Gas Gauging	FC	Clear Voltage Threshold	I2	0	5000	4100	mV	<i>BatteryStatus()[FC]</i> cell voltage clear threshold
Gas Gauging	FC	Set RSOC % Threshold	U1	0	100	100	%	<i>BatteryStatus()[FC]RemainingStateOfCharge()</i> set threshold
Gas Gauging	FC	Clear RSOC % Threshold	U1	0	100	95	%	<i>BatteryStatus()[FC]RemainingStateOfCharge()</i> clear threshold

13.7.8 TDA

Per the *Smart Battery Data Specification v1.1*, TDA is only active while discharging.

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	TD	Set Voltage Threshold	I2	0	5000	3200	mV	<i>GaugingStatus[TD]</i> cell voltage set threshold
Gas Gauging	TD	Clear Voltage Threshold	I2	0	5000	3300	mV	<i>GaugingStatus[TD]</i> cell voltage clear threshold
Gas Gauging	TD	Set RSOC % Threshold	U1	0	100	6	%	<i>GaugingStatus[TD]RemainingStateOfCharge()</i> set threshold
Gas Gauging	TD	Clear RSOC % Threshold	U1	0	100	8	%	<i>GaugingStatus[TD]RemainingStateOfCharge()</i> clear threshold

13.7.9 TCA

Per the *Smart Battery Data Specification v1.1*, TCA is only active while charging.

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	TC	Set Voltage Threshold	I2	0	5000	4200	mV	<i>GaugingStatus[TC]</i> cell voltage set threshold
Gas Gauging	TC	Clear Voltage Threshold	I2	0	5000	4100	mV	<i>GaugingStatus[TC]</i> cell voltage clear threshold
Gas Gauging	TC	Set RSOC % Threshold	U1	0	100	100	%	<i>GaugingStatus[TC]RemainingStateOfCharge()</i> set threshold
Gas Gauging	TC	Clear RSOC % Threshold	U1	0	100	95	%	<i>GaugingStatus[TC]RemainingStateOfCharge()</i> clear threshold

13.7.10 State

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	State	QMax Cell 0	I2	0	32767	4400	mAh	QMax Cell 0
Gas Gauging	State	QMax Cell 1	I2	0	32767	4400	mAh	QMax Cell 1
Gas Gauging	State	QMax Pack	I2	0	32767	4400	mAh	QMax of the whole stack
Gas Gauging	State	QMax Cycle count	U2	0	65535	0		The <i>CycleCount()</i> when Qmax updated

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	State	Update Status	H1	0x00	0xFF	0		Bit 1:0: Update1, Update0 Update Status 0,0 = Impedance Track gauging and lifetime updating is disabled. 0,1 = QMax updated 1,0 = QMax and Ra table have been updated Bit 2: Enable—Impedance Track gauging and lifetime updating enable 0 = Disabled 1 = Enabled Bit 3: QMax update in the field 0 = Not updated 1 = Updated Bit 7:4: Reserved
Gas Gauging	State	Cell 0 Chg Voltage at EoC	I2	0	32767	4200	mV	Cell 0 voltage value at end of charge
Gas Gauging	State	Cell 1 Chg Voltage at EoC	I2	0	32767	4200	mV	Cell 1 voltage value at end of charge
Gas Gauging	State	Current at EoC	I2	-32768	32767	250	mA	Current at end of charge
Gas Gauging	State	Avg I Last Run	I2	-32768	32767	-2000	mA	Average current last discharge cycle
Gas Gauging	State	Avg P Last Run	I2	-32768	32767	-3022	10 mW	Average power last discharge cycle
Gas Gauging	State	Delta Voltage	I2	-32768	32767	0	mV	<i>Voltage()</i> delta between normal and short load spikes to optimize run time calculation
Gas Gauging	State	Temp k	I2	0	32767	100	0.1C/2560 mW	Initial Thermal model Temperature factor
Gas Gauging	State	Temp a	I2	0	32767	1000	-	Initial Thermal model Temperature
Gas Gauging	State	Max I Last Run	I2	-32768	32767	-2000	mA	Max current last discharge cycle
Gas Gauging	State	Max P Last Run	I2	-32768	32767	-3022	10 mW	Max power last discharge cycle
Gas Gauging	State	Cycle count	U2	0	65535	0	Cycle count	Value reported by <i>CycleCount()</i> . Updated by the gauge automatically based on Cycle Count Percentage

13.7.11 IT Config

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	IT Cfg	Pack Resistance	I2	0	32767	30	mΩ	
Gas Gauging	IT Cfg	System Resistance	I2	0	32767	0	mΩ	
Gas Gauging	IT Cfg	Ra Filter	U2	0	999	500	0.1%	Filter value used in Ra Updates, specifies what percentage or Ra update is from new value (100%—setting) vs. old value (setting). The recommended setting is 80% if RSOC_CONV feature is enabled. Otherwise, the setting should be 50% as default.
Gas Gauging	IT Cfg	Ra Max Delta	U1	0	255	15	% of Design Resistance	Maximum value of allowed Ra change
Gas Gauging	IT Cfg	Reference Grid	UI	0	15	4		Reference Grid point used by Design Resistance. The default setting should be used if RSOC_CONV feature is enabled. Otherwise, grid point 11 should be used to ensure resistance updates fast enough at the grid where discharge termination occurs.

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	IT Cfg	Resistance Parameter Filter	U2	1	65534	65124	—	This is one of the filters used for resistance update. Reducing this filter setting can improve low temperature performance at high rates. The default setting is 41-s time constant. It is recommended to keep this filter within the range of 4 s (i.e., DF setting = 61680) up to the default 41 s (i.e., DF setting = 65142). Examining the Term Voltage Delta setting and Fast Scale Start SOC should be done prior to twisting this parameter when trying to improve the RSOC performance. The following is the formula to convert the DF setting into actual filter time constant: Filter time constant = $[0.25/(1 - (DF_Value / 65536))] - 0.25$.
Gas Gauging	IT Cfg	Near EDV Ra Param Filter	U2	1	65535	59220	-	Ra filter used in the fast scaling region if $[FF_NEAR_EDV] = 1$. Default value should be used
Gas Gauging	IT Cfg	Qmax Delta	U1	3	100	5	%	Maximum allowed Qmax change from its previous value. The Qmax change will be capped by this setting if the delta from the previous Qmax is larger than Qmax Delta . Qmax Delta is a percentage of Design Capacity
Gas Gauging	IT Cfg	Qmax Upper Bound	U1	100	255	130	%	Maximum Qmax value over the lifetime of the pack. If the updated Qmax value is larger than this setting, the updated Qmax will be capped to Qmax Upper Bound . Qmax Upper Bound is a percentage of Design Capacity
Gas Gauging	IT Cfg	Term Voltage	I2	0	32767	9000	mV	Min stack voltage to be used for capacity calculation
Gas Gauging	IT Cfg	Term Voltage Delta	I2	0	32767	300	mV	Controls when the RSOC_CONV feature becomes active. The recommended setting is 3.3 –Term Voltage/Number Cells. The default setting is 300 mV, which is assuming a typical 3V termination voltage per cell. If a different termination voltage is used, this parameter should be adjusted accordingly.
Gas Gauging	IT Cfg	Term Min Cell Voltage	I2	0	32767	2800	mV	Minimum cell termination voltage when used, if $[CELL_TERM] = 1$. This is intended to allow the IT algorithm to reach 0% before CUV is triggered; therefore, this value should be set at or above CUV:Threshold
Gas Gauging	IT Cfg	Voltage Consistency Delta	I2	0	32767	300	mV	Use in voltage consistency check. See $[VOLTAGE_CONSIST]$ for details
Gas Gauging	IT Cfg	Fast Scale Start SOC	U1	0	100	10	%	Control start of convergence when $[RSOC_CONV] = 1$ based on RSOC %. Raising this setting can improve RSOC drop at the end of discharge. However the RSOC % chosen for this setting must keep after the sharp drop of the discharge curve (the knee of the discharge curve)
Gas Gauging	IT Cfg	Load Select	U1	0	255	7		Defines Load compensation mode used by gauging algorithm
Gas Gauging	IT Cfg	Load Mode	U1	0	255	0		Defines unit used by gauging algorithm: 0 = Constant Current 1 = Constant Power
Gas Gauging	IT Cfg	Design Resistance						Averaged cell resistance at Reference Grid point. Automatically updated when Update Status is set to 0x6 by the gauge. To automatically update again set Update Status to 0x4 or manually set when Update Status is set to 0x6.
Gas Gauging	IT Cfg	User-Rate-mA	I2	-32768	32768	0	mA	Discharge rate used for capacity calculation selected by Load Select
Gas Gauging	IT Cfg	User-Rate-mW	I2	-32768	32768	0	10 mW	Discharge rate used for capacity calculation selected by Load Select
Gas Gauging	IT Cfg	Reserve Cap-mAh	I2	0	9000	0	mAh	Capacity reserved available when gauging algorithm reports 0% RemainingStateOfCharge()
Gas Gauging	IT Cfg	Reserve Cap-cWh	I2	0	32000	0	cWh	Capacity reserved available when gauging algorithm reports 0% RemainingStateOfCharge()

13.7.12 Smoothing

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	Smoothing	Smooth Relax Time	I2	1	32767	1000	s	If <code>[RELAX_SMOOTH_OK] = 1</code> the delta Remaining Capacity and Full Charge Capacity is smoothed over this set period of time. It is recommended to use the default setting

13.7.13 Condition Flag

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	Condition Flag	Max Error Limit	U1	1	100	100	%	Max Error Limit Percentage

13.7.14 SoH

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Gas Gauging	SoH	SoH Load Rate	U1	1	255	5	0.1C-rate	Current rate used in SoH simulation

13.8 System Data

13.8.1 Manufacturer Data

Class	Subclass	Name	Type	Min	Max	Unit	Description
System Data	Manufacturer Data	ManufacturerInfo	S32+1	—	—	—	<code>ManufacturerInfo()</code> value

13.8.2 Integrity

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
System Data	Integrity	Static DF Signature	H2	0	7FFF	0	hex	Statis data flash signature. Use MAC <code>StaticDFSignature()</code> (with MSB set to 0) to initializ this value
System Data	Integrity	Static Chem DF Signature	H2	0	7FFF	6C98	hex	Statis Chemistry data signature. Use MAC <code>StaticChemDFSignature()</code> (with MSB set to 0) to initializ this value
System Data	Integrity	All DF Signature	H2	0	7FFF	0	hex	Statis data flash signature. Use MAC <code>AllDFSignature()</code> (with MSB set to 0) to initializ this value

13.9 Configuration

13.9.1 Data

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Configuration	Data	Manufacturer Date	U2	0	65535	01/01/80		<i>ManufacturerDate()</i> value in the following format:Day + Month*32 + (Year-1980) * 512
Configuration	Data	Serial Number	H2	0x0000	0xFFFF	0x0001		<i>SerialNumber()</i> value
Configuration	Data	Manufacturer Name	S20+1	—	—	Texas Instruments	ASCII	<i>ManufacturerName()</i> value
Configuration	Data	Device Name	S20+1	—	—	bq28z610	ASCII	<i>DeviceName()</i> value
Configuration	Data	Device Chemistry	S4+1	—	—	LION	ASCII	<i>DeviceChemistry()</i> value

13.10 Lifetimes

13.10.1 Voltage

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Lifetimes	Voltage	Max Voltage Cell 0	I2	0	32767	0	mV	Maximum reported cell voltage 0
Lifetimes	Voltage	Max Voltage Cell 1	I2	0	32767	0	mV	Maximum reported cell voltage 1

13.10.2 Current

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Lifetimes	Current	Max Chg Current	I2	0	32768	0	200 mA	Maximum reported <i>Current()</i> in charge direction
Lifetimes	Current	Max Dsg Current	I2	-32768	0	0	200 mA	Maximum reported <i>Current()</i> in discharge direction

13.10.3 Temperature

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Lifetimes	Temperature	Max Temp Cell	I1	-128	127	-128	°C	Maximum reported cell temperature
Lifetimes	Temperature	Min Temp Cell	I1	-128	127	127	°C	Minimum reported cell temperature

13.11 Protections

13.11.1 CUV—Cell Undervoltage

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	CUV	Threshold	I2	0	32767	2500	mV	Cell undervoltage trip threshold
Protections	CUV	Delay	U1	0	255	2	s	Cell undervoltage trip delay
Protections	CUV	Recovery	I2	0	32767	3000	mV	Cell undervoltage recovery threshold

13.11.2 COV—Cell Overvoltage

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	COV	Threshold Low Temp	I2	0	32767	4300	mV	Cell overvoltage low temperature range trip threshold
Protections	COV	Threshold Standard Temp	I2	0	32767	4300	mV	Cell overvoltage standard temperature range trip threshold

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	COV	Threshold High Temp	I2	0	32767	4300	mV	Cell overvoltage high temperature range trip threshold
Protections	COV	Threshold Rec Temp	I2	0	32767	4300	mV	Cell overvoltage recommended temperature range trip threshold
Protections	COV	Delay	U1	0	255	0	s	Cell overvoltage trip delay
Protections	COV	Recovery Low Temp	I2	0	32767	3900	mV	Cell overvoltage low temperature range recovery threshold
Protections	COV	Recovery Standard Temp	I2	0	32767	3900	mV	Cell overvoltage standard temperature recovery range threshold
Protections	COV	Recovery High Temp	I2	0	32767	3900	mV	Cell overvoltage high temperature range recovery threshold
Protections	COV	Recovery Rec Temp	I2	0	32767	3900	mV	Cell overvoltage recommended temperature range recovery threshold

13.11.3 OCC—Overcurrent In Charge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	OCC	Threshold	I2	-32768	32767	6000	mA	Overcurrent in Charge trip threshold
Protections	OCC	Delay	U1	0	255	0	s	Overcurrent in Charge trip delay
Protections	OCC	Recovery Threshold	I2	-32768	32767	200	mA	Overcurrent in Charge recovery threshold
Protections	OCC	Recovery Delay	U1	0	255	5	s	Overcurrent in Charge recovery delay

13.11.4 OCD—Overcurrent In Discharge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	OCD	Threshold	I2	-32768	32767	-6000	mA	Overcurrent in Discharge trip threshold
Protections	OCD	Delay	U1	0	255	6	s	Overcurrent in Discharge trip delay
Protections	OCD	Recovery	I2	-32768	32767	50	mA	Overcurrent in Discharge recovery threshold
Protections	OCD	Recovery Delay	U1	0	255	5	s	Overcurrent in Discharge recovery delay

13.11.5 AOLD—AFE Over Load In Discharge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	AOLD	Threshold	H1	0x00	0xFF	0xF4	hex	AOLD: Threshold Setting, Bits 7–4: OLDD: AOLD delay time Setting, Bits 3–0: OLDV: AOLD threshold
Protections	AOLD	Recovery	U1	0	255	5	s	Overload recovery time

13.11.6 ASCC—AFE Short Circuit in Charge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	ASCC	Threshold	H1	0x00	0xFF	0x77	hex	ASCC: Threshold Setting, Bits 7–4: SCCD: ASCC delay time Setting, Bit 3: Reserved Setting, Bits 2–0: OLDV: AOLD threshold Setting,
Protections	ASCC	Recovery	U1	0	255	5	s	Overload recovery time

13.11.7 ASCD—AFE Short Circuit in Discharge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	ASCD	Threshold 1	H1	0x00	0xFF	0x77	hex	ASCD: Threshold 1 Setting, Bits 7–4: SCD1D: SCD1 delay time Setting, Bit 3: Reserved Setting, Bits 2–0: SCD1V: SCD1 threshold Setting,
Protections	ASCD	Threshold 2	H1	0x00	0xFF	0xE7	hex	ASCD: Threshold 2 Setting, Bits 7–4: SCD2D: SCD2 delay time Setting, Bit 3: Reserved Setting, Bits 2–0: SCD2V: SCD2 threshold Setting,
Protections	ASCD	Recovery	U1	0	255	5	s	Overload recovery time

13.11.8 OTC—Overtemperature in Charge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	OTC	Threshold	I2	–400	1500	550	0.1°C	Overtemperature in Charge trip threshold
Protections	OTC	Delay	U1	0	255	2	s	Overtemperature in Charge Cell trip delay
Protections	OTC	Recovery	I2	–400	1500	500	0.1°C	Overtemperature in Charge Cell recovery threshold

13.11.9 OTD—Overtemperature in Discharge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	OTD	Threshold	I2	–400	1500	600	0.1°C	Overtemperature in Discharge trip threshold
Protections	OTD	Delay	U1	0	255	2	s	Overtemperature in Discharge trip delay
Protections	OTD	Recovery	I2	–400	1500	550	0.1°C	Overtemperature in Discharge recovery threshold

13.11.10 UTC—Under Temperature in Charge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	UTC	Threshold	I2	–400	1500	0	0.1°C	Under Temperature in Charge trip threshold
Protections	UTC	Delay	U1	0	255	2	s	Under Temperature in Charge Cell trip delay
Protections	UTC	Recovery	I2	–400	1500	50	0.1°C	Under Temperature in Charge Cell recovery threshold

13.11.11 UTD—Under Temperature in Discharge

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	UTD	Threshold	I2	–400	1500	0	0.1°C	Under Temperature in Discharge trip threshold
Protections	UTD	Delay	U1	0	255	2	s	Under Temperature in Discharge trip delay
Protections	UTD	Recovery	I2	–400	1500	50	0.1°C	Under Temperature in Discharge recovery threshold

13.11.12 PTO—Precharge Mode Time Out

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	PTO	Charge Threshold	I2	–32768	32767	2000	mA	Precharge Timeout Current Threshold
Protections	PTO	Suspend Threshold	I2	–32768	32767	1800	mA	Precharge Timeout Suspend Threshold

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	PTO	Delay	U2	0	65535	1800	s	Precharge Timeout trip delay
Protections	PTO	Reset	I2	-32768	32767	2	mA	Precharge Timeout Reset Threshold

13.11.13 CTO—Fast Charge Mode Time Out

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Protections	CTO	Charge Threshold	I2	-32768	32767	2500	mA	Fast-Charge Timeout Current Threshold
Protections	CTO	Suspend Threshold	I2	-32768	32767	2000	mA	Fast-Charge Timeout Suspend Threshold
Protections	CTO	Delay	U2	0	65535	54000	s	Fast-Charge Timeout trip delay
Protections	CTO	Reset	I2	-32768	32767	2	mA	Fast-Charge Timeout Reset Threshold

13.12 Permanent Fail

13.12.1 SOV—Safety Cell Overvoltage

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Permanent Fail	SOV	Threshold	I2	0	32767	4500	mV	Safety Cell Overvoltage trip threshold
Permanent Fail	SOV	Delay	U1	0	255	5	s	Safety Cell Overvoltage trip delay

13.13 PF Status

The data in this class is saved at the time of the PF event

13.13.1 Device Status

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Safety Alert A	H1	0	FF	0	hex	Accumulated safety flags since PF event
PF Status	Device Status Data	Safety Status A	H1	0	FF	0	hex	Accumulated safety flags since PF event

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Safety Alert A or Safety Status A	RSVD	AOLD	RSVD	OCD	RSVD	OCC	COV	CUV

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Safety Alert B	H1	0	FF	0	hex	Accumulated safety flags since PF event
PF Status	Device Status Data	Safety Status B	H1	0	FF	0	hex	Accumulated safety flags since PF event

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Safety Alert B or Safety Status B	RSVD	RSVD	OTD	OTC	RSVD	ASCD	RSVD	ASCC

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Safety Alert C	H1	0	FF	0	hex	Accumulated safety flags since PF event
PF Status	Device Status Data	Safety Status C	H1	0	FF	0	hex	Accumulated safety flags since PF event

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Safety Alert C or Safety Status C	RSVD	RSVD	CTOS	RSVD	PTOS	RSVD	RSVD	RSVD

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Safety Alert D	H1	0	FF	0	hex	Accumulated safety flags since PF event, All bits in this register are RSVD
PF Status	Device Status Data	Safety Status D	H1	0	FF	0	hex	Accumulated safety flags since PF event

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Safety Status D	RSVD	RSVD	CTOS	RSVD	PTOS	DFW	RSVD	IFC

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Operation Status A	H2	0	FFFF	0	hex	<i>OperatonStatus()</i> data at the time of the PF event

Name	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Operation Status A	BTP_INT	RSVD	RSVD	RSVD	PCHG	CHG	DSG	RSVD	SLEEP	XCHG	XDSG	PF	SS	SDV	SEC1	SEC0

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Operation Status B	H2	0	FFFF	0	hex	<i>OperatonStatus()</i> data at the time of the PF event

Name	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Operation Status B	SLEEP	XL	CAL_OFFSET	CAL	AUTO CALM	AUTH	LED	SDM	RSVD	RSVD	RSVD	CB	SLPCC	SLPAD	SMBL CAL	INIT

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Temp Range	H1	0	FF	0	hex	Temperature range status at the time of the PF event. The temperature range information returned to <i>ChargngStatus()</i> .

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Temp range	RSVD	OT	HT	STH	RT	SLT	LT	UT

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Charging Status A	H1	0	FF	0	hex	The charging status at the time of the PF event . See section under ManufactureAccess(), Charging Status()

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Charging Status A	VCT	MCHG	SU	IN	HV	MV	LV	PV

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	Gauging Status	H1	0	FF	0	hex	The charging status at the time of the PF event . See section under ManufactureAccess(), Gauging Status().

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Gauging Status	VCT	MCHG	SU	IN	HV	MV	LV	PV

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Status Data	IT Status	H2	0	FFFF	0	hex	The Impedance Track status at the time of the PF event . See section under ManufactureAccess(), Gauging Status().

Name	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IT Status	NSFM	RSVD	SLPQ MAX	QEN	VOK	RDIS	RSVD	REST	RSVD	RSVD	RSVD	OCVFR	LDMD	RX	QMAX	VDQ

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
Calibration	Current Deadband	Deadband	U1	0	255	3	mA	Pack-based Deadband to report 0 mA
Calibration	Current Deadband	Coulomb Counter Deadband	U1	0	255	9	116 nV	Coulomb counter deadband to report 0 charge (This setting should not be modified)

13.13.2 Device Voltage Data

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Voltage Data	Cell Voltage 0	I2	-32768	32767	0	mV	Cell 0 voltage
PF Status	Device Voltage Data	Cell Voltage 1	I2	-32768	32767	0	mV	Cell 1 voltage
PF Status	Device Voltage Data	Bat Direct Voltage	I2	-32768	32767	0	mV	Cell stack voltage
PF Status	Device Voltage Data	Pack Voltage	I2	-32768	32767	0	mV	Pack pin voltage

13.13.3 Device Current Data

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Current Data	Current	I2	-32768	32767	0	mA	Current()

13.13.4 Device Temperature Data

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Temperature Data	Internal Tempertaure	I2	-32768	32767	0	0.1K	Internal temperature sensor Temperature
PF Status	Device Temperature Data	Exernal 1 Temperature	I2	-32768	32767	0	0.1K	External TS1 Temperature

13.13.5 Device Gauging Data

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
PF Status	Device Gauging Data	Cell 0 DOD0	I2	-32768	32767	0		Cell 0 depth of discharge
PF Status	Device Gauging Data	Cell 1 DOD0	I2	-32768	32767	0		Cell 1 depth of discharge
PF Status	Device Gauging Data	Passed Charge	I2	-32768	32767	0	mAh	Passed charge since last QMax update

13.13.6 AFE Registers

Class	Subclass	Name	Type	Min	Max	Default	Description
PF Status	AFE Regs	AFE Interrupt Status	H1	0x00	0xFF	0x00	AFE Interrupt Status Register Contents
PF Status	AFE Regs	AFE FET Status	H1	0x00	0xFF	0x00	AFE FET Status Register Contents
PF Status	AFE Regs	AFE Rxin	H1	0x00	0xFF	0x00	AFE Rxin Register Contents
PF Status	AFE Regs	AFE Interrupt Enable	H1	0x00	0xFF	0x00	AFE Interrupt Enable Register Contents
PF Status	AFE Regs	AFE FET Control	H1	0x00	0xFF	0x00	AFE FET Control Register Contents
PF Status	AFE Regs	AFE RXIEN	H1	0x00	0xFF	0x00	AFE RXIEN Register Contents
PF Status	AFE Regs	AFE RLOUT	H1	0x00	0xFF	0x00	AFE RLOUT Register Contents
PF Status	AFE Regs	AFE RHOUT	H1	0x00	0xFF	0x00	AFE RHOUT Register Contents
PF Status	AFE Regs	AFE RHINT	H1	0x00	0xFF	0x00	AFE RHINT Register Contents
PF Status	AFE Regs	AFE Cell Balance	H1	0x00	0xFF	0x00	AFE Cell Balance Register Contents
PF Status	AFE Regs	AFE AD/CC Control	H1	0x00	0xFF	0x00	AFE AD/CC Control Register Contents
PF Status	AFE Regs	AFE ADC Mux	H1	0x00	0xFF	0x00	AFE ADC Mux Register Contents
PF Status	AFE Regs	AFE State Control	H1	0x00	0xFF	0x00	AFE State Control Register Contents
PF Status	AFE Regs	AFE Wake Control	H1	0x00	0xFF	0x00	AFE Wake Control Register Contents
PF Status	AFE Regs	AFE Protection Control	H1	0x00	0xFF	0x00	AFE Protection Control Register Contents
PF Status	AFE Regs	AFE OCD	H1	0x00	0xFF	0x00	AFE OCD Register Contents
PF Status	AFE Regs	AFE SCC	H1	0x00	0xFF	0x00	AFE SCC Register Contents
PF Status	AFE Regs	AFE SCD1	H1	0x00	0xFF	0x00	AFE SCD1 Register Contents
PF Status	AFE Regs	AFE SCD2	H1	0x00	0xFF	0x00	AFE SCD2 Register Contents

13.14 RA Table

13.14.1 R_a0

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
RA Table	R_a0	Cell 0 R_A Flag	H2	0x0000	0xFFFF	0xFF55		High Byte: 0x00: Cell Impedance and QMax updated 0x05: RELAX mode and QMax update in progress 0x55: DISCHARGE mode and cell updated 0xFF: Cell impedance never updated Low-Byte: 0x00: Table not used and QMax updated 0x55: Table being used 0xFF: Table never used, no QMax or cell impedance update
RA Table	R_a0	Cell 0 R_A 0	I2	-32768	32768	38	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 0
RA Table	R_a0	Cell 0 R_A 1	I2	-32768	32768	41	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 1
RA Table	R_a0	Cell 0 R_A 2	I2	-32768	32768	43	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 2
RA Table	R_a0	Cell 0 R_A 3	I2	-32768	32768	44	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 3
RA Table	R_a0	Cell 0 R_A 4	I2	-32768	32768	42	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 4
RA Table	R_a0	Cell 0 R_A 5	I2	-32768	32768	42	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 5
RA Table	R_a0	Cell 0 R_A 6	I2	-32768	32768	45	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 6
RA Table	R_a0	Cell 0 R_A 7	I2	-32768	32768	48	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 7
RA Table	R_a0	Cell 0 R_A 8	I2	-32768	32768	49	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 8
RA Table	R_a0	Cell 0 R_A 9	I2	-32768	32768	52	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 9
RA Table	R_a0	Cell 0 R_A 10	I2	-32768	32768	56	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 10
RA Table	R_a0	Cell 0 R_A 11	I2	-32768	32768	64	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 11
RA Table	R_a0	Cell 0 R_A 12	I2	-32768	32768	74	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 12
RA Table	R_a0	Cell 0 R_A 13	I2	-32768	32768	128	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 13
RA Table	R_a0	Cell 0 R_A 14	I2	-32768	32768	378	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 14

13.14.2 R_a1

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
RA Table	R_a1	Cell 1 R_A Flag	H2	0x0000	0xFFFF	0xFF55		High-Byte: 0x00: Cell Impedance and QMax updated 0x05: RELAX mode and QMax update in progress 0x55: DISCHARGE mode and cell updated 0xFF: cell impedance never updated Low-Byte: 0x00: Table not used and QMax updated 0x55: Table being used 0xFF: Table never used, no QMax or cell impedance update
RA Table	R_a1	Cell 1 R_A 0	I2	-32768	32768	38	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 0
RA Table	R_a1	Cell 1 R_A 1	I2	-32768	32768	41	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 1
RA Table	R_a1	Cell 1 R_A 2	I2	-32768	32768	43	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 2
RA Table	R_a1	Cell 1 R_A 3	I2	-32768	32768	44	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 3
RA Table	R_a1	Cell 1 R_A 4	I2	-32768	32768	42	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 4
RA Table	R_a1	Cell 1 R_A 5	I2	-32768	32768	42	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 5
RA Table	R_a1	Cell 1 R_A 6	I2	-32768	32768	45	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 6
RA Table	R_a1	Cell 1 R_A 7	I2	-32768	32768	48	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 7
RA Table	R_a1	Cell 1 R_A 8	I2	-32768	32768	49	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 8
RA Table	R_a1	Cell 1 R_A 9	I2	-32768	32768	52	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 9
RA Table	R_a1	Cell 1 R_A 10	I2	-32768	32768	56	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 10
RA Table	R_a1	Cell 1 R_A 11	I2	-32768	32768	64	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 11
RA Table	R_a1	Cell 1 R_A 12	I2	-32768	32768	74	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 12
RA Table	R_a1	Cell 1 R_A 13	I2	-32768	32768	128	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 13
RA Table	R_a1	Cell 1 R_A 14	I2	-32768	32768	378	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 14

13.14.3 R_a0x

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
RA Table	R_a0x	xCell 0 R_A Flag	H2	0x0000	0xFFFF	0xFFFF		High-Byte: 0x00: Cell Impedance and QMax updated 0x05: RELAX mode and QMax update in progress 0x55: DISCHARGE mode and cell updated 0xFF: cell impedance never updated Low-Byte: 0x00: Table not used and QMax updated 0x55: Table being used 0xFF: Table never used, no QMax or cell impedance update
RA Table	R_a0x	xCell 0 R_A 0	I2	-32768	32768	38	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 0
RA Table	R_a0x	xCell 0 R_A 1	I2	-32768	32768	41	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 1
RA Table	R_a0x	xCell 0 R_A 2	I2	-32768	32768	43	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 2
RA Table	R_a0x	xCell 0 R_A 3	I2	-32768	32768	44	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 3
RA Table	R_a0x	xCell 0 R_A 4	I2	-32768	32768	42	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 4
RA Table	R_a0x	xCell 0 R_A 5	I2	-32768	32768	42	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 5
RA Table	R_a0x	xCell 0 R_A 6	I2	-32768	32768	45	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 6
RA Table	R_a0x	xCell 0 R_A 7	I2	-32768	32768	48	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 7
RA Table	R_a0x	xCell 0 R_A 8	I2	-32768	32768	49	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 8
RA Table	R_a0x	xCell 0 R_A 9	I2	-32768	32768	52	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 9
RA Table	R_a0x	xCell 0 R_A 10	I2	-32768	32768	56	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 10
RA Table	R_a0x	xCell 0 R_A 11	I2	-32768	32768	64	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 11
RA Table	R_a0x	xCell 0 R_A 12	I2	-32768	32768	74	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 12
RA Table	R_a0x	xCell 0 R_A 13	I2	-32768	32768	128	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 13
RA Table	R_a0x	xCell 0 R_A 14	I2	-32768	32768	378	2 ⁻¹⁰ Ω	Cell 0 resistance at grid point 14

13.14.4 R_a1x

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
RA Table	R_a1x	xCell 1 R_A Flag	H2	0x0000	0xFFFF	0xFFFF		High-Byte: 0x00: Cell Impedance and QMax updated 0x05: RELAX mode and QMax update in progress 0x55: DISCHARGE mode and Cell updated 0xFF: cell impedance never updated Low-Byte: 0x00: Table not used and QMax updated 0x55: Table being used 0xFF: Table never used, no QMax or cell impedance update
RA Table	R_a1x	xCell 1 R_A 0	I2	-32768	32768	38	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 0
RA Table	R_a1x	xCell 1 R_A 1	I2	-32768	32768	41	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 1
RA Table	R_a1x	xCell 1 R_A 2	I2	-32768	32768	43	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 2
RA Table	R_a1x	xCell 1 R_A 3	I2	-32768	32768	44	2 ⁻¹⁰ Ω	Cell 1 resistance at grid point 3

Class	Subclass	Name	Type	Min	Max	Default	Unit	Description
RA Table	R_a1x	xCell 1 R_A 4	I2	-32768	32768	42	$2^{-10} \Omega$	Cell 1 resistance at grid point 4
RA Table	R_a1x	xCell 1 R_A 5	I2	-32768	32768	42	$2^{-10} \Omega$	Cell 1 resistance at grid point 5
RA Table	R_a1x	xCell 1 R_A 6	I2	-32768	32768	45	$2^{-10} \Omega$	Cell 1 resistance at grid point 6
RA Table	R_a1x	xCell 1 R_A 7	I2	-32768	32768	48	$2^{-10} \Omega$	Cell 1 resistance at grid point 7
RA Table	R_a1x	xCell 1 R_A 8	I2	-32768	32768	49	$2^{-10} \Omega$	Cell 1 resistance at grid point 8
RA Table	R_a1x	xCell 1 R_A 9	I2	-32768	32768	52	$2^{-10} \Omega$	Cell 1 resistance at grid point 9
RA Table	R_a1x	xCell 1 R_A 10	I2	-32768	32768	56	$2^{-10} \Omega$	Cell 1 resistance at grid point 10
RA Table	R_a1x	xCell 1 R_A 11	I2	-32768	32768	64	$2^{-10} \Omega$	Cell 1 resistance at grid point 11
RA Table	R_a1x	xCell 1 R_A 12	I2	-32768	32768	74	$2^{-10} \Omega$	Cell 1 resistance at grid point 12
RA Table	R_a1x	xCell 1 R_A 13	I2	-32768	32768	128	$2^{-10} \Omega$	Cell 1 resistance at grid point 13
RA Table	R_a1x	xCell 1 R_A 14	I2	-32768	32768	378	$2^{-10} \Omega$	Cell 1 resistance at grid point 14

DRAFT

Data Flash Summary

Data Flash Table

Table 14-1. Data Flash Summary

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Calibration	Voltage	0x4000	I2	Cell Gain	-32767	32767	12101	-
Calibration	Voltage	0x4002	U2	Pack Gain	0	65535	49669	-
Calibration	Voltage	0x4004	U2	BAT Gain	0	65535	48936	-
Calibration	Current	0x4006	F4	CC Gain	1.00E-01	4.00E+00	3.58422	-
Calibration	Current	0x400a	F4	Capacity Gain	2.98E+04	1.19E+06	1069035.256	-
Calibration	Current Offset	0x400e	I2	CC Offset	-32767	32767	0	-
Calibration	Current Offset	0x4010	U2	Coulomb Counter Offset Samples	0	65535	64	-
Calibration	Current Offset	0x4012	I2	Board Offset	-32768	32767	0	-
Calibration	Current Offset	0x40c0	H1	CC Auto Config	0x00	0x07	0x03	hex
Calibration	Current Offset	0x40c1	I2	CC Auto Offset	-10000	10000	0	-
Calibration	Temperature	0x4014	I1	Internal Temp Offset	-128	127	0	0.1degC
Calibration	Temperature	0x4015	I1	External1 Temp Offset	-128	127	0	0.1degC
Calibration	Temperature	0x4016	I1	External2 Temp Offset	-128	127	0	0.1degC
Calibration	Internal Temp Model	0x4400	I2	Int Gain	-32768	32767	-12143	-
Calibration	Internal Temp Model	0x4402	I2	Int base offset	-32768	32767	6232	-
Calibration	Internal Temp Model	0x4404	I2	Int Minimum AD	-32768	32767	0	-
Calibration	Internal Temp Model	0x4406	I2	Int Maximum Temp	-32768	32767	6232	0.1degK
Calibration	Cell Temperature Model	0x4408	I2	Coeff a1	-32768	32767	-11130	-
Calibration	Cell Temperature Model	0x440a	I2	Coeff a2	-32768	32767	19142	-
Calibration	Cell Temperature Model	0x440c	I2	Coeff a3	-32768	32767	-19262	-
Calibration	Cell Temperature Model	0x440e	I2	Coeff a4	-32768	32767	28203	-

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Calibration	Cell Temperature Model	0x4410	I2	Coeff a5	-32768	32767	892	-
Calibration	Cell Temperature Model	0x4412	I2	Coeff b1	-32768	32767	328	-
Calibration	Cell Temperature Model	0x4414	I2	Coeff b2	-32768	32767	-605	-
Calibration	Cell Temperature Model	0x4416	I2	Coeff b3	-32768	32767	-2443	-
Calibration	Cell Temperature Model	0x4418	I2	Coeff b4	-32768	32767	4696	-
Calibration	Cell Temperature Model	0x441a	I2	Rc0	-32768	32767	11703	-
Calibration	Cell Temperature Model	0x441c	I2	Adc0	-32768	32767	11703	-
Calibration	Cell Temperature Model	0x441e	I2	Rpad	-32768	32767	0	-
Calibration	Cell Temperature Model	0x4420	I2	Rint	-32768	32767	0	-
Calibration	Current Deadband	0x4446	U1	Deadband	0	255	3	mA
Calibration	Current Deadband	0x4447	U1	Coulomb Counter Deadband	0	255	9	116nV
Settings	Configuration	0x4600	H1	FET Options	0x0	0xff	0x20	hex
Settings	Configuration	0x4601	H1	I2C Gauging Configuration	0x0	0x0f	0x4	hex
Settings	Configuration	0x4602	H1	I2C Configuration	0x0	0x7f	0x01	hex
Settings	Configuration	0x4603	H1	Power Config	0x0	0x01	0x00	hex
Settings	Configuration	0x4604	H1	IO Config	0x0	0x03	0x00	hex
Settings	Configuration	0x4631	H2	SOC Flag Config A	0x0	0xff	0xc8c	hex
Settings	Configuration	0x4633	H1	SOC Flag Config B	0x0	0xff	0x8c	hex
Settings	Configuration	0x464c	H1	Charging Configuration	0x0	0x3f	0x0	hex
Settings	Configuration	0x4688	H1	Temperature Enable	0x0	0x03	0x03	hex
Settings	Configuration	0x4689	H1	DA Configuration	0x0	0xff	0x11	hex
Settings	Configuration	0x4792	H2	IT Gauging Configuration	0x0	0xffff	0xd4de	hex

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Settings	Configuration	0x47fa	H1	Balancing Configuration	0x0	0xff	0x1	hex
Settings	BTP	0x4605	I2	Init Discharge Set	0	32767	150	mA
Settings	BTP	0x4607	I2	Init Charge Set	0	32767	175	mA
Settings	Charger	0x4623	H1	Device Address	0x0	0xff	0xd4	hex
Settings	Charger	0x4624	H1	Voltage Register	0x0	0xff	0x0c	hex
Settings	Charger	0x4625	H1	Current Register	0x0	0xff	0x0a	hex
Settings	Charger	0x4628	U1	Broadcast Pacing	0	255	15	s
Settings	Protection	0x47a4	H1	Protection Configuration	0x0	0x03	0x0	hex
Settings	Protection	0x47a5	H1	Enabled Protections A	0x0	0xff	0x57	hex
Settings	Protection	0x47a6	H1	Enabled Protections B	0x0	0xff	0x35	hex
Settings	Protection	0x47a7	H1	Enabled Protections C	0x0	0xff	0x3c	hex
Settings	Protection	0x47a8	H1	Enabled Protections D	0x0	0xff	0x0c	hex
Settings	Permanent Failure	0x47f2	H1	Enabled PF A	0x0	0xff	0x0	hex
Settings	AFE	0x468b	H1	AFE Protection Control	0x0	0xff	0x70	hex
Settings	AFE	0x4691	I2	ZVCHG Exit Threshold	0	8000	2200	mV
Settings	Manufacturing	0x43c0	H2	Mfg Status init	0x0	0xffff	0x0000	hex
Advanced Charge Algorithm	Temperature Ranges	0x464d	I1	T1 Temp	-128	127	0	degC
Advanced Charge Algorithm	Temperature Ranges	0x464e	I1	T2 Temp	-128	127	12	degC
Advanced Charge Algorithm	Temperature Ranges	0x464f	I1	T5 Temp	-128	127	20	degC
Advanced Charge Algorithm	Temperature Ranges	0x4650	I1	T6 Temp	-128	127	25	degC
Advanced Charge Algorithm	Temperature Ranges	0x4651	I1	T3 Temp	-128	127	30	degC
Advanced Charge Algorithm	Temperature Ranges	0x4652	I1	T4 Temp	-128	127	55	degC

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Advanced Charge Algorithm	Temperature Ranges	0x4653	I1	Hysteresis Temp	-128	127	1	degC
Advanced Charge Algorithm	Low Temp Charging	0x4654	I2	Voltage	0	32767	4000	mV
Advanced Charge Algorithm	Low Temp Charging	0x4656	I2	Current Low	0	32767	132	mA
Advanced Charge Algorithm	Low Temp Charging	0x4658	I2	Current Med	0	32767	352	mA
Advanced Charge Algorithm	Low Temp Charging	0x465a	I2	Current High	0	32767	264	mA
Advanced Charge Algorithm	Standard Temp Charging	0x465c	I2	Voltage	0	32767	4200	mV
Advanced Charge Algorithm	Standard Temp Charging	0x465e	I2	Current Low	0	32767	1980	mA
Advanced Charge Algorithm	Standard Temp Charging	0x4660	I2	Current Med	0	32767	4004	mA
Advanced Charge Algorithm	Standard Temp Charging	0x4662	I2	Current High	0	32767	2992	mA
Advanced Charge Algorithm	High Temp Charging	0x4664	I2	Voltage	0	32767	4000	mV
Advanced Charge Algorithm	High Temp Charging	0x4666	I2	Current Low	0	32767	1012	mA
Advanced Charge Algorithm	High Temp Charging	0x4668	I2	Current Med	0	32767	1980	mA
Advanced Charge Algorithm	High Temp Charging	0x466a	I2	Current High	0	32767	1496	mA
Advanced Charge Algorithm	Rec Temp Charging	0x466c	I2	Voltage	0	32767	4100	mV
Advanced Charge Algorithm	Rec Temp Charging	0x466e	I2	Current Low	0	32767	2508	mA
Advanced Charge Algorithm	Rec Temp Charging	0x4670	I2	Current Med	0	32767	4488	mA
Advanced Charge Algorithm	Rec Temp Charging	0x4672	I2	Current High	0	32767	3520	mA
Advanced Charge Algorithm	Pre-Charging	0x4674	I2	Current	0	32767	88	mA
Advanced Charge Algorithm	Maintenance Charging	0x4676	I2	Current	0	32767	44	mA
Advanced Charge Algorithm	Voltage Range	0x4678	I2	Precharge Start Voltage	0	32767	2500	mV

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Advanced Charge Algorithm	Voltage Range	0x467a	I2	Charging Voltage Low	0	32767	2900	mV
Advanced Charge Algorithm	Voltage Range	0x467c	I2	Charging Voltage Med	0	32767	3600	mV
Advanced Charge Algorithm	Voltage Range	0x467e	I2	Charging Voltage High	0	32767	4000	mV
Advanced Charge Algorithm	Voltage Range	0x4680	U1	Charging Voltage Hysteresis	0	255	0	mV
Advanced Charge Algorithm	Termination Config	0x4681	I2	Charge Term Taper Current	0	32767	250	mA
Advanced Charge Algorithm	Termination Config	0x4685	I2	Charge Term Voltage	0	32767	75	mV
Advanced Charge Algorithm	Cell Balancing Config	0x47fb	U2	Bal Time/mAh Cell 1	0	65535	367	s/mAh
Advanced Charge Algorithm	Cell Balancing Config	0x47fd	U2	Bal Time/mAh Cell 2	0	65535	514	s/mAh
Power	Power	0x4609	I2	Valid Update Voltage	0	32767	2800	mV
Power	Shutdown	0x460b	I2	Shutdown Voltage	0	32767	2300	mV
Power	Shutdown	0x460d	U1	Shutdown Time	0	255	10	s
Power	Shutdown	0x460e	I2	Charger Present Threshold	0	32767	3000	mV
Power	Sleep	0x4610	I2	Sleep Current	0	32767	10	mA
Power	Sleep	0x4612	U1	Bus Timeout	0	255	5	s
Power	Sleep	0x4617	U1	Voltage Time	0	255	5	s
Power	Sleep	0x4618	U1	Current Time	0	255	20	s
Power	Sleep	0x4619	H1	Wake Comparitor	0x0	0xff	0x0	hex
Power	Ship	0x461a	U1	FET Off Time	0	127	10	s
Power	Ship	0x461b	U1	Delay	0	254	20	s
Power	Ship	0x4621	U2	Auto Ship Time	0	65535	1440	min
Gas Gauging	Standby	0x461c	I2	StandbyCurrent	-32768	0	-10	mA
Gas Gauging	Max Load	0x461e	I2	Max Load Current	-32768	0	-500	mA
Gas Gauging	Max Load	0x4620	U1	Max Load Rsoc	0	100	50	%
Gas Gauging	Current Thresholds	0x4694	I2	Dsg Current Threshold	-32768	32767	100	mA
Gas Gauging	Current Thresholds	0x4696	I2	Chg Current Threshold	-32768	32767	50	mA

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Gas Gauging	Current Thresholds	0x4698	I2	Quit Current	0	32767	10	mA
Gas Gauging	Current Thresholds	0x469a	U1	Dsg Relax Time	0	255	1	s
Gas Gauging	Current Thresholds	0x469b	U1	Chg Relax Time	0	255	60	s
Gas Gauging	Design	0x4629	I2	Design Capacity mAh	0	32767	4400	mAh
Gas Gauging	Design	0x462b	I2	Design Capacity cWh	0	32767	6336	cWh
Gas Gauging	Design	0x462d	I2	Design Voltage	0	32767	7200	mV
Gas Gauging	Cycle	0x462f	U1	Cycle Count Percentage	0	100	90	%
Gas Gauging	FD	0x4634	I2	Set Voltage Threshold	0	5000	3000	mV
Gas Gauging	FD	0x4636	I2	Clear Voltage Threshold	0	5000	3100	mV
Gas Gauging	FD	0x4638	U1	Set % RSOC Threshold	0	100	0	%
Gas Gauging	FD	0x4639	U1	Clear % RSOC Threshold	0	100	5	%
Gas Gauging	FC	0x463a	I2	Set Voltage Threshold	0	5000	4200	mV
Gas Gauging	FC	0x463c	I2	Clear Voltage Threshold	0	5000	4100	mV
Gas Gauging	FC	0x463e	U1	Set % RSOC Threshold	0	100	100	%
Gas Gauging	FC	0x463f	U1	Clear % RSOC Threshold	0	100	95	%
Gas Gauging	TD	0x4640	I2	Set Voltage Threshold	0	5000	3200	mV
Gas Gauging	TD	0x4642	I2	Clear Voltage Threshold	0	5000	3300	mV
Gas Gauging	TD	0x4644	U1	Set % RSOC Threshold	0	100	6	%
Gas Gauging	TD	0x4645	U1	Clear % RSOC Threshold	0	100	8	%
Gas Gauging	TC	0x4646	I2	Set Voltage Threshold	0	5000	4200	mV
Gas Gauging	TC	0x4648	I2	Clear Voltage Threshold	0	5000	4100	mV
Gas Gauging	TC	0x464a	U1	Set % RSOC Threshold	0	100	100	%

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Gas Gauging	TC	0x464b	U1	Clear % RSOC Threshold	0	100	95	%
Gas Gauging	State	0x4204	I2	Qmax Cell 1	0	32767	4400	mAh
Gas Gauging	State	0x4206	I2	Qmax Cell 2	0	32767	4400	mAh
Gas Gauging	State	0x4208	I2	Qmax Pack	0	32767	4400	mAh
Gas Gauging	State	0x420a	U2	Qmax Cycle Count	0	65535	0	-
Gas Gauging	State	0x420c	H1	Update Status	0x0	0x0e	0x0	-
Gas Gauging	State	0x420d	I2	Cell 1 Chg Voltage at EoC	0	32767	4200	mV
Gas Gauging	State	0x420f	I2	Cell 2 Chg Voltage at EoC	0	32767	4200	mV
Gas Gauging	State	0x4211	I2	Current at EoC	0	32767	250	mA
Gas Gauging	State	0x4213	I2	Avg I Last Run	-32768	32767	-2000	mA
Gas Gauging	State	0x4215	I2	Avg P Last Run	-32768	32767	-3022	cW
Gas Gauging	State	0x4217	I2	Delta Voltage	-32768	32767	0	mV
Gas Gauging	State	0x4219	I2	Temp k	0	32767	100	0.1degC/2560mW
Gas Gauging	State	0x421b	I2	Temp a	0	32767	1000	-
Gas Gauging	State	0x421d	I2	Max Avg I Last Run	-32768	32767	-2000	mA
Gas Gauging	State	0x421f	I2	Max Avg P Last Run	-32768	32767	-3022	cW
Gas Gauging	State	0x4240	U2	Cycle Count	0	65535	0	-
Gas Gauging	IT Cfg	0x4200	I2	Pack Resistance	0	32767	30	mOhms
Gas Gauging	IT Cfg	0x4202	I2	System Resistance	0	32767	0	mOhms
Gas Gauging	IT Cfg	0x458e	U2	Ra Filter	0	999	500	%
Gas Gauging	IT Cfg	0x4591	U1	Ra Max Delta	0	255	15	%
Gas Gauging	IT Cfg	0x4593	U1	Reference Grid	0	14	4	-
Gas Gauging	IT Cfg	0x4594	U2	Resistance Parameter Filter	1	65535	65142	-
Gas Gauging	IT Cfg	0x4596	U2	Near EDV Ra Param Filter	1	65535	59220	-
Gas Gauging	IT Cfg	0x45bc	U1	Qmax Delta	3	100	5	%
Gas Gauging	IT Cfg	0x45bd	U1	Qmax Upper Bound	100	255	130	%

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Gas Gauging	IT Cfg	0x45be	I2	Term Voltage	0	32767	6000	mV
Gas Gauging	IT Cfg	0x45c0	I2	Term Voltage Delta	0	32767	300	mV
Gas Gauging	IT Cfg	0x45c2	I2	Term Min Cell V	0	32767	2800	mV
Gas Gauging	IT Cfg	0x45c7	I2	Voltage Consistency Delta	0	32767	300	mV
Gas Gauging	IT Cfg	0x45da	U1	Fast Scale Start SOC	0	100	10	%
Gas Gauging	IT Cfg	0x4795	U1	Load Select	0	7	7	-
Gas Gauging	IT Cfg	0x4796	U1	Load Mode	0	1	0	-
Gas Gauging	IT Cfg	0x4797	I2	Design Resistance	1	32767	42	mOhms
Gas Gauging	IT Cfg	0x4799	I2	User Rate-mA	-9000	0	0	mA
Gas Gauging	IT Cfg	0x479b	I2	User Rate-cW	-32768	0	0	cW
Gas Gauging	IT Cfg	0x479d	I2	Reserve Cap-mAh	0	9000	0	mAh
Gas Gauging	IT Cfg	0x479f	I2	Reserve Cap-cWh	0	32000	0	cWh
Gas Gauging	Smoothing	0x47a1	I2	Smooth Relax Time	1	32767	1000	s
Gas Gauging	Condition Flag	0x47a3	U1	Max Error Limit	0	100	100	%
Gas Gauging	SoH	0x45e3	U1	SoH Load Rate	0	255	50	0.1hour Rate
System Data	Manufacturer Data	0x4040	S33	Manufacturer Info	x	x	abcdefghijkl mnopqrstuv wzxy012345	-
System Data	Integrity	0x4061	H2	Static DF Signature	0x0	0x7fff	0x0	hex
System Data	Integrity	0x4063	H2	Static Chem DF Signature	0x0	0x7fff	0x6c98	hex
System Data	Integrity	0x4065	H2	All DF Signature	0x0	0x7fff	0x0	hex
I2C Configuration	Data	0x4067	U2	Manufacture Date	0	65535	0	date
I2C Configuration	Data	0x4069	H2	Serial Number	0x0	0xffff	0x1	hex
I2C Configuration	Data	0x406b	S21	Manufacturer Name	x	x	Texas Instruments	-
I2C Configuration	Data	0x4080	S21	Device Name	x	x	bq28z610	-
I2C Configuration	Data	0x4095	S5	Device Chemistry	x	x	LION	-

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Lifetimes	Voltage	0x4280	I2	Cell 1 Max Voltage	0	32767	0	mV
Lifetimes	Voltage	0x4282	I2	Cell 2 Max Voltage	0	32767	0	mV
Lifetimes	Current	0x4284	I2	Max Charge Current	0	32767	0	mA
Lifetimes	Current	0x4286	I2	Max Discharge Current	-32768	0	0	mA
Lifetimes	Temperature	0x4288	I1	Max Temp Cell	-128	127	-128	degC
Lifetimes	Temperature	0x4289	I1	Min Temp Cell	-128	127	127	degC
Protections	CUV	0x47a9	I2	Threshold	0	32767	2500	mV
Protections	CUV	0x47ab	U1	Delay	0	255	2	s
Protections	CUV	0x47ac	I2	Recovery	0	32767	3000	mV
Protections	COV	0x47ae	I2	Threshold Low Temp	0	32767	4300	mV
Protections	COV	0x47b0	I2	Threshold Standard Temp	0	32767	4300	mV
Protections	COV	0x47b2	I2	Threshold High Temp	0	32767	4300	mV
Protections	COV	0x47b4	I2	Threshold Rec Temp	0	32767	4300	mV
Protections	COV	0x47b6	U1	Delay	0	255	2	s
Protections	COV	0x47b7	I2	Recovery Low Temp	0	32767	3900	mV
Protections	COV	0x47b9	I2	Recovery Standard Temp	0	32767	3900	mV
Protections	COV	0x47bb	I2	Recovery High Temp	0	32767	3900	mV
Protections	COV	0x47bd	I2	Recovery Rec Temp	0	32767	3900	mV
Protections	OCC	0x47bf	I2	Threshold	-32768	32767	6000	mA
Protections	OCC	0x47c1	U1	Delay	0	255	6	s
Protections	OCC	0x47c2	I2	Recovery Threshold	-32768	32767	-200	mA
Protections	OCC	0x47c4	U1	Recovery Delay	0	255	5	s
Protections	OCD	0x47c5	I2	Threshold	-32768	32767	-6000	mA
Protections	OCD	0x47c7	U1	Delay	0	255	6	s
Protections	OCD	0x47c8	I2	Recovery Threshold	-32768	32767	200	mA
Protections	OCD	0x47ca	U1	Recovery Delay	0	255	5	s
Protections	AOLD	0x468c	H1	Threshold	0x0	0xff	0xf4	hex
Protections	AOLD	0x47cb	U1	Recovery	0	255	5	s
Protections	ASCC	0x468d	H1	Threshold	0x0	0xff	0x77	hex
Protections	ASCC	0x47cc	U1	Recovery	0	255	5	s
Protections	ASCD	0x468e	H1	Threshold 1	0x0	0xff	0x77	hex
Protections	ASCD	0x468f	H1	Threshold 2	0x0	0xff	0xe7	hex
Protections	ASCD	0x47cd	U1	Recovery	0	255	5	s

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Protections	OTC	0x47ce	I2	Threshold	-400	1500	550	0.1degC
Protections	OTC	0x47d0	U1	Delay	0	255	2	s
Protections	OTC	0x47d1	I2	Recovery	-400	1500	500	0.1degC
Protections	OTD	0x47d3	I2	Threshold	-400	1500	600	0.1degC
Protections	OTD	0x47d5	U1	Delay	0	255	2	s
Protections	OTD	0x47d6	I2	Recovery	-400	1500	550	0.1degC
Protections	UTC	0x47d8	I2	Threshold	-400	1500	0	0.1degC
Protections	UTC	0x47da	U1	Delay	0	255	2	s
Protections	UTC	0x47db	I2	Recovery	-400	1500	50	0.1degC
Protections	UTD	0x47dd	I2	Threshold	-400	1500	0	0.1degC
Protections	UTD	0x47df	U1	Delay	0	255	2	s
Protections	UTD	0x47e0	I2	Recovery	-400	1500	50	0.1degC
Protections	PTO	0x47e2	I2	Charge Threshold	-32768	32767	2000	mA
Protections	PTO	0x47e4	I2	Suspend Threshold	-32768	32767	1800	mA
Protections	PTO	0x47e6	U2	Delay	0	65535	1800	s
Protections	PTO	0x47e8	I2	Reset	0	32767	2	mAh
Protections	CTO	0x47ea	I2	Charge Threshold	-32768	32767	2500	mA
Protections	CTO	0x47ec	I2	Suspend Threshold	-32768	32767	2000	mA
Protections	CTO	0x47ee	U2	Delay	0	65535	54000	s
Protections	CTO	0x47f0	I2	Reset	0	32767	2	mAh
Permanent Fail	SOV	0x47f6	I2	Threshold	0	32767	4500	mV
Permanent Fail	SOV	0x47f8	U1	Delay	0	255	5	s
PF Status	Device Status Data	0x42c0	H1	Safety Alert A	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c1	H1	Safety Status A	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c2	H1	Safety Alert B	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c3	H1	Safety Status B	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c4	H1	Safety Alert C	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c5	H1	Safety Status C	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c6	H1	Safety Alert D	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c7	H1	Safety Status D	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c8	H1	PF Alert A	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42c9	H1	PF Status A	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42cf	H1	PF Status D	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42d0	H2	Operation Status A	0x0	0xffff	0x0	hex

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
PF Status	Device Status Data	0x42d2	H2	Operation Status B	0x0	0xffff	0x0	hex
PF Status	Device Status Data	0x42d4	H1	Temp Range	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42d5	H1	Charging Status A	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42d6	H1	Charging Status B	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42d7	H1	Gauging Status	0x0	0xff	0x0	hex
PF Status	Device Status Data	0x42d8	H2	IT Status	0x0	0xffff	0x0	hex
PF Status	Device Voltage Data	0x42da	I2	Cell 1 Voltage	-32768	32767	0	mV
PF Status	Device Voltage Data	0x42dc	I2	Cell 2 Voltage	-32768	32767	0	mV
PF Status	Device Voltage Data	0x42de	I2	Battery Direct Voltage	-32768	32767	0	mV
PF Status	Device Voltage Data	0x42e0	I2	Pack Voltage	-32768	32767	0	mV
PF Status	Device Current Data	0x42e2	I2	Current	-32768	32767	0	mA
PF Status	Device Temperature Data	0x42e4	I2	Internal Temperature	-32768	32767	0	0.1degK
PF Status	Device Temperature Data	0x42e6	I2	External 1 Temperature	-32768	32767	0	0.1degK
PF Status	Device Temperature Data	0x42e8	I2	External 2 Temperature	-32768	32767	0	0.1degK
PF Status	Device Gauging Data	0x42ea	I2	Cell 1 Dod0	-32768	32767	0	-
PF Status	Device Gauging Data	0x42ec	I2	Cell 2 Dod0	-32768	32767	0	-
PF Status	Device Gauging Data	0x42ee	I2	Passed Charge	-32768	32767	0	mAh
PF Status	AFE Regs	0x42f0	H1	AFE Interrupt Status	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42f1	H1	AFE FET Status	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42f2	H1	AFE RXIN	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42f3	H1	AFE Latch Status	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42f4	H1	AFE Interrupt Enable	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42f5	H1	AFE FET Control	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42f6	H1	AFE RXIEN	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42f7	H1	AFE RLOUT	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42f8	H1	AFE RHOUT	0x0	0xff	0x0	hex

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
PF Status	AFE Regs	0x42f9	H1	AFE RHINT	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42fa	H1	AFE Cell Balance	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42fb	H1	AFE AD/CC Control	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42fc	H1	AFE ADC Mux	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42fd	H1	AFE LED Output	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42fe	H1	AFE State Control	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x42ff	H1	AFE LED/Wake Control	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x4300	H1	AFE Protection Control	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x4301	H1	AFE OCD	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x4302	H1	AFE SCC	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x4303	H1	AFE SCD1	0x0	0xff	0x0	hex
PF Status	AFE Regs	0x4304	H1	AFE SCD2	0x0	0xff	0x0	hex
Ra Table	R_a0	0x4100	H2	Cell0 R_a flag	0x0	0xffff	0xff55	-
Ra Table	R_a0	0x4102	I2	Cell0 R_a 0	0	32767	67	2 [^] -10ohm
Ra Table	R_a0	0x4104	I2	Cell0 R_a 1	0	32767	71	2 [^] -10ohm
Ra Table	R_a0	0x4106	I2	Cell0 R_a 2	0	32767	83	2 [^] -10ohm
Ra Table	R_a0	0x4108	I2	Cell0 R_a 3	0	32767	110	2 [^] -10ohm
Ra Table	R_a0	0x410a	I2	Cell0 R_a 4	0	32767	96	2 [^] -10ohm
Ra Table	R_a0	0x410c	I2	Cell0 R_a 5	0	32767	77	2 [^] -10ohm
Ra Table	R_a0	0x410e	I2	Cell0 R_a 6	0	32767	96	2 [^] -10ohm
Ra Table	R_a0	0x4110	I2	Cell0 R_a 7	0	32767	86	2 [^] -10ohm
Ra Table	R_a0	0x4112	I2	Cell0 R_a 8	0	32767	84	2 [^] -10ohm
Ra Table	R_a0	0x4114	I2	Cell0 R_a 9	0	32767	82	2 [^] -10ohm
Ra Table	R_a0	0x4116	I2	Cell0 R_a 10	0	32767	81	2 [^] -10ohm
Ra Table	R_a0	0x4118	I2	Cell0 R_a 11	0	32767	92	2 [^] -10ohm
Ra Table	R_a0	0x411a	I2	Cell0 R_a 12	0	32767	103	2 [^] -10ohm
Ra Table	R_a0	0x411c	I2	Cell0 R_a 13	0	32767	123	2 [^] -10ohm
Ra Table	R_a0	0x411e	I2	Cell0 R_a 14	0	32767	658	2 [^] -10ohm
Ra Table	R_a1	0x4140	H2	Cell1 R_a flag	0x0	0xffff	0xff55	-
Ra Table	R_a1	0x4142	I2	Cell1 R_a 0	0	32767	67	2 [^] -10ohm
Ra Table	R_a1	0x4144	I2	Cell1 R_a 1	0	32767	71	2 [^] -10ohm
Ra Table	R_a1	0x4146	I2	Cell1 R_a 2	0	32767	83	2 [^] -10ohm
Ra Table	R_a1	0x4148	I2	Cell1 R_a 3	0	32767	110	2 [^] -10ohm
Ra Table	R_a1	0x414a	I2	Cell1 R_a 4	0	32767	96	2 [^] -10ohm
Ra Table	R_a1	0x414c	I2	Cell1 R_a 5	0	32767	77	2 [^] -10ohm
Ra Table	R_a1	0x414e	I2	Cell1 R_a 6	0	32767	96	2 [^] -10ohm
Ra Table	R_a1	0x4150	I2	Cell1 R_a 7	0	32767	86	2 [^] -10ohm
Ra Table	R_a1	0x4152	I2	Cell1 R_a 8	0	32767	84	2 [^] -10ohm
Ra Table	R_a1	0x4154	I2	Cell1 R_a 9	0	32767	82	2 [^] -10ohm
Ra Table	R_a1	0x4156	I2	Cell1 R_a 10	0	32767	81	2 [^] -10ohm

Table 14-1. Data Flash Summary (continued)

Class	Subclass	Address	Type	Name	Min	Max	Default	Units
Ra Table	R_a1	0x4158	I2	Cell1 R_a 11	0	32767	92	2 [^] -10ohm
Ra Table	R_a1	0x415a	I2	Cell1 R_a 12	0	32767	103	2 [^] -10ohm
Ra Table	R_a1	0x415c	I2	Cell1 R_a 13	0	32767	123	2 [^] -10ohm
Ra Table	R_a1	0x415e	I2	Cell1 R_a 14	0	32767	658	2 [^] -10ohm
Ra Table	R_a0x	0x4180	H2	xCell0 R_a flag	0x0	0xffff	0xffff	-
Ra Table	R_a0x	0x4182	I2	xCell0 R_a 0	0	32767	67	2 [^] -10ohm
Ra Table	R_a0x	0x4184	I2	xCell0 R_a 1	0	32767	71	2 [^] -10ohm
Ra Table	R_a0x	0x4186	I2	xCell0 R_a 2	0	32767	83	2 [^] -10ohm
Ra Table	R_a0x	0x4188	I2	xCell0 R_a 3	0	32767	110	2 [^] -10ohm
Ra Table	R_a0x	0x418a	I2	xCell0 R_a 4	0	32767	96	2 [^] -10ohm
Ra Table	R_a0x	0x418c	I2	xCell0 R_a 5	0	32767	77	2 [^] -10ohm
Ra Table	R_a0x	0x418e	I2	xCell0 R_a 6	0	32767	96	2 [^] -10ohm
Ra Table	R_a0x	0x4190	I2	xCell0 R_a 7	0	32767	86	2 [^] -10ohm
Ra Table	R_a0x	0x4192	I2	xCell0 R_a 8	0	32767	84	2 [^] -10ohm
Ra Table	R_a0x	0x4194	I2	xCell0 R_a 9	0	32767	82	2 [^] -10ohm
Ra Table	R_a0x	0x4196	I2	xCell0 R_a 10	0	32767	81	2 [^] -10ohm
Ra Table	R_a0x	0x4198	I2	xCell0 R_a 11	0	32767	92	2 [^] -10ohm
Ra Table	R_a0x	0x419a	I2	xCell0 R_a 12	0	32767	103	2 [^] -10ohm
Ra Table	R_a0x	0x419c	I2	xCell0 R_a 13	0	32767	123	2 [^] -10ohm
Ra Table	R_a0x	0x419e	I2	xCell0 R_a 14	0	32767	658	2 [^] -10ohm
Ra Table	R_a1x	0x41c0	H2	xCell1 R_a flag	0x0	0xffff	0xffff	-
Ra Table	R_a1x	0x41c2	I2	xCell1 R_a 0	0	32767	67	2 [^] -10ohm
Ra Table	R_a1x	0x41c4	I2	xCell1 R_a 1	0	32767	71	2 [^] -10ohm
Ra Table	R_a1x	0x41c6	I2	xCell1 R_a 2	0	32767	83	2 [^] -10ohm
Ra Table	R_a1x	0x41c8	I2	xCell1 R_a 3	0	32767	110	2 [^] -10ohm
Ra Table	R_a1x	0x41ca	I2	xCell1 R_a 4	0	32767	96	2 [^] -10ohm
Ra Table	R_a1x	0x41cc	I2	xCell1 R_a 5	0	32767	77	2 [^] -10ohm
Ra Table	R_a1x	0x41ce	I2	xCell1 R_a 6	0	32767	96	2 [^] -10ohm
Ra Table	R_a1x	0x41d0	I2	xCell1 R_a 7	0	32767	86	2 [^] -10ohm
Ra Table	R_a1x	0x41d2	I2	xCell1 R_a 8	0	32767	84	2 [^] -10ohm
Ra Table	R_a1x	0x41d4	I2	xCell1 R_a 9	0	32767	82	2 [^] -10ohm
Ra Table	R_a1x	0x41d6	I2	xCell1 R_a 10	0	32767	81	2 [^] -10ohm
Ra Table	R_a1x	0x41d8	I2	xCell1 R_a 11	0	32767	92	2 [^] -10ohm
Ra Table	R_a1x	0x41da	I2	xCell1 R_a 12	0	32767	103	2 [^] -10ohm
Ra Table	R_a1x	0x41dc	I2	xCell1 R_a 13	0	32767	123	2 [^] -10ohm
Ra Table	R_a1x	0x41de	I2	xCell1 R_a 14	0	32767	658	2 [^] -10ohm

AFE Threshold and Delay Settings

A.1 Overload in Discharge Protection (AOLD)

**Table A-1. Overload in Discharge Protection Threshold
(Settings:AFE:AFE Protection Control [RSNS] = 0)⁽¹⁾**

OLD Threshold ([RSNS] = 0)			
Setting	Threshold	Setting	Threshold
0x00	–8.30 mV	0x08	–30.54 mV
0x01	–11.08 mV	0x09	–33.32 mV
0x02	–13.86 mV	0x0A	–36.10 mV
0x03	–16.64 mV	0x0B	–38.88 mV
0x04	–19.42 mV	0x0C	–41.66 mV
0x05	–22.20 mV	0x0D	–44.44 mV
0x06	–24.98 mV	0x0E	–47.22 mV
0x07	–27.76 mV	0x0F	–50.00 mV

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:OLD Threshold[3:0]* sets the voltage threshold.

**Table A-2. Overload in Discharge Protection Threshold
(Settings:AFE:AFE Protection Control [RSNS] = 1)⁽¹⁾**

OLD Threshold ([RSNS] = 1)			
Setting	Threshold	Setting	Threshold
0x00	–16.60 mV	0x08	–61.08 mV
0x01	–22.16 mV	0x09	–66.64 mV
0x02	–27.72 mV	0x0A	–72.20 mV
0x03	–33.28 mV	0x0B	–77.76 mV
0x04	–38.84 mV	0x0C	–83.32 mV
0x05	–44.40 mV	0x0D	–88.88 mV
0x06	–49.96 mV	0x0E	–94.44 mV
0x07	–55.52 mV	0x0F	–100.00 mV

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:OLD Threshold[3:0]* sets the voltage threshold.

Table A-3. Overload in Discharge Protection Delay⁽¹⁾

Setting	Time	Setting	Time	Setting	Time	Setting	Time
0x00	1 ms	0x04	9 ms	0x08	17 ms	0x0C	25 ms
0x01	3 ms	0x05	11 ms	0x09	19 ms	0x0D	27 ms
0x02	5 ms	0x06	13 ms	0x0A	21 ms	0x0E	29 ms
0x03	7 ms	0x07	15 ms	0x0B	23 ms	0x0F	31 ms

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:OLD Threshold[7:4]* sets the delay time.

A.2 Short Circuit in Charge (ASCC)

**Table A-4. Short Circuit in Charge Threshold
(Settings:AFE:AFE Protection Control [RSNS] = 0)⁽¹⁾**

Setting	Threshold	Setting	Threshold
0x00	22.2 mV	0x04	66.65 mV
0x01	33.3 mV	0x05	77.75 mV
0x02	44.4 mV	0x06	88.85 mV
0x03	55.5 mV	0x07	100 mV

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCC Threshold[2:0]* sets the voltage threshold.

**Table A-5. Short Circuit in Charge Threshold
(Settings:AFE:AFE Protection Control [RSNS] = 1)⁽¹⁾**

Setting	Threshold	Setting	Threshold
0x00	44.4 mV	0x04	133.3 mV
0x01	66.6 mV	0x05	155.5 mV
0x02	88.8 mV	0x06	177.7 mV
0x03	111.1 mV	0x07	200 mV

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCC Threshold[2:0]* sets the voltage threshold.

Table A-6. Short Circuit in Charge Delay⁽¹⁾

Setting	Time	Setting	Time	Setting	Time	Setting	Time
0x00	0 μ s	0x04	244 μ s	0x08	488 μ s	0x0C	732 μ s
0x01	61 μ s	0x05	305 μ s	0x09	549 μ s	0x0D	793 μ s
0x02	122 μ s	0x06	366 μ s	0x0A	610 μ s	0x0E	854 μ s
0x03	183 μ s	0x07	427 μ s	0x0B	671 μ s	0x0F	915 μ s

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCC Threshold[7:4]* sets the delay time.

A.3 Short Circuit in Discharge (ASCD1 and ASCD2)

**Table A-7. Short Circuit in Discharge Threshold
(Settings:AFE:AFE Protection Control [RSNS] = 0)⁽¹⁾**

Setting	Threshold	Setting	Threshold
0x00	-22.2 mV	0x04	-66.65 mV
0x01	-33.3 mV	0x05	-77.75 mV
0x02	-44.4 mV	0x06	-88.85 mV
0x03	-55.5 mV	0x07	-100 mV

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCD1 Threshold[2:0]* and *Protection:AFE Thresholds:SCD2 Threshold[2:0]* sets the voltage thresholds.

**Table A-8. Short Circuit in Discharge Threshold
(Settings:AFE:AFE Protection Control [RSNS] = 1)⁽¹⁾**

Setting	Threshold	Setting	Threshold
0x00	-44.4 mV	0x04	-133.3 mV
0x01	-66.6 mV	0x05	-155.5 mV
0x02	-88.8 mV	0x06	-177.7 mV
0x03	-111.1 mV	0x07	-200 mV

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCD1 Threshold[2:0]* and *Protection:AFE Thresholds:SCD2 Threshold[2:0]* sets the voltage thresholds.

**Table A-9. Short Circuit in Discharge 1 Delay
(Settings:AFE:AFE Protection Control [SCDDx2] = 0)⁽¹⁾**

Setting	Time	Setting	Time	Setting	Time	Setting	Time
0x00	0 μs	0x04	244 μs	0x08	488 μs	0x0C	732 μs
0x01	61 μs	0x05	305 μs	0x09	549 μs	0x0D	793 μs
0x02	122 μs	0x06	366 μs	0x0A	610 μs	0x0E	854 μs
0x03	183 μs	0x07	427 μs	0x0B	671 μs	0x0F	915 μs

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCD1Threshold[7:4]* sets the delay time.

**Table A-10. Short Circuit in Discharge 1 Delay
(Settings:AFE:AFE Protection Control [SCDDx2] = 1)⁽¹⁾**

Setting	Time	Setting	Time	Setting	Time	Setting	Time
0x00	0 μs	0x04	488 μs	0x08	976 μs	0x0C	1464 μs
0x01	122 μs	0x05	610 μs	0x09	1098 μs	0x0D	1586 μs
0x02	244 μs	0x06	732 μs	0x0A	1220 μs	0x0E	1708 μs
0x03	366 μs	0x07	854 μs	0x0B	1342 μs	0x0F	1830 μs

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCD1 Threshold[7:4]* sets the delay time.

**Table A-11. Short Circuit in Discharge 2 Delay
(Settings:AFE:AFE Protection Control [SCDDx2] = 0)⁽¹⁾**

Setting	Time	Setting	Time	Setting	Time	Setting	Time
0x00	0 μs	0x04	122 μs	0x08	244 μs	0x0C	366 μs
0x01	31 μs	0x05	153 μs	0x09	275 μs	0x0D	396 μs
0x02	61 μs	0x06	183 μs	0x0A	305 μs	0x0E	427 μs
0x03	92 μs	0x07	214 μs	0x0B	335 μs	0x0F	458 μs

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCD2 Threshold[7:4]* sets the delay time.

**Table A-12. Short Circuit in Discharge 2 Delay
(Settings:AFE:AFE Protection Control [SCDDx2] = 1)⁽¹⁾**

Setting	Time	Setting	Time	Setting	Time	Setting	Time
0x00	0 μs	0x04	244 μs	0x08	488 μs	0x0C	732 μs
0x01	62 μs	0x05	306 μs	0x09	550 μs	0x0D	792 μs
0x02	122 μs	0x06	366 μs	0x0A	610 μs	0x0E	854 μs
0x03	184 μs	0x07	428 μs	0x0B	670 μs	0x0F	916 μs

⁽¹⁾ Data flash setting *Protection:AFE Thresholds:SCD2 Threshold[7:4]* sets the delay time.

Sample Filter Settings

Table B-1. Sample V/I/P Filter Settings and Associated Low-Pass Filter Time Constants⁽¹⁾

Average V/I/P Filter	Effective Low-Pass Time Constant
10	0.25 seconds
50	0.5 seconds
145	1 second
200	3 seconds

⁽¹⁾ Data flash setting **Calibration:Filter:Average V/I/P** sets this threshold.

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